

Product Overview

Address Spaces

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Memory Map

SAM47 Instruction Set

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PRODUCT OVERVIEW

OVERVIEW

The KS57C5532/P5532 single-chip CMOS microcontroller has been designed for high-performance using Samsung's newest 4-bit CPU core, SAM47 (Samsung Arrangeable Microcontrollers). The KS57P5532 is a microcontroller which has 32-kbyte one-time-programmable EPROM but its functions are same to KS57C5532.

With its DTMF generator, 8-bit serial I/O interface, and versatile 8-bit timer/counters, the KS57C5532/P5532 offers an excellent design solution for a wide variety of telecommunication applications.

Up to 55 pins of the 64-pin SDIP or QFP package can be dedicated to I/O. Seven vectored interrupts provide fast response to internal and external events. In addition, the KS57C5532/P5532's advanced CMOS technology provides for low power consumption and a wide operating voltage range.

DEVELOPMENT SUPPORT

The Samsung Microcontroller Development System, SMDS, provides you with a complete PC-based development environment for KS57-series microcontrollers that is powerful, reliable, and portable. In addition to its window-based program development structure, the SMDS toolset includes versatile debugging, trace, instruction timing, and performance measurement applications.

The Samsung Generalized Assembler (SAMA) has been designed specifically for the SMDS environment and accepts assembly language sources in a variety of microprocessor formats. SAMA generates industry-standard hex files that also contain program control data for SMDS compatibility.

FEATURES SUMMARY

Memory

- 1 K × 4-bit RAM
- 32 K × 8-bit ROM

55 I/O Pins

- Input only: 4 pins
- I/O: 43 pins
- N-channel open-drain I/O (S/W): 8 pins

Memory-Mapped I/O Structure

- Data memory bank 15

DTMF Generator

- 16 dual-tone frequencies for tone dialing

8-bit Basic Timer

- Programmable internal timer
- Watchdog timer

Two 8-bit Timer/Counters

- Programmable interval timer
- External event counter function
- Timer/counters clock outputs to TCLO0 and TCLO1 pins
- External clock signal divider
- Serial I/O interface clock generator

Watch Timer

- Time interval generation:
0.5 s, 3.9 ms at 32.768 kHz
- 4 frequency outputs to the BUZ pin

8-bit Serial I/O Interface

- 8-bit transmit/receive mode
- 8-bit receive mode
- LSB-first or MSB-first transmission selectable

Bit Sequential Carrier

- Supports 8-bit serial data transfer in arbitrary format

Interrupts

- 3 external interrupt vectors
- 4 internal interrupt vectors
- 2 quasi-interrupts

Power-Down Modes

- Idle: Only CPU clock stops
- Stop: Main system clock stops
- Subsystem clock stop mode

Oscillation Sources

- Crystal, ceramic for main system clock
- Crystal oscillator for subsystem clock
- Main system clock frequency:
3.579545 MHz (typical)
- Subsystem clock frequency: 32.768 kHz (typical)
- CPU clock divider circuit (by 4, 8, or 64)

Instruction Execution Times

- 0.67, 1.33, 10.7 μs at 6.0 MHz
- 1.12, 2.23, 17.88 μs at 3.579545 MHz
- 122 μs at 32.768 kHz

Operating Temperature

- -40 °C to 85 °C

Operating Voltage Range

- 1.8 V to 5.5 V (at 3 MHz)
- 2.7 V to 5.5 V (at 6 MHz)

Package Types

- 64 SDIP, 64 QFP

BLOCK DIAGRAM

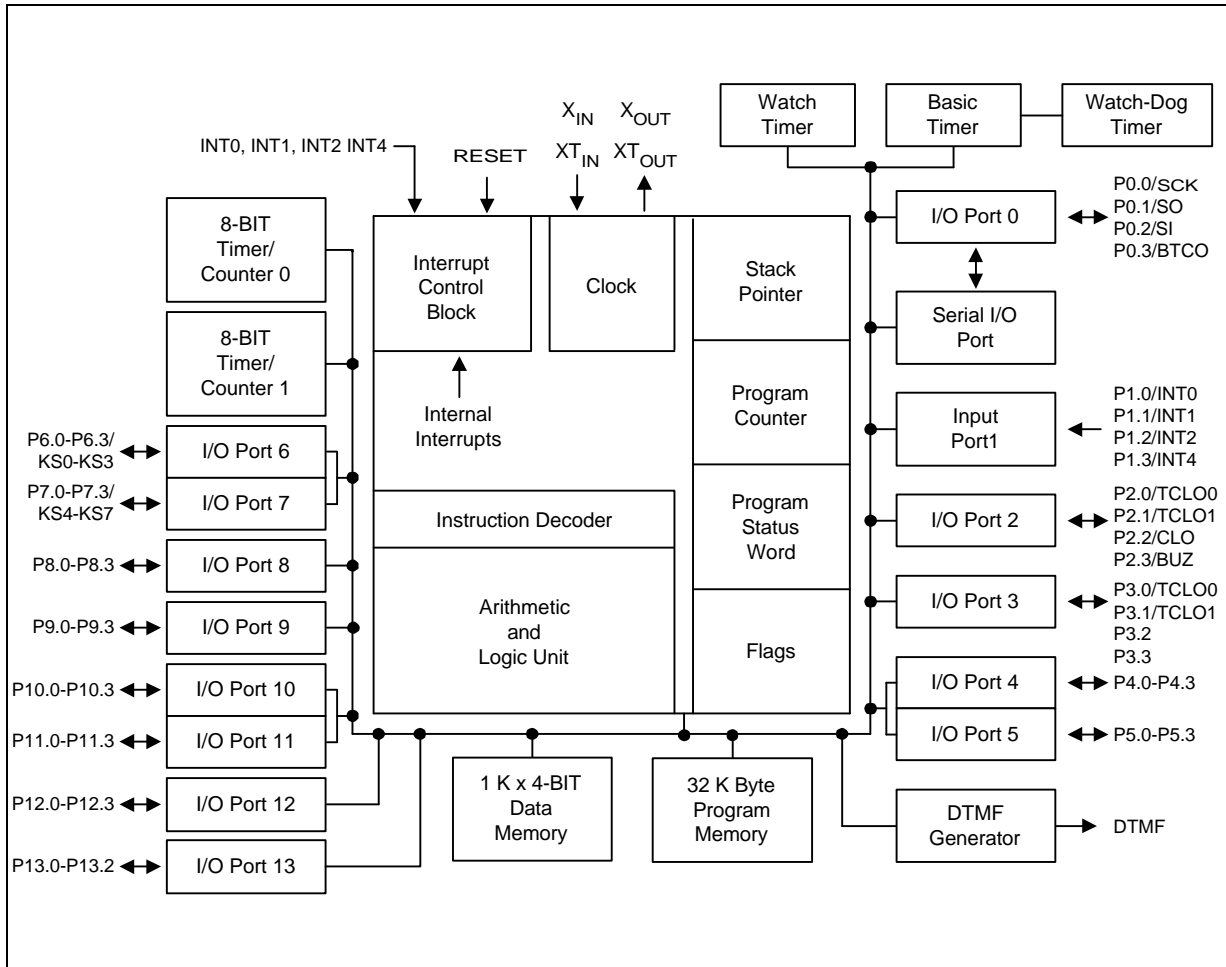


Figure 1-1. KS57C5532/P5532 Simplified Block Diagram

PIN ASSIGNMENTS

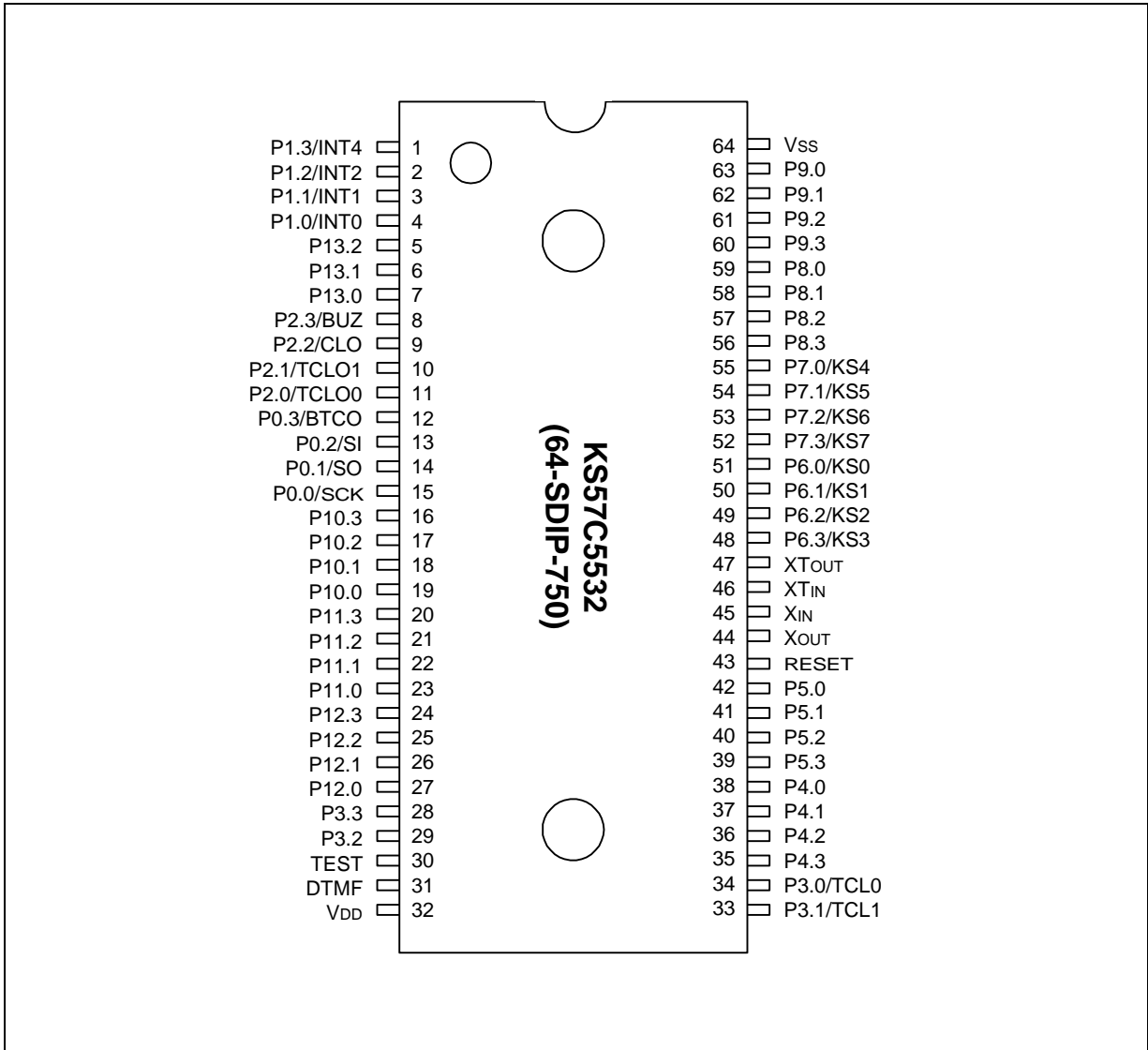


Figure 1-2. KS57C5532/P5532 Pin Assignment Diagrams

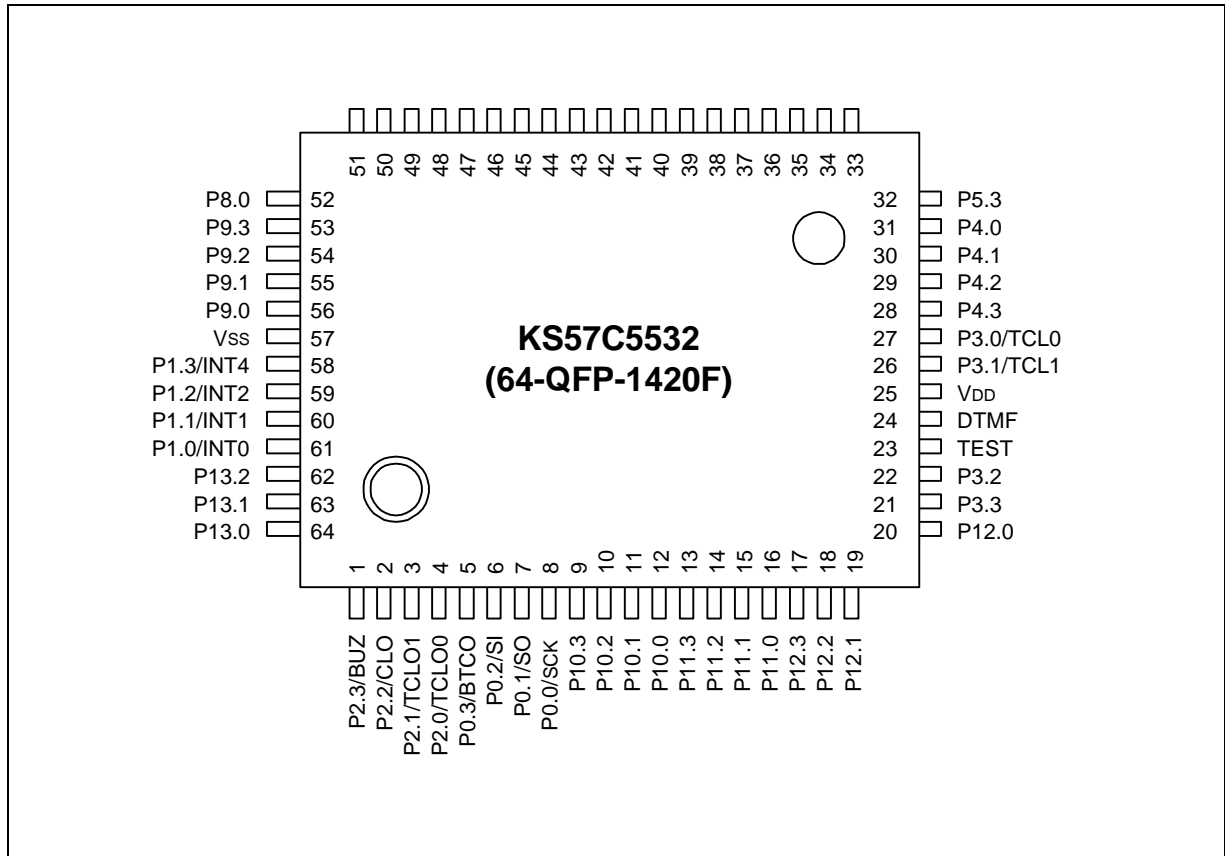


Figure 1-2. KS57C5532/P5532 Pin Assignment Diagrams (Continued)

PIN DESCRIPTIONS

Table 1-1. KS57C5532/P5532 Pin Descriptions

Pin Name	Pin Type	Description	Number	Share Pin
P0.0 P0.1 P0.2 P0.3	I/O	4-bit I/O port. 1-bit or 4-bit read/write and test is possible. Individual pins are software configurable as input or output. 4-bit pull-up resistors are software assignable; pull-up resistors are automatically disabled for output pins.	15 (8) 14 (7) 13 (6) 12 (5)	SCK SO SI BTCO
P1.0 P1.1 P1.2 P1.3	I	4-bit input port. 1-bit and 4-bit read and test is possible. 4-bit pull-up resistors are assignable by software to port 1.	1 (61) 2 (60) 3 (59) 4 (58)	INT0 INT1 INT2 INT4
P2.0 P2.1 P2.2 P2.3	I/O	Same as port 0.	11 (4) 10 (3) 9 (2) 8 (1)	TCLO0 TCLO1 CLO BUZ
P3.0 P3.1 P3.2 P3.3	I/O	Same as port 0.	34 (27) 33 (26) 29 (22) 28 (21)	TCL0 TCL1 SCLK ⁽¹⁾ SDAT ⁽¹⁾
P4.0–P4.3 P5.0–P5.3	I/O	4-bit I/O ports. 1-bit and 4-bit read/write and test is possible. 4-bit pull-up resistors are software assignable to input pins and are automatically disabled for output pins. N-channel open-drain or push-pull output can be selected by software. Port 4 and 5 can be paired to support 8-bit data transfer.	38–35 (31–28) 42–39 (35–32)	–
P6.0–P6.3 P7.0–P7.3	I/O	4-bit I/O ports. 1-bit or 4-bit read/write and test is possible. Port 6 pins are individually software configurable as input or output. 4-bit pull-up resistors are software assignable; pull-up resistors are automatically disabled for output pins. Ports 6 and 7 can be paired to enable 8-bit data transfer.	51–48 (44–41) 55–52 (48–45)	KS0–KS3 KS4–KS7
P8.0–P8.3	I/O	Same as port 0.	59–56 (52–49)	–
P9.0–P9.3	I/O	4-bit I/O port. 1-bit or 4-bit read/write and test is possible. 4-bit pull-up resistors are software assignable; pull-up resistors are automatically disabled for output pins.	63–60 (56–53)	–

NOTES

1. SCLK and SDAT are used for KS57P5532 only.
2. Parentheses indicate pin number for 64 QFP package.

Table 1-1. KS57C5532/P5532 Pin Descriptions (Continued)

Pin Name	Pin Type	Description	Number	Share Pin
P10.0–P10.3 P11.0–P11.3	I/O	Same as port 9. Ports 10 and 11 can be paired to support 8-bit data transfer.	19–16 (12–9) 23–20 (16–13)	–
P12.0–P12.3	I/O	4-bit I/O port. 1-bit or 4-bit read/write and test is possible. Individual pins are software configurable as input or output. 4-bit <i>pull-down</i> resistors are software assignable; pull-down resistors are automatically disabled for output pins.	27–24 (20–17)	–
P13.0–P13.2	I/O	3-bit I/O port; characteristics are same as port 9.	7–5 (64–62)	–
DTMF	O	DTMF output.	31 (24)	–
SCK	I/O	Serial I/O interface clock signal	15 (8)	P0.0
SO	I/O	Serial data output	14 (7)	P0.1
SI	I/O	Serial data input	13 (6)	P0.2
BTCO	I/O	Basic timer clock output	12 (5)	P0.3
INT0, INT1	I	External interrupts. The triggering edge for INT0 and INT1 is selectable. INT0 is synchronized to system clock.	4, 3 (61, 60)	P1.0, P1.1
INT2	I	Quasi-interrupt with detection of rising edges	2 (59)	P1.2
INT4	I	External interrupt with detection of rising and falling edges.	1 (58)	P1.3
TCLO0	I/O	Timer/counter 0 clock output	11 (4)	P2.0
TCLO1	I/O	Timer/counter 1 clock output	10 (3)	P2.1
CLO	I/O	Clock output	9 (2)	P2.2
BUZ	I/O	2 kHz, 4 kHz, 8 kHz, or 16 kHz frequency output at the watch timer clock frequency of 32.768 kHz for buzzer sound	8 (1)	P2.3
TCL0	I/O	External clock input for timer/counter 0	34 (27)	P3.0
TCL1	I/O	External clock input for timer/counter 1	33 (26)	P3.1
KS0–KS3 KS4–KS7	I/O	Quasi-interrupt inputs with falling edge detection	51–48 (44–41) 55–52 (48–45)	P6.0–P6.3 P7.0–P7.3

NOTE: Parentheses indicate pin number for 64 QFP package.

Table 1-1. KS57C5532/P5532 Pin Descriptions (Concluded)

Pin Name	Pin Type	Description	Number	Share Pin
V _{DD}	–	Power supply	32 (25)	–
V _{SS}	–	Ground	64 (57)	–
RESET	I	Reset signal	43 (36)	–
X _{IN} , X _{OUT}	–	Crystal, ceramic, or R/C oscillator signal for main system clock. (For external clock input, use X _{IN} and input X _{IN} 's reverse phase to X _{OUT})	45, 44 (38, 37)	–
XT _{IN} , XT _{OUT}	–	Crystal oscillator signal for subsystem clock. (For external clock input, use XT _{IN} and input XT _{IN} 's reverse phase to XT _{OUT})	46, 47 (39, 40)	–
TEST	–	Chip test input pin. Hold GND when the device is operating.	30 (23)	–

NOTE: Parentheses indicate pin number for 64 QFP package.

Table 1-2. Overview of KS57C5532/P5532 Pin Data

Pin Names	Share Pins	I/O Type	Reset Value	Circuit Type
P0.0–P0.3	SCK, SO, SI, BTCO	I/O	Input	D-4
P1.0–P1.3	INT0, INT1, INT2, INT4	I	Input	A-1
P2.0–P2.3	TCLO0, TCLO1, CLO, BUZ	I/O	Input	D-2
P3.0–P3.1	TCL0, TCL1	I/O	Input	D-4
P3.2–P3.3	–	I/O	Input	D-2
P4.0–P4.3 P5.0–P5.3	–	I/O	Input	E-2
P6.0–P6.3 P7.0–P7.3	KS0–KS3 KS4–KS7	I/O	Input	D-4
P8.0–P8.3	–	I/O	Input	D-2
P9.0–P9.3	–	I/O	Input	D-2
P10.0–P10.3 P11.0–P11.3	–	I/O	Input	D-2
P12.0–P12.3	–	I/O	Input	D-6
P13.0–P13.2	–	I/O	Input	D-2
DTMF	–	O	High impedance	G-6
X _{IN} , X _{OUT} XT _{IN} , XT _{OUT}	–	–	–	–
RESET	–	I	–	B
NC	–	–	–	–
V _{DD} , V _{SS}	–	–	–	–

PIN CIRCUIT DIAGRAMS

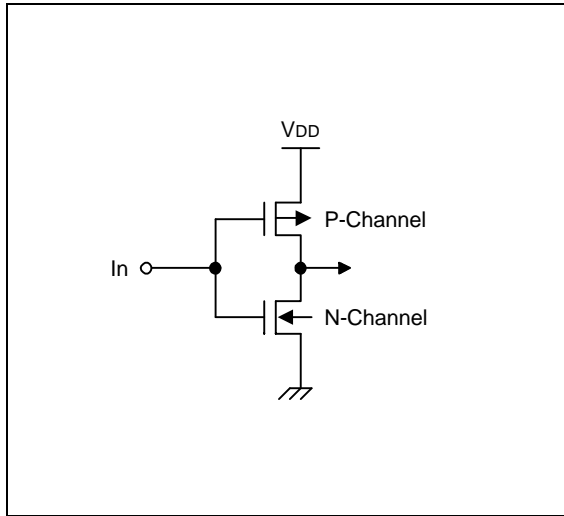


Figure 1-3. Pin Circuit Type A

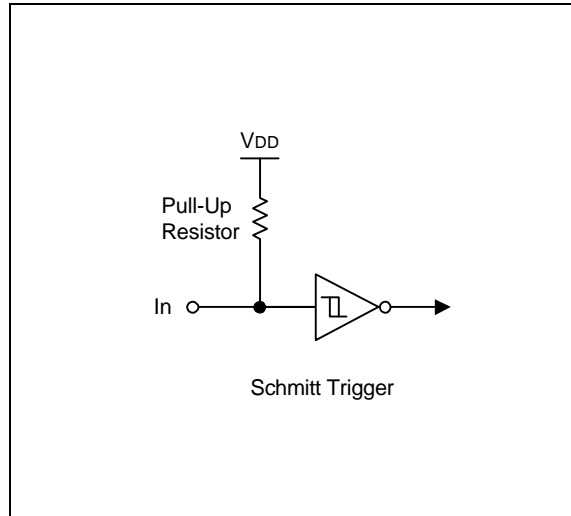


Figure 1-5. Pin Circuit Type B

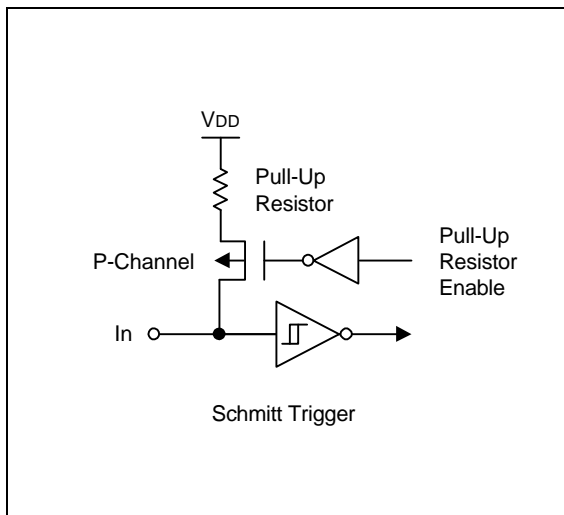


Figure 1-4. Pin Circuit Type A-1

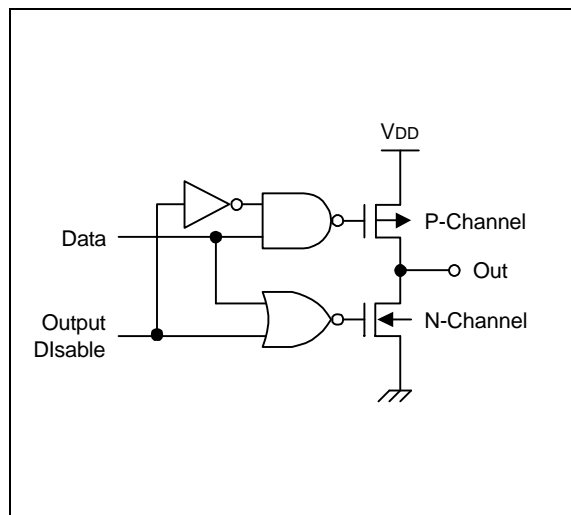


Figure 1-6. Pin Circuit Type C

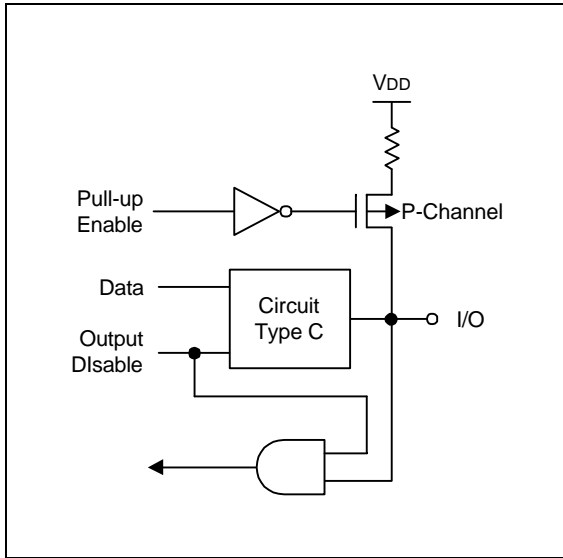


Figure 1-7. Pin Circuit Type D-2

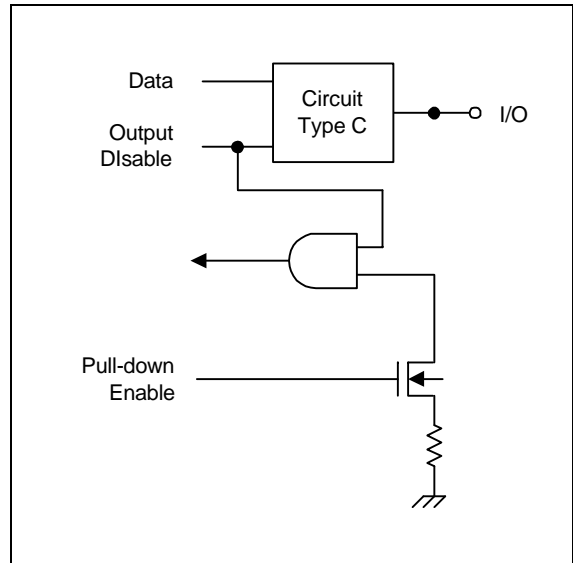


Figure 1-9. Pin Circuit Type D-6

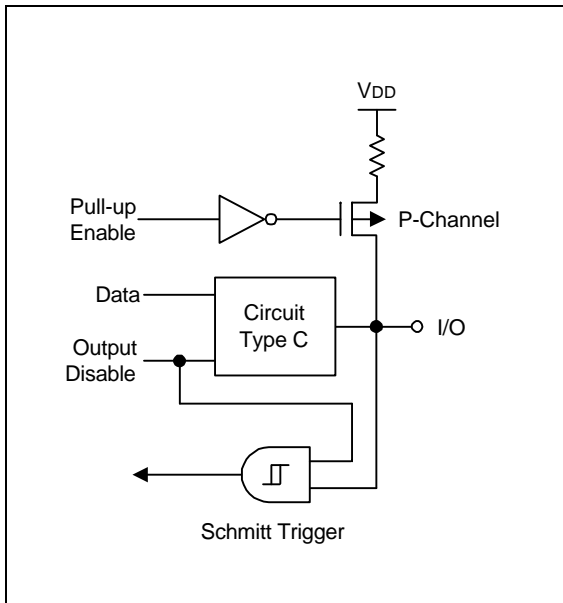


Figure 1-8. Pin Circuit Type D-4

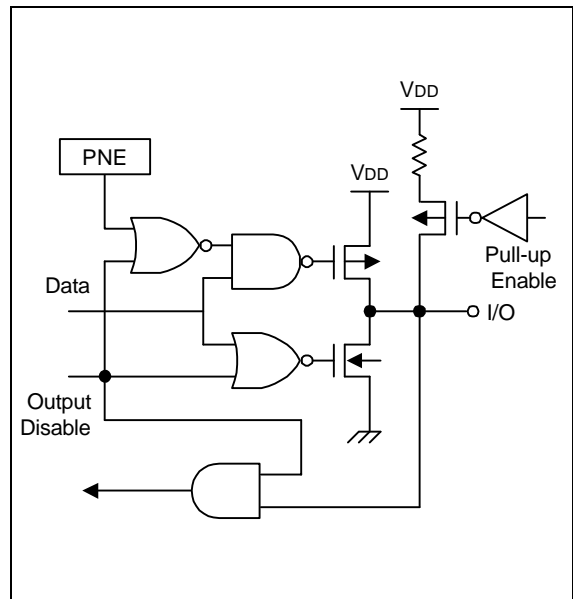
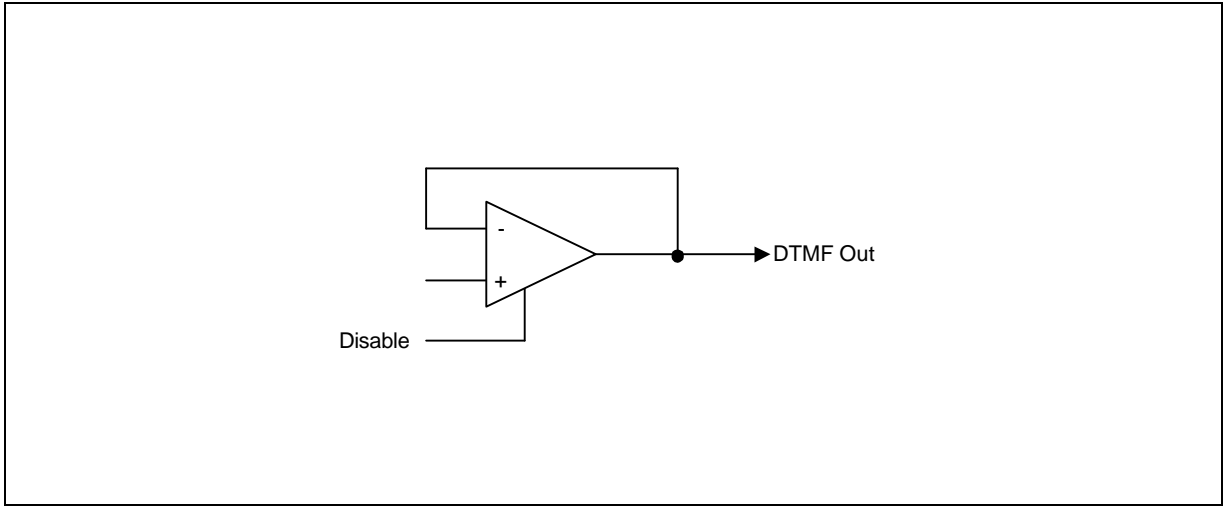


Figure 1-10. Pin Circuit Type E-2



2 ADDRESS SPACES

PROGRAM MEMORY (ROM)

OVERVIEW

ROM maps for the KS57C5532 are mask programmable at the factory. In its standard configuration, the device's 32,768 × 8-bit program memory has three areas that are directly addressable by the program counter (PC):

- 16-byte area for vector addresses
- 16-byte general-purpose area
- 96-byte instruction reference area
- 32,640-byte general-purpose area

General-Purpose Program Memory

Two program memory areas are allocated for general-purpose use: One area is 16 bytes in size and the other is 32,640 bytes.

Vector Addresses

A 16-byte vector address area is used to store the vector addresses required to execute system resets and interrupts. Start addresses for interrupt service routines are stored in this area, along with the values of the enable memory bank (EMB) and enable register bank (ERB) flags that are used to initialize the corresponding service routines. The 16-byte area can be used alternately as general-purpose ROM.

REF Instructions

Locations 0020H–007FH are used as a reference area (look-up table) for 1-byte REF instructions. The REF instruction reduces the byte size of instruction operands. REF can reference one 2-byte instruction, two 1-byte instructions, and 3-byte instructions which are stored in the look-up table. Unused look-up table addresses can be used as general-purpose ROM.

Table 2-1. Program Memory Address Ranges

ROM Area Function	Address Ranges	Area Size (in Bytes)
Vector address area	0000H–000FH	16
General-purpose program memory	0010H–001FH	16
REF instruction look-up table area	0020H–007FH	96
General-purpose program memory	0080H–7FFFH	32,640

GENERAL-PURPOSE MEMORY AREAS

The 16-byte area at ROM locations 0010H–001FH and the 32,640-byte area at ROM locations 0080H–7FFFH are used as general-purpose program memory. Unused locations in the vector address area and REF instruction look-up table areas can be used as general-purpose program memory. However, care must be taken not to overwrite live data when writing programs that use special-purpose areas of the ROM.

VECTOR ADDRESS AREA

The 16-byte vector address area of the ROM is used to store the vector addresses for executing system resets and interrupts. The starting addresses of interrupt service routines are stored in this area, along with the enable memory bank (EMB) and enable register bank (ERB) flag values that are needed to initialize the service routines. 16-byte vector addresses are organized as follows:

EMB	ERB	PC13	PC12	PC11	PC10	PC9	PC8
PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0

To set up the vector address area for specific programs, use the instruction VENTn. The programming tips on the next page explain how to do this.

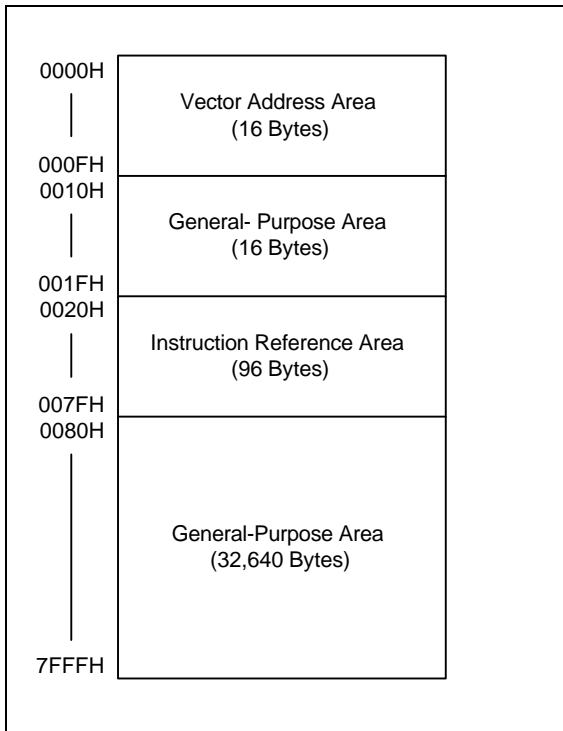


Figure 2-1. ROM Address Structure

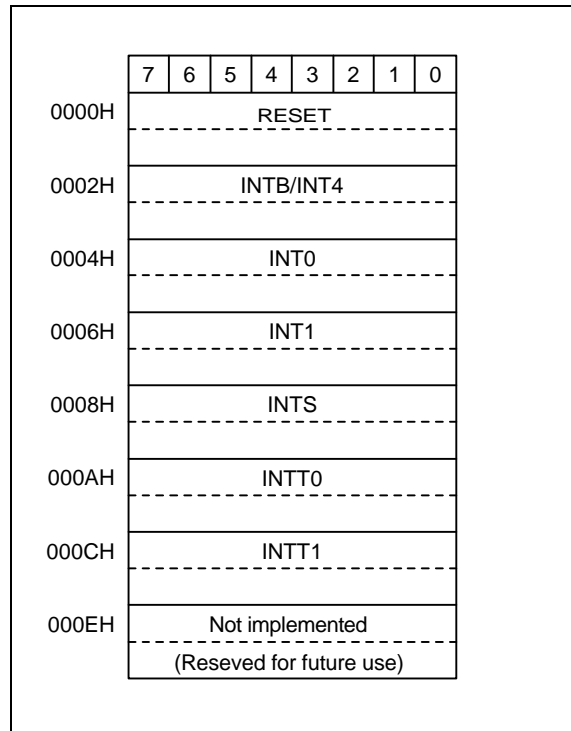


Figure 2-2. Vector Address Map

PROGRAMMING TIP — Defining Vectored Interrupts

The following examples show you several ways you can define the vectored interrupt and instruction reference areas in program memory:

1. When all vector interrupts are used:

```

;
;          ORG          0000H
;
VENT0     1,0,RESET    ;   EMB ← 1, ERB ← 0; Jump to RESET address by RESET
VENT1     0,0,INTB     ;   EMB ← 0, ERB ← 0; Jump to INTB address INTB
VENT2     0,0,INT0     ;   EMB ← 0, ERB ← 0; Jump to INT0 address INT0
VENT3     0,0,INT1     ;   EMB ← 0, ERB ← 0; Jump to INT1 address INT1
VENT4     0,0,INTS     ;   EMB ← 0, ERB ← 0; Jump to INTS address INTS
VENT5     0,0,INTT0    ;   EMB ← 0, ERB ← 0; Jump to INTT0 address INTT0
VENT6     0,0,INTT1    ;   EMB ← 0, ERB ← 0; Jump to INTT1 address INTT1

```

2. When a specific vectored interrupt such as INT0, and INTT0 is not used, the unused vector interrupt locations must be skipped with the assembly instruction ORG so that jumps will address the correct locations:

```

;
;          ORG          0000H
;
VENT0     1,0,RESET    ;   EMB ← 1, ERB ← 0; Jump to RESET address by RESET
VENT1     0,0,INTB     ;   EMB ← 0, ERB ← 0; Jump to INTB address by INTB
;
;          ORG          0006H    ;   INT0 interrupt not used
;
VENT3     0,0,INT1     ;   EMB ← 0, ERB ← 0; Jump to INT1 address by INT1
VENT4     0,0,INTS     ;   EMB ← 0, ERB ← 0; Jump to INTS address by INTS
;
;          ORG          00C0H    ;   INTT0 interrupt not used
;
VENT6     0,0,INTT1    ;   EMB ← 0, ERB ← 0; Jump to INTT1 address by INTT1
;
;          ORG          0010H

```


 **PROGRAMMING TIP — Defining Vectored Interrupts (Continued)**

3. If an INT0 interrupt is not used and if its corresponding vector interrupt area is not fully utilized, or if it is not written by a ORG instruction in Example 2, a CPU malfunction will occur:

```

      ORG      0000H
;
VENT0    1,0,RESET      ;  EMB ← 1, ERB ← 0; Jump to RESET address by RESET
VENT1    0,0,INTB       ;  EMB ← 0, ERB ← 0; Jump to INTB address by INTB
VENT3    0,0,INT1       ;  EMB ← 0, ERB ← 0; Jump to INT1 address INT1
VENT4    0,0,INTS       ;  EMB ← 0, ERB ← 0; Jump to INTS address INTS
VENT5    0,0,INTT0      ;  EMB ← 0, ERB ← 0; Jump to INTT0 address INTT0
VENT6    0,0,INTT1      ;  EMB ← 0, ERB ← 0; Jump to INTT1 address INTT1
;
      ORG      0010H
;
      General-purpose ROM area
;

```

In this example, when an INTS interrupt is generated, the corresponding vector area is not VENT4 INTS, but VENT5 INTT0. This causes an INTS interrupt to jump incorrectly to the INTT0 address and causes a CPU malfunction to occur.

INSTRUCTION REFERENCE AREA

Using 1-byte REF instructions, you can easily reference instructions with larger byte sizes that are stored in addresses 0020H–007FH of program memory. This 96-byte area is called the REF instruction reference area, or look-up table. Locations in the REF look-up table may contain two 1-byte instructions, one 2-byte instruction, or one 3-byte instruction such as a JP (jump) or CALL. The starting address of the instruction you are referencing must always be an even number. To reference a JP or CALL instruction, it must be written to the reference area in a two-byte format: for JP, this format is TJP; for CALL, it is TCALL. In summary, there are three ways to the REF instruction:

By using REF instructions you can execute instructions larger than one byte. In summary, there are three ways you can use the REF instruction:

- Using the 1-byte REF instruction to execute one 2-byte or two 1-byte instructions,
- Branching to any location by referencing a branch instruction stored in the look-up table,
- Calling subroutines at any location by referencing a call instruction stored in the look-up table.

PROGRAMMING TIP — Using the REF Look-up Table

Here is one example of how to use the REF instruction look-up table:

```

                ORG      0020H
;
JMAIN          TJP      MAIN          ; 0, MAIN
KEYCK          BTSF    KEYFG         ; 1, KEYFG check
WATCH         TCALL   CLOCK         ; 2, call CLOCK
INCHL         LD      @HL,A         ; 3, (HL) ← A
                INCS    HL
                •
                •
                •
ABC           LD      EA,#00H        ; 47, EA ← #00H
                ORG      0080
;
MAIN          NOP
                NOP
                •
                •
                •
                REF    KEYCK         ; BTSF KEYFG (1-byte instruction)
                REF    JMAIN        ; KEYFG = 1, jump to MAIN (1-byte instruction)
                REF    WATCH       ; KEYFG = 0, call CLOCK (1-byte instruction)
                REF    INCHL       ; LD @HL,A
                REF    INCS HL      ; INCS HL
                REF    ABC          ; LD EA,#00H (1-byte instruction)
                •
                •
                •

```

DATA MEMORY (RAM)

OVERVIEW

In its standard configuration, the 1024 × 4-bit data memory has four areas:

- 32 × 4-bit working register area
- 224 × 4-bit general-purpose area (also used as stack area)
- 3 × 256 × 4-bit general-purpose area
- 128 × 4-bit area for peripheral hardware

To make it easier to reference, the data memory area has three memory banks — bank 0, bank 1, bank 2, bank 3, and bank 15. The select memory bank instruction (SMB) is used to select the bank you want to select as working data memory. Data stored in RAM locations are 1-, 4-, and 8-bit addressable.

Initialization values for the data memory area are not defined by hardware and must therefore be initialized by program software following RESET. However, when RESET signal is generated in power-down mode, the most of data memory contents are held.

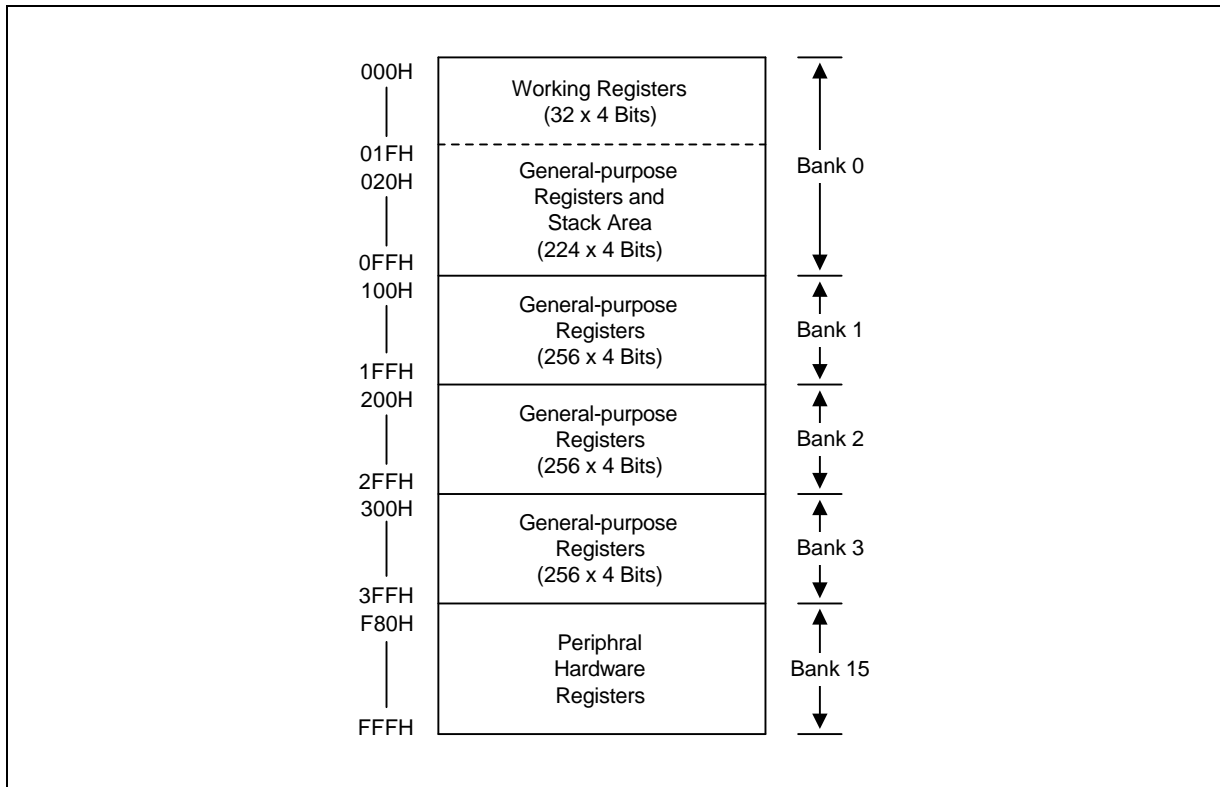


Figure 2-3. Data Memory (RAM) Map

Memory Banks 0, 1, 2, 3, and 15

Bank 0	(000H–0FFH)	The lowest 32 nibbles of bank 0 (000H–01FH) are used as working registers; the next 224 nibbles (020H–0FFH) can be used both as stack area and as general-purpose data memory. Use the stack area for implementing subroutine calls and returns, and for interrupt processing.
Bank 1	(100H–1FFH)	The 256 nibbles of bank 1 (100H–1FFH) are for general-purpose use.
Bank 2	(200H–2FFH)	The 256 nibbles of bank 1 (200H–2FFH) are for general-purpose use.
Bank 3	(300H–3FFH)	The 256 nibbles of bank 1 (300H–3FFH) are for general-purpose use.
Bank 15	(F80H–FFFH)	The microcontroller uses bank 15 for memory-mapped peripheral I/O. Fixed RAM locations for each peripheral hardware register: the port latches, timers, peripherals controls, etc. are mapped into this area.

Data Memory Addressing Modes

The enable memory bank (EMB) flag controls the addressing mode for data memory banks 0, 1, 2, 3, or 15. When the EMB flag is logic zero, the addressable area is restricted to specific locations, depending on whether direct or indirect addressing is used. With direct addressing, you can access locations 000H–07FH of bank 0 and bank 15. With indirect addressing, only bank 0 (000H–0FFH) can be accessed. When the EMB flag is set to logic one, all five data memory banks can be accessed according to the current SMB value.

For 8-bit addressing, two 4-bit registers are addressed as a register pair. Also, when using 8-bit instructions to address RAM locations, remember to use the even-numbered register address as the instruction operand.

Working Registers

The RAM working register area in data memory bank 0 is further divided into four *register* banks (bank 0, 1, 2, and 3). Each register bank has eight 4-bit registers and paired 4-bit registers are 8-bit addressable.

Register A is used as a 4-bit accumulator and register pair EA as an 8-bit extended accumulator. The carry flag bit can also be used as a 1-bit accumulator. Register pairs WX, WL, and HL are used as address pointers for indirect addressing. To limit the possibility of data corruption due to incorrect register addressing, it is advisable to use register bank 0 for the main program and banks 1, 2, and 3 for interrupt service routines.

Table 2-2. Data Memory Organization and Addressing

Addresses	Register Areas	Bank	EMB Value	SMB Value
000H–01FH	Working registers	0	0, 1	0
020H–0FFH	Stack and general-purpose registers			
100H–1FFH	General-purpose registers	1	1	1
200H–2FFH	General-purpose registers	2	1	2
300H–3FFH	General-purpose registers	3	1	3
F80H–FFFH	Peripheral hardware registers	15	0, 1	15

 **PROGRAMMING TIP — Clearing Data Memory Banks 0 and 1**

Clear banks 0 and 1 of the data memory area:

```

RAMCLR  SMB    1                ; RAM (100H–1FFH) clear
        LD     HL,#00H
        LD     A,#0H
RMCL1   LD     @HL,A
        INCS   HL
        JR     RMCL1
;
        SMB    0                ; RAM (010H–0FFH) clear
RMCL0   LD     HL,#10H
        LD     @HL,A
        INCS   HL
        JR     RMCL0

```

WORKING REGISTERS

Working registers, mapped to RAM address 000H–01FH in data memory bank 0, are used to temporarily store intermediate results during program execution, as well as pointer values used for indirect addressing. Unused registers may be used as general-purpose memory. Working register data can be manipulated as 1-bit units, 4-bit units or, using paired registers, as 8-bit units.

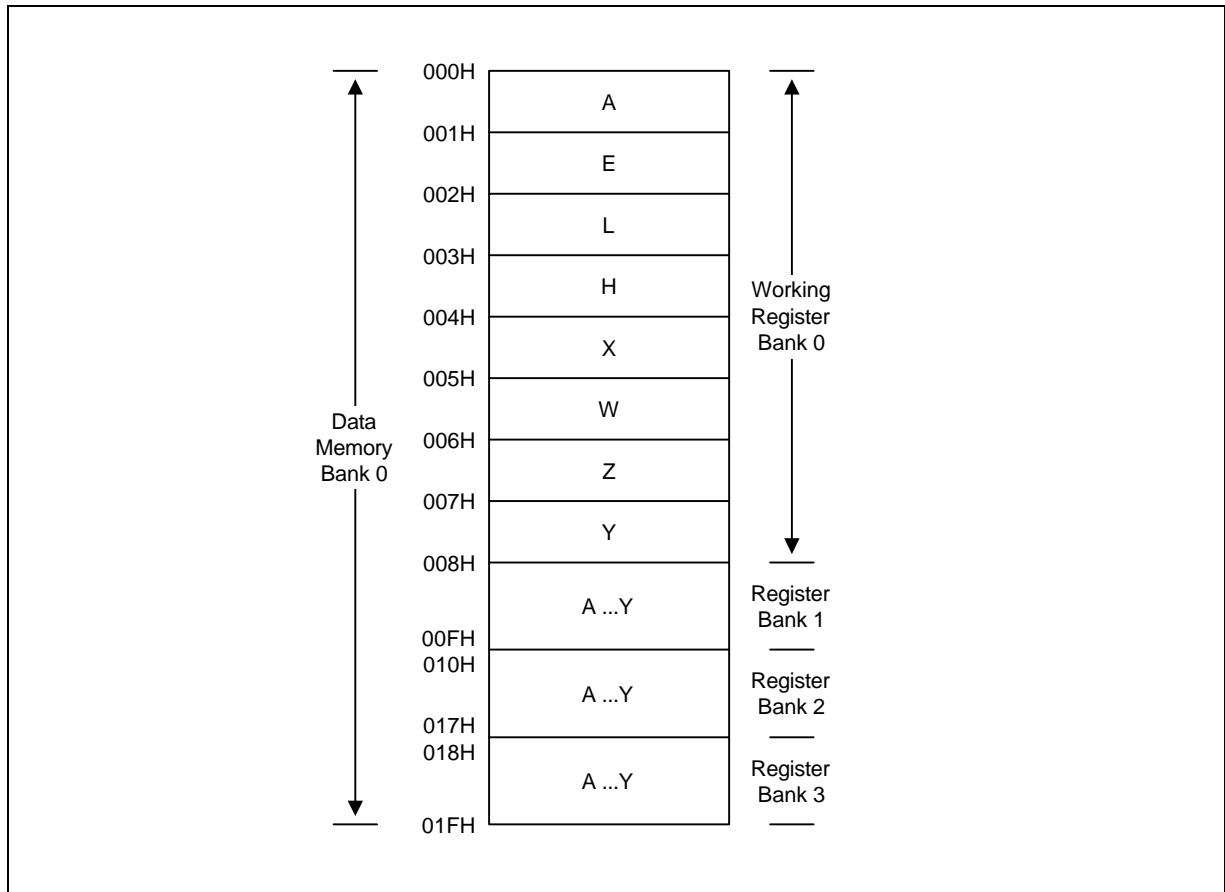


Figure 2-4. Working Register Map

Working Register Banks

For addressing purposes, the working register area is divided into four register banks — bank 0, bank 1, bank 2, and bank 3. Any one of these banks can be selected as the working register bank by the register bank selection instruction (SRB n) and by setting the status of the register bank enable flag (ERB).

Generally, working register bank 0 is used for the main program, and banks 1, 2, and 3 for interrupt service routines. Following this convention helps to prevent possible data corruption during program execution due to contention in register bank addressing.

Table 2-3. Working Register Organization and Addressing

ERB Setting	SRB Settings				Selected Register Bank
	3	2	1	0	
0	0	0	x	x	Always set to bank 0
1	0	0	0	0	Bank 0
			0	1	Bank 1
			1	0	Bank 2
			1	1	Bank 3

NOTE: 'x' means don't care.

Paired Working Registers

Each of the register banks is subdivided into eight 4-bit registers. These registers, named Y, Z, W, X, H, L, E and A, can either be manipulated individually using 4-bit instructions, or together as register pairs for 8-bit data manipulation.

The names of the 8-bit register pairs in each register bank are EA, HL, WX, YZ and WL. Registers A, L, X and Z always become the lower nibble when registers are addressed as 8-bit pairs. This makes a total of eight 4-bit registers or four 8-bit double registers in each of the four working register banks.

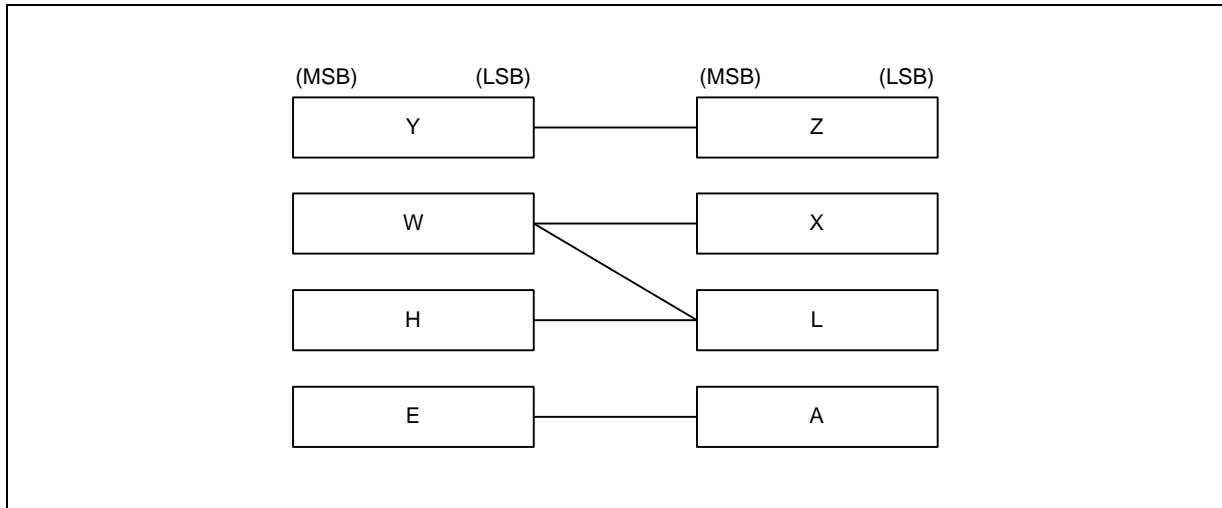


Figure 2-5. Register Pair Configuration

Special-Purpose Working Registers

Register A is used as a 4-bit accumulator and double register EA as an 8-bit accumulator. The carry flag can also be used as a 1-bit accumulator.

8-bit double registers WX, WL and HL are used as data pointers for indirect addressing. When the HL register serves as a data pointer, the instructions LDI, LDD, XCHI, and XCHD can make very efficient use of working registers as program loop counters by letting you transfer a value to the L register and increment or decrement it using a single instruction.

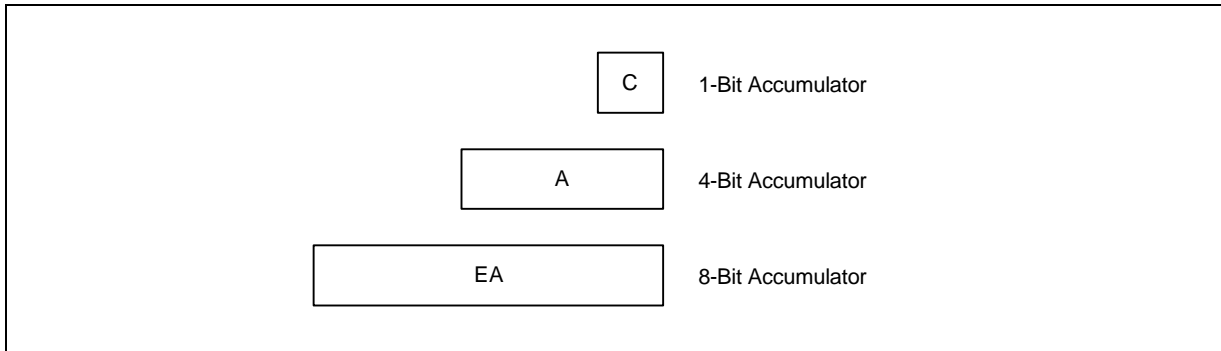


Figure 2-6. 1-Bit, 4-Bit, and 8-Bit Accumulator

Recommendation for Multiple Interrupt Processing

If more than four interrupts are being processed at one time, you can avoid possible loss of working register data by using the PUSH RR instruction to save register contents to the stack before the service routines are executed in the same register bank. When the routines have executed successfully, you can restore the register contents from the stack to working memory using the POP instruction.

PROGRAMMING TIP — Selecting the Working Register Area

The following examples show the correct programming method for selecting working register area:

1. When ERB = "0":

```

VENT2      1,0,INT0          ; EMB ← 1, ERB ← 0, Jump to INT0 address
;
INT0       PUSH      SB      ; PUSH current SMB, SRB
          SRB        2      ; Instruction does not execute because ERB = "0"
          PUSH      HL      ; PUSH HL register contents to stack
          PUSH      WX      ; PUSH WX register contents to stack
          PUSH      YZ      ; PUSH YZ register contents to stack
          PUSH      EA      ; PUSH EA register contents to stack
          SMB        0
          LD        EA,#00H
          LD        80H,EA
          LD        HL,#40H
          INCS      HL
          LD        WX,EA
          LD        YZ,EA
          POP       EA      ; POP EA register contents from stack
          POP       YZ      ; POP YZ register contents from stack
          POP       WX      ; POP WX register contents from stack
          POP       HL      ; POP HL register contents from stack
          POP       SB      ; POP current SMB, SRB
          IRET

```

The POP instructions execute alternately with the PUSH instructions. If an SMB n instruction is used in an interrupt service routine, a PUSH and POP SB instruction must be used to store and restore the current SMB and SRB values, as shown in Example 2 below.

2. When ERB = "1":

```

VENT2      1,1,INT0          ; EMB ← 1, ERB ← 1, Jump to INT0 address
;
INT0       PUSH      SB      ; Store current SMB, SRB
          SRB        2      ; Select register bank 2 because of ERB = "1"
          SMB        0
          LD        EA,#00H
          LD        80H,EA
          LD        HL,#40H
          INCS      HL
          LD        WX,EA
          LD        YZ,EA
          POP       SB      ; Restore SMB, SRB
          IRET

```

STACK OPERATIONS

STACK POINTER (SP)

The stack pointer (SP) is an 8-bit register that stores the address used to access the stack, an area of data memory set aside for temporary storage of stack addresses. The SP can be read or written by 8-bit control instructions. When addressing the SP, bit 0 must always remain cleared to logic zero.

F80H	SP3	SP2	SP1	"0"
F81H	SP7	SP6	SP5	SP4

There are two basic stack operations: writing to the top of the stack (push), and reading from the top of the stack (pop). A push decrements the SP and a pop increments it so that the SP always points to the top address of the last data to be written to the stack.

The program counter contents and program status word are stored in the stack area prior to the execution of a CALL or a PUSH instruction, or during interrupt service routines. Stack operation is a LIFO (Last In-First Out) type. The stack area is located in general-purpose data memory bank 0.

During an interrupt or a subroutine, the PC value and the PSW are saved to the stack area. When the routine has completed, the stack pointer is referenced to restore the PC and PSW, and the next instruction is executed.

The SP can address stack registers in bank 0 (addresses 000H-0FFH) regardless of the current value of the enable memory bank (EMB) flag and the select memory bank (SMB) flag. Although general-purpose register areas can be used for stack operations, be careful to avoid data loss due to simultaneous use of the same register(s).

Since the reset value of the stack pointer is not defined in firmware, we recommend that you initialize the stack pointer by program code to location 00H. This sets the first register of the stack area to 0FFH.

NOTE

A subroutine call occupies six nibbles in the stack; an interrupt requires six. When subroutine nesting or interrupt routines are used continuously, the stack area should be set in accordance with the maximum number of subroutine levels. To do this, estimate the number of nibbles that will be used for the subroutines or interrupts and set the stack area correspondingly.

PROGRAMMING TIP — Initializing the Stack Pointer

To initialize the stack pointer (SP):

1. When EMB = "1":

```
SMB      15          ; Select memory bank 15
LD       EA,#00H    ; Bit 0 of accumulator A is always cleared to "0"
LD       SP,EA      ; Stack area initial address (0FFH) ← (SP) – 1
```

2. When EMB = "0":

```
LD       EA,#00H
LD       SP,EA      ; Memory addressing area (00H–7FH, F80H–FFFH)
```

PUSH OPERATIONS

Three kinds of push operations reference the stack pointer (SP) to write data from the source register to the stack: PUSH instructions, CALL instructions, and interrupts. In each case, the SP is *decremented* by a number determined by the type of push operation and then points to the next available stack location.

PUSH Instructions

A PUSH instruction references the SP to write two 4-bit data nibbles to the stack. Two 4-bit stack addresses are referenced by the stack pointer: one for the upper register value and another for the lower register. After the PUSH has executed, the SP is decremented *by two* and points to the next available stack location.

CALL Instructions

When a subroutine call is issued, the CALL instruction references the SP to write the PC's contents to six 4-bit stack locations. Current values for the enable memory bank (EMB) flag and the enable register bank (ERB) flag are also pushed to the stack. Since six 4-bit stack locations are used per CALL, you may nest subroutine calls up to the number of levels permitted in the stack.

Interrupt Routines

An interrupt routine references the SP to push the contents of the PC and the program status word (PSW) to the stack. Six 4-bit stack locations are used to store this data. After the interrupt has executed, the SP is decremented *by six* and points to the next available stack location. During an interrupt sequence, subroutines may be nested up to the number of levels which are permitted in the stack area.

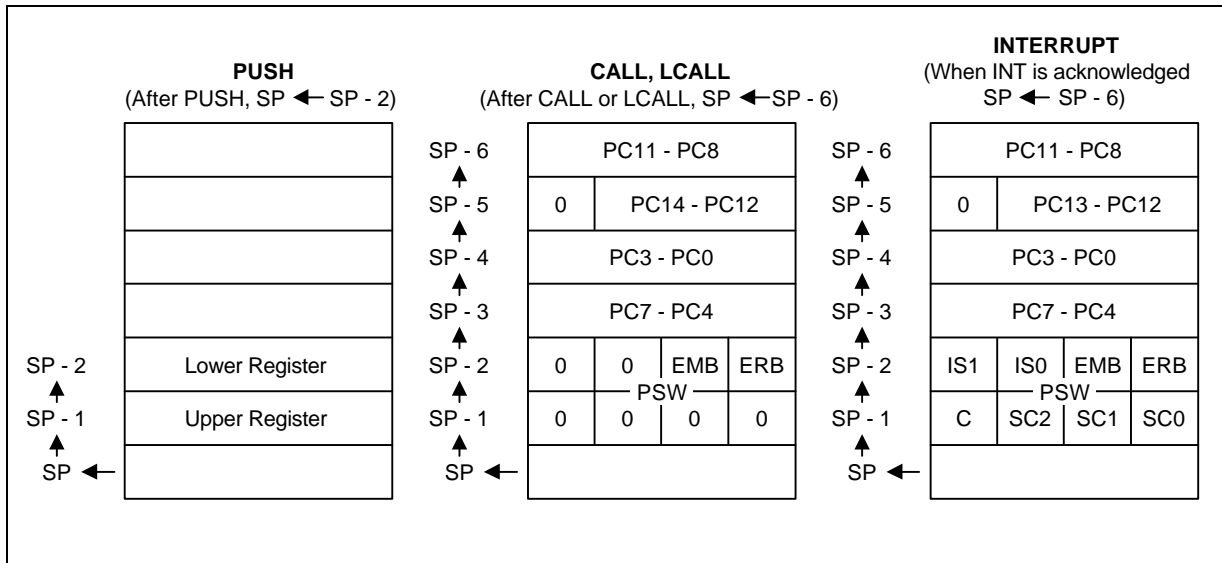


Figure 2-7. Push-Type Stack Operations

POP OPERATIONS

For each push operation there is a corresponding pop operation to write data from the stack back to the source register or registers: for the PUSH instruction it is the POP instruction; for CALL, the instruction RET or SRET; for interrupts, the instruction IRET. When a pop operation occurs, the SP is *incremented* by a number determined by the type of operation and points to the next free stack location.

POP Instructions

A POP instruction references the SP to write data stored in two 4-bit stack locations back to the register pairs and SB register. The value of the lower 4-bit register is popped first, followed by the value of the upper 4-bit register. After the POP has executed, the SP is incremented *by two* and points to the next free stack location.

RET and SRET Instructions

The end of a subroutine call is signaled by the return instruction, RET or SRET. The RET or SRET uses the SP to reference the six 4-bit stack locations used for the CALL and to write this data back to the PC, the EMB, and the ERB. After the RET or SRET has executed, the SP is incremented *by six* and points to the next free stack location.

IRET Instructions

The end of an interrupt sequence is signaled by the instruction IRET. IRET references the SP to locate the six 4-bit stack addresses used for the interrupt and to write this data back to the PC and the PSW. After the IRET has executed, the SP is incremented *by six* and points to the next free stack location.

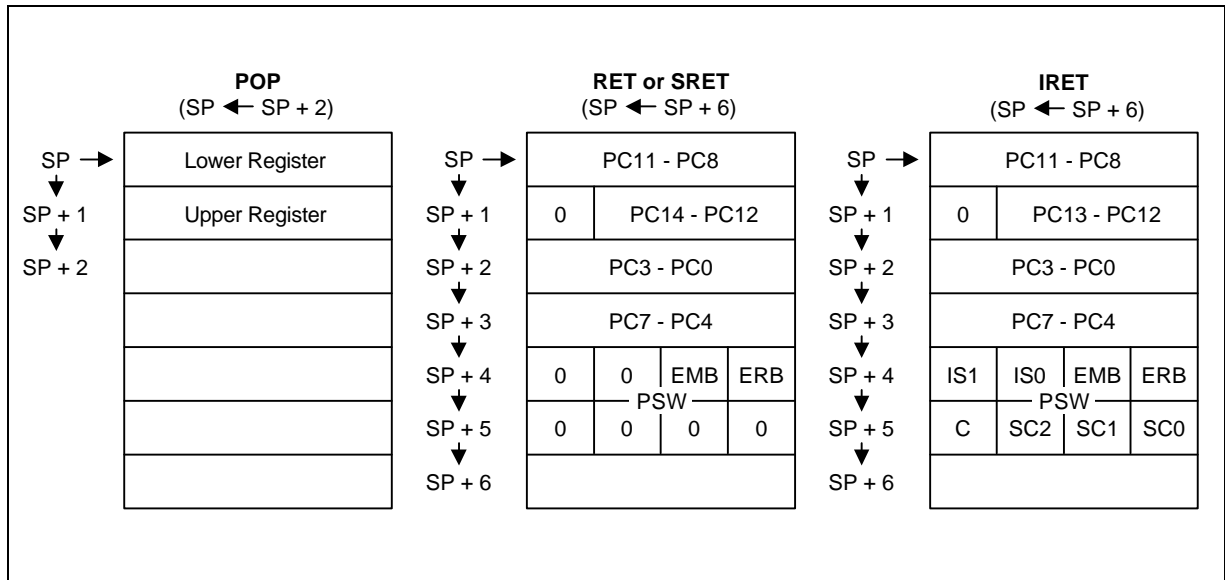


Figure 2-8. Pop-Type Stack Operations

BIT SEQUENTIAL CARRIER (BSC)

The bit sequential carrier (BSC) is a 8-bit general register that can be manipulated using 1-, 4-, and 8-bit RAM control instructions. RESET clears all BSC bit values to logic zero.

Using the BSC, you can specify sequential addresses and bit locations using 1-bit indirect addressing (memb.@L). (Bit addressing is independent of the current EMB value.) In this way, programs can process 16-bit data by moving the bit location sequentially and then incrementing or decrementing the value of the L register.

BSC data can also be manipulated using direct addressing.

If the values of the L register are 0H at BSC2.@L, the address and bit location assignment is FC0H.0. If the L register content is 8H at BSC2.@L, the address and bit location assignment is FC3H.3.

Table 2-4. BSC Register Organization

Name	Address	Bit 3	Bit 2	Bit 1	Bit 0
BSC0	FC0H	BSC0.3	BSC0.2	BSC0.1	BSC0.0
BSC1	FC1H	BSC1.3	BSC1.2	BSC1.1	BSC1.0
BSC2	FC2H	BSC2.3	BSC2.2	BSC2.1	BSC2.0
BSC3	FC3H	BSC3.3	BSC3.2	BSC3.1	BSC3.0

PROGRAMMING TIP — Using the BSC Register to Output 16-Bit Data

To use the bit sequential carrier (BSC) register to output 8-bit data (59H) to the P2.3 pin:

```

          BITS      EMB
          SMB      15
          LD      EA,#37H
          LD      BSC0,EA      ; BSC0 ← A, BSC1 ← E
          LD      EA,#59H      ;
          LD      BSC2,EA      ; BSC2 ← A, BSC3 ← E
          SMB      0
          LD      L,#0H        ;
AGN      LDB     C,BSC0.@L    ;
          LDB     P2.3,C      ; P2.3 ← C
          INCS    L
          JR      AGN
          RET

```

PROGRAM COUNTER (PC)

A 15-bit program counter (PC) stores addresses for instruction fetches during program execution. Whenever a reset operation or an interrupt occurs, bits PC13 through PC0 are set to the vector address.

Usually, the PC is incremented by the number of bytes of the instruction being fetched. One exception is the 1-byte REF instruction which is used to reference instructions stored in the ROM.

PROGRAM STATUS WORD (PSW)

The program status word (PSW) is an 8-bit word that defines system status and program execution status and which permits an interrupted process to resume operation after an interrupt request has been serviced. PSW values are mapped as follows:

FB0H	IS1	IS0	EMB	ERB
FB1H	C	SC2	SC1	SC0

The PSW can be manipulated by 1-bit or 4-bit read/write and by 8-bit read instructions, depending on the specific bit or bits being addressed. The PSW can be addressed during program execution regardless of the current value of the enable memory bank (EMB) flag.

Part or all of the PSW is saved to stack prior to execution of a subroutine call or hardware interrupt. After the interrupt has been processed, the PSW values are popped from the stack back to the PSW address.

When a RESET is generated, the EMB and ERB values are set according to the RESET vector address, and the carry flag is left undefined (or the current value is retained). PSW bits IS0, IS1, SC0, SC1, and SC2 are all cleared to logical zero.

Table 2-5. Program Status Word Bit Descriptions

PSW Bit Identifier	Description	Bit Addressing	Read/Write
IS1, IS0	Interrupt status flags	1, 4	R/W
EMB	Enable memory bank flag	1	R/W
ERB	Enable register bank flag	1	R/W
C	Carry flag	1	R/W
SC2, SC1, SC0	Program skip flags	8	R

INTERRUPT STATUS FLAGS (IS0, IS1)

PSW bits IS0 and IS1 contain the current interrupt execution status values. You can manipulate IS0 and IS1 flags directly using 1-bit RAM control instructions

By manipulating interrupt status flags in conjunction with the interrupt priority register (IPR), you can process multiple interrupts by anticipating the next interrupt in an execution sequence. The interrupt priority control circuit determines the IS0 and IS1 settings in order to control multiple interrupt processing. When both interrupt status flags are set to "0", all interrupts are allowed. The priority with which interrupts are processed is then determined by the IPR.

When an interrupt occurs, IS0 and IS1 are pushed to the stack as part of the PSW and are automatically incremented to the next status. Then, when the interrupt service routine ends with an IRET instruction, IS0 and IS1 values are restored to the PSW. Table 2-6 shows the effects of IS0 and IS1 flag settings.

Table 2-6. Interrupt Status Flag Bit Settings

IS1 Value	IS0 Value	Status of Currently Executing Process	Effect of IS0 and IS1 Settings on Interrupt Request Control
0	0	0	All interrupt requests are serviced
0	1	1	Only high-priority interrupt as determined in the interrupt priority register (IPR) is serviced
1	0	2	No more interrupt requests are serviced
1	1	–	Not applicable; these bit settings are undefined

Since interrupt status flags can be addressed by write instructions, programs can exert direct control over interrupt processing status. Before interrupt status flags can be addressed, however, you must first execute a DI instruction to inhibit additional interrupt routines. When the bit manipulation has been completed, execute an EI instruction to re-enable interrupt processing.

 PROGRAMMING TIP — Setting ISx Flags for Interrupt Processing

The following instruction sequence shows how to use the IS0 and IS1 flags to control interrupt processing:

```
INTB      DI                ; Disable interrupt
          BITR              IS1    ; IS1 ← 0
          BITS              IS0    ; Allow interrupts according to IPR priority level
          EI                ; Enable interrupt
```

EMB FLAG (EMB)

The EMB flag is used to enable whether the memory bank selected by SMB register is to be valid or not. In this way, it controls the addressing mode for data memory banks 0, 1, or 15.

When the EMB flag is "0", the data memory address space is restricted to bank 15 and addresses 000H–07FH of memory bank 0, regardless of the SMB register contents. When the EMB flag is set to "1", the general-purpose areas of bank 0, 1, and 15 can be accessed by using the appropriate SMB value.

 PROGRAMMING TIP — Using the EMB Flag to Select Memory Banks

EMB flag settings for memory bank selection:

1. When EMB = "0":

SMB	1	; Non-essential instruction since EMB = "0"
LD	A,#9H	
LD	90H,A	; (F90H) ← A, bank 15 is selected
LD	34H,A	; (034H) ← A, bank 0 is selected
SMB	0	; Non-essential instruction since EMB = "0"
LD	90H,A	; (F90H) ← A, bank 15 is selected
LD	34H,A	; (034H) ← A, bank 0 is selected
SMB	15	; Non-essential instruction, since EMB = "0"
LD	20H,A	; (020H) ← A, bank 0 is selected
LD	90H,A	; (F90H) ← A, bank 15 is selected

2. When EMB = "1":

SMB	1	; Select memory bank 1
LD	A,#9H	
LD	90H,A	; (190H) ← A, bank 1 is selected
LD	34H,A	; (134H) ← A, bank 1 is selected
SMB	0	; Select memory bank 0
LD	90H,A	; (090H) ← A, bank 0 is selected
LD	34H,A	; (034H) ← A, bank 0 is selected
SMB	15	; Select memory bank 15
LD	20H,A	; Program error, but assembler does not detect it
LD	90H,A	; (F90H) ← A, bank 15 is selected

ERB FLAG (ERB)

The 1-bit register bank enable flag (ERB) determines the range of addressable working register area. When the ERB flag is "1", the working register area from register banks 0 to 3 is selected according to the register bank selection register (SRB). When the ERB flag is "0", register bank 0 is the selected working register area, regardless of the current value of the register bank selection register (SRB).

When an internal RESET is generated, bit 6 of program memory address 0000H is written to the ERB flag. This automatically initializes the flag. When a vectored interrupt is generated, bit 6 of the respective address table in program memory is written to the ERB flag, setting the correct flag status before the interrupt service routine is executed.

During the interrupt routine, the ERB value is automatically pushed to the stack area along with the other PSW bits. Afterwards, it is popped back to the FB0H.0 bit location in the PSW. The initial ERB flag settings for each vectored interrupt are defined using VENTn instructions.

 PROGRAMMING TIP — Using the ERB Flag to Select Register Banks

ERB flag settings for register bank selection:

1. When ERB = "0":

SRB	1	; Register bank 0 is selected (since ERB = "0", the
		; SRB is configured to bank 0)
LD	EA,#34H	; Bank 0 EA ← #34H
LD	HL,EA	; Bank 0 HL ← EA
SRB	2	; Register bank 0 is selected
LD	YZ,EA	; Bank 0 YZ ← EA
SRB	3	; Register bank 0 is selected
LD	WX,EA	; Bank 0 WX ← EA

2. When ERB = "1":

SRB	1	; Register bank 1 is selected
LD	EA,#34H	; Bank 1 EA ← #34H
LD	HL,EA	; Bank 1 HL ← Bank 1 EA
SRB	2	; Register bank 2 is selected
LD	YZ,EA	; Bank 2 YZ ← BANK2 EA
SRB	3	; Register bank 3 is selected
LD	WX,EA	; Bank 3 WX ← Bank 3 EA

SKIP CONDITION FLAGS (SC2, SC1, SC0)

The skip condition flags SC2, SC1, and SC0 indicate the current program skip conditions and are set and reset automatically during program execution. Skip condition flags can only be addressed by 8-bit read instructions. Direct manipulation of the SC2, SC1, and SC0 bits is not allowed.

CARRY FLAG (C)

The carry flag is used to save the result of an overflow or borrow when executing arithmetic instructions involving a carry (ADC, SBC). The carry flag can also be used as a 1-bit accumulator for performing Boolean operations involving bit-addressed data memory.

If an overflow or borrow condition occurs when executing arithmetic instructions with carry (ADC, SBC), the carry flag is set to "1". Otherwise, its value is "0". When a RESET occurs, the current value of the carry flag is retained during power-down mode, but when normal operating mode resumes, its value is undefined.

The carry flag can be directly manipulated by predefined set of 1-bit read/write instructions, independent of other bits in the PSW. Only the ADC and SBC instructions, and the instructions listed in Table 2-7, affect the carry flag.

Table 2-7. Valid Carry Flag Manipulation Instructions

Operation Type	Instructions	Carry Flag Manipulation
Direct manipulation	SCF	Set carry flag to "1"
	RCF	Clear carry flag to "0" (reset carry flag)
	CCF	Invert carry flag value (complement carry flag)
	BTST C	Test carry and skip if C = "1"
Bit transfer	LDB (operand) (1),C	Load carry flag value to the specified bit
	LDB C,(operand) (1)	Load contents of the specified bit to carry flag
Boolean manipulation	BAND C,(operand) (1)	AND the specified bit with contents of carry flag and save the result to the carry flag
	BOR C,(operand) (1)	OR the specified bit with contents of carry flag and save the result to the carry flag
	BXOR C,(operand) (1)	XOR the specified bit with contents of carry flag and save the result to the carry flag
Interrupt routine	INT _n (2)	Save carry flag to stack with other PSW bits
Return from interrupt	IRET	Restore carry flag from stack with other PSW bits

NOTES:

1. The operand has three bit addressing formats: mem.a, memb.@L, and @H + DA.b.
2. 'INT_n' refers to the specific interrupt being executed and is not an instruction.

 PROGRAMMING TIP — Using the Carry Flag as a 1-Bit Accumulator

1. Set the carry flag to logic one:

```
SCF                ; C ← 1
LD      EA,#0C3H   ; EA ← #0C3H
LD      HL,#0AAH   ; HL ← #0AAH
ADC     EA,HL      ; EA ← #0C3H + #0AAH + #1H, C ← 1
```

2. Logical-AND bit 3 of address 3FH with P3.3 and output the result to P5.0:

```
LD      H,#3H      ; Set the upper four bits of the address to the H register
                        ; value
LDB     C,@H+0FH.3 ; C ← bit 3 of 3FH
BAND    C,P3.3     ; C ← C AND P3.3
LDB     P5.0,C     ; Output result from carry flag to P5.0
```

3 ADDRESSING MODES

OVERVIEW

The enable memory bank flag, EMB, controls the two addressing modes for data memory. When the EMB flag is set to logic one, you can address the entire RAM area; when the EMB flag is cleared to logic zero, the addressable area in the RAM is restricted to specific locations.

The EMB flag works in connection with the select memory bank instruction, SMBn. You will recall that the SMBn instruction is used to select RAM bank 0, 1, 2, 3, or 15. The SMB setting is always contained in the upper four bits of a 12-bit RAM address. For this reason, both addressing modes (EMB = "0" and EMB = "1") apply specifically to the memory bank indicated by the SMB instruction, and any restrictions to the addressable area within banks 0, 1, 2, 3, or 15. Direct and indirect 1-bit, 4-bit, and 8-bit addressing methods can be used. Several RAM locations are addressable at all times, regardless of the current EMB flag setting.

Here are a few guidelines to keep in mind regarding data memory addressing:

- When you address peripheral hardware locations in bank 15, the mnemonic for the memory-mapped hardware component can be used as the operand in place of the actual address location.
- Always use an even-numbered RAM address as the operand in 8-bit direct and indirect addressing.
- With direct addressing, use the RAM address as the instruction operand; with indirect addressing, the instruction specifies a register which contains the operand's address.

RAM Areas		Addressing Mode		@HL @H+DA.b		@WX @WL	mema.b	memb.@L
		DA DA.b		EMB = 0	EMB = 1	X	X	X
000H	Working Registers							
01FH								
020H								
07FH	Bank 0 (General Registers and Stack)		SMB = 0		SMB = 0			
080H								
0FFH	Bank 1 (General Registers)		SMB = 1		SMB = 1			
100H								
1FFH	Bank 2 (General Registers)		SMB = 2		SMB = 2			
200H								
2FFH	Bank 3 (General Registers)		SMB = 3		SMB = 3			
300H								
3FFH								
F80H	Bank 15 (Peripheral Hardware Registers)		SMB = 15		SMB = 15	FB0H		
						FBFH		
						FC0H		
FFFH						FF0H		

NOTES:

- 'X' means don't care.
- Blank columns indicate RAM areas that are not addressable, given the addressing method and enable memory bank (EMB) flag setting shown in the column headers.

Figure 3-1. RAM Address Structure

EMB AND ERB INITIALIZATION VALUES

The EMB and ERB flag bits are set automatically by the values of the RESET vector address and the interrupt vector address. When a RESET is generated internally, bit 7 of program memory address 0000H is written to the EMB flag, initializing it automatically. When a vectored interrupt is generated, bit 7 of the respective vector address table is written to the EMB. This automatically sets the EMB flag status for the interrupt service routine. When the interrupt is serviced, the EMB value is automatically saved to stack and then restored when the interrupt routine has completed.

At the beginning of a program, the initial EMB and ERB flag values for each vectored interrupt must be set by using VENT instruction. The EMB and ERB can be set or reset by bit manipulation instructions (BITS, BITR) despite the current SMB setting.

PROGRAMMING TIP — Initializing the EMB and ERB Flags

The following assembly instructions show how to initialize the EMB and ERB flag settings:

```

ORG    0000H        ; ROM address assignment
VENT0  1,0,RESET    ; EMB ← 1, ERB ← 0, branch RESET
VENT1  0,1,INTB     ; EMB ← 0, ERB ← 1, branch INTB
VENT2  0,1,INT0     ; EMB ← 0, ERB ← 1, branch INT0
VENT3  0,1,INT1     ; EMB ← 0, ERB ← 1, branch INT1
VENT4  0,1,INTS     ; EMB ← 0, ERB ← 1, branch INTS
VENT5  0,1,INTT0    ; EMB ← 0, ERB ← 1, branch INTT0
VENT6  0,1,INTT1    ; EMB ← 0, ERB ← 1, branch INTT1
      .
      .
      .
RESET  BITR    EMB

```

ENABLE MEMORY BANK SETTINGS

EMB = "1"

When the enable memory bank flag EMB is set to logic one, you can address the data memory bank specified by the select memory bank (SMB) value (0, 1, 2, 3, or 15) using 1-, 4-, or 8-bit instructions. You can use both direct and indirect addressing modes. The addressable RAM areas when EMB = "1" are as follows:

- If SMB = 0, 000H–0FFH
- If SMB = 1, 100H–1FFH
- If SMB = 2, 200H–2FFH
- If SMB = 3, 300H–3FFH
- If SMB = 15, F80H–FFFH

EMB = "0"

When the enable memory bank flag EMB is set to logic zero, the addressable area is defined independently of the SMB value, and is restricted to specific locations depending on whether a direct or indirect address mode is used.

If EMB = "0", the addressable area is restricted to locations 000H–07FH in bank 0 and to locations F80H–FFFH in bank 15 for direct addressing. For indirect addressing, only locations 000H–0FFH in bank 0 are addressable, regardless of SMB value.

To address the peripheral hardware register (bank 15) using indirect addressing, the EMB flag must first be set to "1" and the SMB value to "15". When a RESET occurs, the EMB flag is set to the value contained in bit 7 of ROM address 0000H.

EMB-Independent Addressing

At any time, several areas of the data memory can be addressed independently of the current status of the EMB flag. These exceptions are described in Table 3-1.

Table 3-1. RAM Addressing not Affected by the EMB Value

Address	Addressing Method	Affected Hardware	Program Examples
000H–0FFH	4-bit indirect addressing using WX and WL register pairs; 8-bit indirect addressing using SP	Not applicable	LD A,@WX PUSH POP
FB0H–FBFH FF0H–FFFH	1-bit direct addressing	PSW, IEx, IRQx, I/O	BITS EMB BITR IE4
FC0H–FFFH	1-bit indirect addressing using the L register	I/O	BAND C,P3.@L

SELECT BANK REGISTER (SB)

The select bank register (SB) is used to assign the memory bank and register bank. The 8-bit SB register consists of the 4-bit select register bank register (SRB) and the 4-bit select memory bank register (SMB), as shown in Figure 3-2.

During interrupts and subroutine calls, SB register contents can be saved to stack in 8-bit units by the PUSH SB instruction. You later restore the value to the SB using the POP SB instruction.

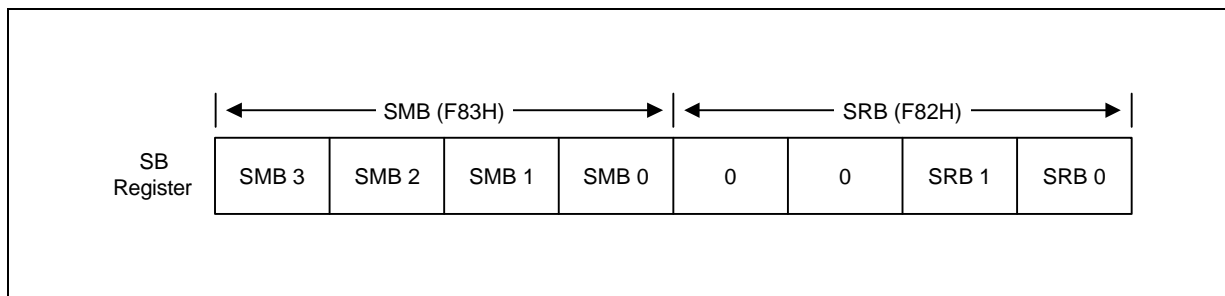


Figure 3-2. SMB and SRB Values in the SB Register

Select Register Bank (SRB) Instruction

The select register bank (SRB) value specifies which register bank is to be used as a working register bank. The SRB value is set by the 'SRB n' instruction, where n = 0, 1, 2, 3.

One of the four register banks is selected by the combination of ERB flag status and the SRB value that is set using the 'SRB n' instruction. The current SRB value is retained until another register is requested by program software. PUSH SB and POP SB instructions are used to save and restore the contents of SRB during interrupts and subroutine calls. RESET clears the 4-bit SRB value to logic zero.

Select Memory Bank (SMB) Instruction

To select one of the four available data memory banks, you must execute an SMB n instruction specifying the number of the memory bank you want (0, 1, 2, 3, or 15). For example, the instruction 'SMB 1' selects bank 1 and 'SMB 15' selects bank 15. (And remember to enable the selected memory bank by making the appropriate EMB flag setting.

The upper four bits of the 12-bit data memory address are stored in the SMB register. If the SMB value is not specified by software (or if a RESET does not occur) the current value is retained. RESET clears the 4-bit SMB value to logic zero.

The PUSH SB and POP SB instructions save and restore the contents of the SMB register to and from the stack area during interrupts and subroutine calls.

DIRECT AND INDIRECT ADDRESSING

1-bit, 4-bit, and 8-bit data stored in data memory locations can be addressed directly using a specific register or bit address as the instruction operand.

Indirect addressing specifies a memory location that contains the required direct address. The KS57 instruction set supports 1-bit, 4-bit, and 8-bit indirect addressing. For 8-bit indirect addressing, an even-numbered RAM address must always be used as the instruction operand.

1-BIT ADDRESSING

Table 3-2. 1-Bit Direct and Indirect RAM Addressing

Operand Notation	Addressing Mode Description	EMB Flag Setting	Addressable Area	Memory Bank	Hardware I/O Mapping
DA.b	Direct: bit is indicated by the RAM address (DA), memory bank selection, and specified bit number (b).	0	000H–07FH	Bank 0	All 1-bit addressable peripherals (SMB = 15)
			F80H–FFFH	Bank 15	
		1	000H–FFFH	SMB = 0, 1, 2, 3, 15	
mema.b	Direct: bit is indicated by addressable area (mema) and bit number (b).	x	FB0H–FBFH FF0H–FFFH	Bank 15	IS0, IS1, EMB, ERB, IEx, IRQx, Pn.n
memb.@L	Indirect: lower two bits of register L is indicated by the upper 10 bits of RAM area (memb) and the upper two bits of register L.	x	FC0H–FFFH	Bank 15	BSCn.x Pn.n
@H + DA.b	Indirect: bit is indicated by the lower four bits of the address (DA), memory bank selection, and the H register identifier.	0	000H–0FFH	Bank 0	All 1-bit addressable peripherals (SMB = 15)
		1	000H–FFFH	SMB = 0, 1, 2, 3, 15	

NOTE: x = not applicable.

PROGRAMMING TIP — 1-Bit Addressing Modes

1-Bit Direct Addressing

1. If EMB = "0":

AFLAG	EQU	34H.3	
BFLAG	EQU	85H.3	
CFLAG	EQU	0BAH.0	
	SMB	0	
	BITS	AFLAG	; 34H.3 ← 1
	BITS	BFLAG	; F85H.3 (BMOD.3) ← 1
	BTST	CFLAG	; If FBAH.0 (IRQW) = 1, skip
	BITS	BFLAG	; Else if, FBAH.0 (IRQW) = 0, F85H.3 (BMOD.3) ← 1
	BITS	P3.0	; FF3H.0 (P3.0) ← 1

2. If EMB = "1":

AFLAG	EQU	34H.3	
BFLAG	EQU	85H.3	
CFLAG	EQU	0BAH.0	
	SMB	0	
	BITS	AFLAG	; 34H.3 ← 1
	BITS	BFLAG	; 85H.3 ← 1
	BTST	CFLAG	; If 0BAH.0 = 1, skip
	BITS	BFLAG	; Else if 0BAH.0 = 0, 085H.3 ← 1
	BITS	P3.0	; FF3H.0 (P3.0) ← 1

1-Bit Indirect Addressing

1. If EMB = "0":

AFLAG	EQU	34H.3	
BFLAG	EQU	85H.3	
CFLAG	EQU	0BAH.0	
	SMB	0	
	LD	H,#0BH	; H ← #0BH
	BTSTZ	@H+CFLAG	; If 0BAH.0 = 1, 0BAH.0 ← 0 and skip
	BITS	CFLAG	; Else if 0BAH.0 = 0, FBAH.0 (IRQW) ← 1

2. If EMB = "1":


AFLAG	EQU	34H.3	
BFLAG	EQU	85H.3	
CFLAG	EQU	0BAH.0	
	SMB	0	
	LD	H,#0BH	; H ← #0BH
	BTSTZ	@H+CFLAG	; If 0BAH.0 = 1, 0BAH.0 ← 0 and skip
	BITS	CFLAG	; Else if 0BAH.0 = 0, 0BAH.0 ← 1

4-BIT ADDRESSING

Table 3-3. 4-Bit Direct and Indirect RAM Addressing

Operand Notation	Addressing Mode Description	EMB Flag Setting	Addressable Area	Memory Bank	Hardware I/O Mapping
DA	Direct: 4-bit address indicated by the RAM address (DA) and the memory bank selection	0	000H–07FH	Bank 0	–
			F80H–FFFH	Bank 15	All 4-bit addressable peripherals (SMB = 15)
		1	000H–FFFH	SMB = 0, 1, 2, 3, 15	
@HL	Indirect: 4-bit address indicated by the memory bank selection and register HL	0	000H–0FFH	Bank 0	–
		1	000H–FFFH	SMB = 0, 1, 2, 3, 15	All 4-bit addressable peripherals (SMB = 15)
@WX	Indirect: 4-bit address indicated by register WX	x	000H–0FFH	Bank 0	–
@WL	Indirect: 4-bit address indicated by register WL	x	000H–0FFH	Bank 0	

NOTE: x = not applicable.

 PROGRAMMING TIP — 4-Bit Addressing Modes

4-Bit Direct Addressing

1. If EMB = "0":

```

ADATA EQU 46H
BDATA EQU 8EH
SMB 15 ; Non-essential instruction, since EMB = "0"
LD A,P3 ; A ← (P3)
SMB 0 ; Non-essential instruction, since EMB = "0"
LD ADATA,A ; (046H) ← A
LD BDATA,A ; (F8EH) ← A
    
```

2. If EMB = "1":

```

ADATA EQU 46H
BDATA EQU 8EH
SMB 15
LD A,P3 ; A ← (P3)
SMB 0
LD ADATA,A ; (046H) ← A
LD BDATA,A ; (08EH) ← A
    
```

 **PROGRAMMING TIP — 4-Bit Addressing Modes (Continued)**

4-Bit Indirect Addressing (Example 1)

1. If EMB = "0", compare bank 0 locations 040H–046H with bank 0 locations 060H–066H:

ADATA	EQU	46H	
BDATA	EQU	66H	
	SMB	1	; Non-essential instruction, since EMB = "0"
	LD	HL,#BDATA	
	LD	WX,#ADATA	
COMP	LD	A,@WL	; A ← bank 0 (040H–046H)
	CPSE	A,@HL	; If bank 0 (060H–066H) = A, skip
	SRET		
	DECS	L	
	JR	COMP	
	RET		

2. If EMB = "1", compare bank 0 locations 040H–046H to bank 1 locations 160H–166H:

ADATA	EQU	46H	
BDATA	EQU	66H	
	SMB	1	
	LD	HL,#BDATA	
	LD	WX,#ADATA	
COMP	LD	A,@WL	; A ← bank 0 (040H–046H)
	CPSE	A,@HL	; If bank 1 (160H–166H) = A, skip
	SRET		
	DECS	L	
	JR	COMP	
	RET		

 **PROGRAMMING TIP — 4-Bit Addressing Modes (Concluded)**

4-Bit Indirect Addressing (Example 2)

1. If EMB = "0", exchange bank 0 locations 040H–046H with bank 0 locations 060H–066H:

ADATA	EQU	46H	
BDATA	EQU	66H	
	SMB	1	; Non-essential instruction, since EMB = "0"
	LD	HL,#BDATA	
	LD	WX,#ADATA	
TRANS	LD	A,@WL	; A ← bank 0 (040H–046MH)
	XCHD	A,@HL	; Bank 0 (060H–066H) ← A
	JR	TRANS	


2. If EMB = "1", exchange bank 0 locations 040H–046H to bank 1 locations 160H–166H:

ADATA	EQU	46H	
BDATA	EQU	66H	
	SMB	1	
	LD	HL,#BDATA	
	LD	WX,#ADATA	
TRANS	LD	A,@WL	; A ← bank 0 (040H–046H)
	XCHD	A,@HL	; Bank 1 (160H–166H) ← A
	JR	TRANS	

8-BIT ADDRESSING

Table 3-4. 8-Bit Direct and Indirect RAM Addressing

Instruction Notation	Addressing Mode Description	EMB Flag Setting	Addressable Area	Memory Bank	Hardware I/O Mapping
DA	Direct: 8-bit address indicated by the RAM address (<i>DA = even number</i>) and memory bank selection	0	000H–07FH	Bank 0	–
			F80H–FFFH	Bank 15	All 8-bit addressable peripherals (SMB = 15)
		1	000H–FFFH	SMB = 0, 1, 2, 3, 15	(SMB = 15)
@HL	Indirect: the 8-bit address indicated by the memory bank selection and register HL; (the 4-bit L register value must be an even number)	0	000H–0FFH	Bank 0	–
		1	000H–FFFH	SMB = 0, 1, 2, 3, 15	All 8-bit addressable peripherals (SMB = 15)

 **PROGRAMMING TIP — 8-Bit Addressing Modes**
8-Bit Direct Addressing

1. If EMB = "0":

ADATA	EQU	46H	
BDATA	EQU	8EH	
	SMB	15	; Non-essential instruction, since EMB = "0"
	LD	EA,P4	; E ← (P5), A ← (P4)
	SMB	0	
	LD	ADATA,EA	; (046H) ← A, (047H) ← E
	LD	BDATA,EA	; (F8EH) ← A, (F8FH) ← E

2. If EMB = "1":

ADATA	EQU	46H	
BDATA	EQU	8EH	
	SMB	15	
	LD	EA,P4	; E ← (P5), A ← (P4)
	SMB	0	
	LD	ADATA,EA	; (046H) ← A, (047H) ← E
	LD	BDATA,EA	; (08EH) ← A, (08FH) ← E

8-Bit Indirect Addressing

1. If EMB = "0":

ADATA	EQU	46H	
	SMB	1	; Non-essential instruction, since EMB = "0"
	LD	HL,#ADATA	
	LD	EA,@HL	; A ← (046H), E ← (047H)

2. If EMB = "1":

ADATA	EQU	46H	
	SMB	1	
	LD	HL,#ADATA	
	LD	EA,@HL	; A ← (146H), E ← (147H)

4 MEMORY MAP

OVERVIEW

To support program control of peripheral hardware, I/O addresses for peripherals are memory-mapped to bank 15 of the RAM. Memory mapping lets you use a mnemonic as the operand of an instruction in place of the specific memory location.

Access to bank 15 is controlled by the select memory bank (SMB) instruction and by the enable memory bank flag (EMB) setting. If the EMB flag is "0", bank 15 can be addressed using direct addressing, regardless of the current SMB value. 1-bit direct and indirect addressing can be used for specific locations in bank 15, regardless of the current EMB value.

I/O MAP FOR HARDWARE REGISTERS

Table 4-1 contains detailed information about I/O mapping for peripheral hardware in bank 15 (register locations F80H–FFFH). Use the I/O map as a quick-reference source when writing application programs. The I/O map gives you the following information:

- Register address
- Register name (mnemonic for program addressing)
- Bit values (both addressable and non-manipulable)
- Read-only, write-only, or read and write addressability
- 1-bit, 4-bit, or 8-bit data manipulation characteristics

Table 4-1. I/O Map for Memory Bank 15

Memory Bank 15							Addressing Mode		
Address	Register	Bit 3	Bit 2	Bit 1	Bit 0	R/W	1-Bit	4-Bit	8-Bit
F80H	SP	.3	.2	.1	"0"	R/W	No	No	Yes
F81H		.7	.6	.5	.4				
F82H–F84H are not mapped.									
F85H	BMOD	.3	.2	.1	.0	W	.3	Yes	No
F86H	BCNT					R	No	No	Yes
F87H									
F88H	WMOD	.3	.2	.1	.0	W	.3 ⁽¹⁾	No	Yes
F89H		.7	"0"	.5	.4				
F8AH–F8FH are not mapped.									
F90H	TMOD0	.3	.2	"0"	"0"	W	.3	No	Yes
F91H		"0"	.6	.5	.4				
F92H		TOE1	TOE0	BOE	"0"	R/W	Yes	Yes	No
F93H		"0"	TOL1	TOL0	"0"	R	Yes	Yes	No
F94H	TCNT0					R	No	No	Yes
F95H									
F96H	TREF0					W	No	No	Yes
F97H									
F98H	WDMOD	.3	.2	.1	.0	W	No	No	Yes
F99H		.7	.6	.5	.4				
F9AH	WDFLAG ⁽²⁾	WDTCF	"0"	"0"	"0"	W	Yes	Yes	No
FA0H	TMOD1	.3	.2	"0"	"0"	W	.3	No	Yes
FA1H		"0"	.6	.5	.4				
FA2H–FA3H are not mapped.									
FA4H	TCNT1					R	No	No	Yes
FA5H									
FA6H–FA7H are not mapped.									
FA8H	TREF1					W	No	No	Yes
FA9H									
FAAH–FABH are not mapped.									
FACH	DTMR	"0"	.2	.1	.0	W	No	No	Yes
FADH		.7	.6	.5	.4				

Table 4-1. I/O Map for Memory Bank 15 (Continued)

Memory Bank 15							Addressing Mode		
Address	Register	Bit 3	Bit 2	Bit 1	Bit 0	R/W	1-Bit	4-Bit	8-Bit
FAEH–FAFH are not mapped.									
FB0H	PSW	IS1	IS0	EMB	ERB	R/W	Yes	Yes	Yes
FB1H		C ⁽³⁾	SC2	SC1	SC0	R	No	No	
FB2H	IPR	IME	.2	.1	.0	W	IME	Yes	No
FB3H	PCON	.3	.2	.1	.0	W	No	Yes	No
FB4H	IMOD0	.3	"0"	.1	.0	W	No	Yes	No
FB5H	IMOD1	"0"	"0"	"0"	.0	W			
FB6H	IMOD2	"0"	"0"	.1	.0	W			
FB7H	SCMOD	.3	.2	"0"	.0	W	Yes	No	No
FB8H		IE4	IRQ4	IEB	IRQB	R/W	Yes	Yes	No
FB9H is not mapped.									
FBAH		"0"	"0"	IEW	IRQW	R/W	Yes	Yes	No
FBBH		"0"	"0"	IET1	IRQT1				
FBCH		"0"	"0"	IET0	IRQT0				
FBDH		"0"	"0"	IES	IRQS				
FBEH		IE1	IRQ1	IE0	IRQ0				
FBFH		"0"	"0"	IE2	IRQ2				
FC0H	BSC0								
FC1H	BSC1								
FC2H	BSC2					R/W	Yes	Yes	Yes
FC3H	BSC3								
FC4H – FCFH are not mapped.									
FD0H	CLMOD	.3	"0"	.1	.0	W	No	Yes	No
FD1H – FD9H are not mapped.									
FDAH	PNE1	PNE4.3	PNE4.2	PNE4.1	PNE4.0	W	No	No	Yes
FDBH		PNE5.3	PNE5.2	PNE5.1	PNE5.0				
FDCH	PUMOD1	PUR3	PUR2	PUR1	PUR0	W	No	No	Yes
FDDH		PUR9	PUR8	PUR7	PUR6				
FDEH	PUMOD2	PUR13	PDR12	PUR11	PUR10	W	No	No	Yes
PDFH		"0"	"0"	PUR5	PUR4				
FE0H	SMOD	.3	.2	.1	.0	W	.3	No	Yes
FE1H		.7	.6	.5	"0"				

Table 4-1. I/O Map for Memory Bank 15 (Concluded)

Memory Bank 15							Addressing Mode		
Address	Register	Bit 3	Bit 2	Bit 1	Bit 0	R/W	1-Bit	4-Bit	8-Bit
FE2H									
FE3H									
FE4H	SBUF					R/W	No	No	Yes
FE5H									
FE6H									
FE7H									
FE8H	PMG1	PM0.3	PM0.2	PM0.1	PM0.0	W	No	No	Yes
FE9H		PM7	"0"	PM5	PM4				
FEAH	PMG2	PM2.3	PM2.2	PM2.1	PM2.0				Yes
FEBH		PM3.3	PM3.2	PM3.1	PM3.0				
FECH	PMG3	PM6.3	PM6.2	PM6.1	PM6.0				Yes
FEDH		PM8.3	PM8.2	PM8.1	PM8.0				
FEEH	PMG4	PM12.3	PM12.2	PM12.1	PM12.0				Yes
FEFH		PM13	PM11	PM10	PM9				
FF0H	Port 0	.3	.2	.1	.0	R/W	Yes	Yes	No
FF1H	Port 1	.3	.2	.1	.0	R			
FF2H	Port 2	.3	.2	.1	.0	R/W			No
FF3H	Port 3	.3	.2	.1	.0	R/W			
FF4H	Port 4	.3	.2	.1	.0	R/W			Yes
FF5H	Port 5	.3/.7	.2/.6	.1/.5	.0/.4	R/W			
FF6H	Port 6	.3	.2	.1	.0	R/W			Yes
FF7H	Port 7	.3/.7	.2/.6	.1/.5	.0/.4	R/W			
FF8H	Port 8	.3	.2	.1	.0	R/W			No
FF9H	Port 9	.3	.2	.1	.0	R/W			
FFAH	Port 10	.3	.2	.1	.0	R/W			Yes
FFBH	Port 11	.3/.7	.2/.6	.1/.5	.0/.4	R/W			
FFCH	Port 12	.3	.2	.1	.0	R/W			No
FFDH	Port 13	.3	.2	.1	.0	R/W			
FFEH									
FFFH									

NOTES:

1. Bit 3 in the WMOD register is read only.
2. F9AH.0 F9AH.2 are fixed to "0"
3. The carry flag can be read or written by specific bit manipulation instructions only.

REGISTER DESCRIPTIONS

In this section, register descriptions are presented in a consistent format to familiarize you with the memory-mapped I/O locations in bank 15 of the RAM. Figure 4–1 describes features of the register description format. Register descriptions are arranged in alphabetical order. Programmers can use this section as a quick-reference source when writing application programs.

Counter registers, buffer registers, and reference registers, as well as the stack pointer and port I/O latches, are not included in these descriptions. More detailed information about how these registers are used is included in Part II of this manual, "Hardware Descriptions," in the context of the corresponding peripheral hardware module descriptions.

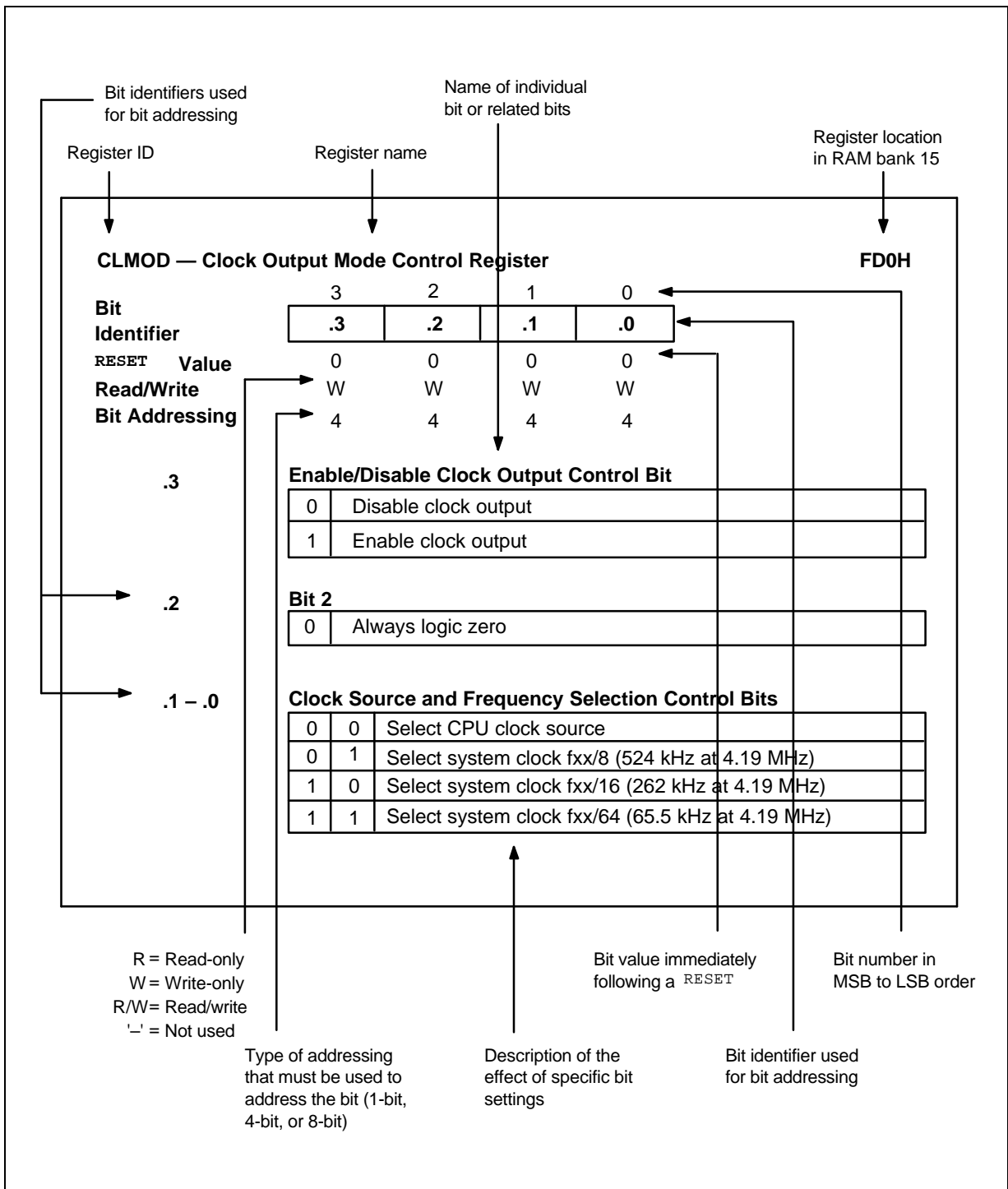


Figure 4-1. Register Description Format

BMOD — Basic Timer Mode Register

BT

F85H

Bit	3	2	1	0
Identifier	.3	.2	.1	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	1/4	4	4	4

BMOD.3**Basic Timer Restart Bit**

1	Restart basic timer, then clear IRQB flag, BCNT and BMOD.3 to logic zero
---	--

BMOD.2 – .0**Input Clock Frequency and Interrupt Interval Time Control Bits**

0	0	0	Input clock frequency: Interrupt interval time:	$f_{xx}/2^{12}$ (0.87 kHz) $2^{20}/f_{xx}$ (292.9 ms)
0	1	1	Input clock frequency: Interrupt interval time:	$f_{xx}/2^9$ (6.99 kHz) $2^{17}/f_{xx}$ (36.6 ms)
1	0	1	Input clock frequency: Interrupt interval time:	$f_{xx}/2^7$ (27.9 kHz) $2^{15}/f_{xx}$ (9.15 ms)
1	1	1	Input clock frequency: Interrupt interval time:	$f_{xx}/2^5$ (111.8 kHz) $2^{13}/f_{xx}$ (2.29 ms)

NOTES:

1. Interrupt interval time is the time required to set the IRQB to "1" periodically.
2. When a RESET occurs, the oscillation stabilization time is 36.6 ms ($2^{17}/f_{xx}$) at 3.579545 MHz.
3. 'fxx' is the system clock rate given a clock frequency of 3.579545 MHz.

CLMOD — Clock Output Mode Register

CPU

FD0H

Bit	3	2	1	0
Identifier	.3	"0"	.1	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	4	4	4	4

CLMOD.3 **Enable/Disable Clock Output Control Bit**

0	Disable clock output
1	Enable clock output

CLMOD.2 **Bit 2**

0	Always logic zero
---	-------------------

CLMOD.1 – .0 **Clock Source and Frequency Selection Control Bits**

0	0	Select CPU clock source fx/4, fx/8, fx/64 or fxt/4 (0.89 MHz, 447 kHz, or 55.9 kHz)
0	1	Select system clock fxx/8 (447.4 kHz)
1	0	Select system clock fxx/16 (223.7 kHz)
1	1	Select system clock fxx/64 (55.9 kHz)

NOTE: 'fxx' is the system clock, given a clock frequency of 3.579545 MHz.

DTMR — DTMF Mode Register**DTMF****FACH, FADH**

Bit	3	2	1	0	3	2	1	0
Identifier	.7	.6	.5	.4	–	.2	.1	.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

DTMR.7 – .4**DTMR Bit Values for Keyboard Inputs**

0	0	0	0	Function key D
0	0	0	1	1
0	0	1	0	2
0	0	1	1	3
0	1	0	0	4
0	1	0	1	5
0	1	1	0	6
0	1	1	1	7
1	0	0	0	8
1	0	0	1	9
1	0	1	0	0
1	0	1	1	*
1	1	0	0	#
1	1	0	1	Function key A
1	1	1	0	Function key B
1	1	1	1	Function key C

DTMR.3**Bit 3**

–	Don't care
---	------------

DTMR.2 – .1**Tone Selection Bits**

0	0	Dual-tone enable
1	0	Dual-tone enable (alternate setting)
0	1	Single-column tone enable
1	1	Single-low tone enable

DTMR.0**DTMF Operation Enable/Disable Bit**

0	Disable DTMF operation
1	Enable DTMF operation

IE0, 1, IRQ0, 1 — INT0, 1 Interrupt Enable/Request Flags**CPU FBEH**

Bit	3	2	1	0
Identifier	IE1	IRQ1	IE0	IRQ0
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

IE1**INT1 Interrupt Enable Flag**

0	Disable interrupt requests at the INT1 pin
1	Enable interrupt requests at the INT1 pin

IRQ1**INT1 Interrupt Request Flag**

–	Generate INT1 interrupt (This bit is set and cleared automatically by hardware when rising or falling edge detected at INT1 pin.)
---	---

IE0**INT0 Interrupt Enable Flag**

0	Disable interrupt requests at the INT0 pin
1	Enable interrupt requests at the INT0 pin

IRQ0**INT0 Interrupt Request Flag**

–	Generate INT0 interrupt (This bit is set and cleared automatically by hardware when rising or falling edge detected at INT0 pin.)
---	---

IE2, IRQ2 — INT2 Interrupt Enable/Request Flags

CPU

FBFH

Bit	3	2	1	0
Identifier	"0"	"0"	IE2	IRQ2
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

.3 – .2

Bits 3–2

0	Always logic zero
---	-------------------

IE2

INT2 Interrupt Enable Flag

0	Disable INT2 interrupt requests at the INT2 pin or KS0–KS7 pins
1	Enable INT2 interrupt requests at the INT2 pin or KS0–KS7 pins

IRQ2

INT2 Interrupt Request Flag

–	Generate INT2 quasi-interrupt (This bit is set and is not cleared automatically by hardware when a rising edge is detected at INT2 or when a falling edge is detected at one of the KS0–KS7 pins. Since INT2 is a quasi-interrupt, IRQ2 flag must be cleared by software.)
---	--

IE4, IRQ4 — INT4 Interrupt Enable/Request Flags CPU FB8H

IEB, IRQB — INTB Interrupt Enable/Request Flags CPU FB8H

Bit	3	2	1	0
Identifier	IE4	IRQ4	IEB	IRQB
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

IE4 **INT4 Interrupt Enable Flag**

0	Disable interrupt requests at the INT4 pin
1	Enable interrupt requests at the INT4 pin

IRQ4 **INT4 Interrupt Request Flag**

–	Generate INT4 interrupt (This bit is set and cleared automatically by hardware when rising and falling signal edge detected at INT4 pin.)
---	---

IEB **INTB Interrupt Enable Flag**

0	Disable INTB interrupt requests
1	Enable INTB interrupt requests

IRQB **INTB Interrupt Request Flag**

–	Generate INTB interrupt (This bit is set and cleared automatically by hardware when reference interval signal received from basic timer.)
---	---

IES, IRQS — INTS Interrupt Enable/Request Flags

CPU

FBDH

Bit	3	2	1	0
Identifier	"0"	"0"	IES	IRQS
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

.3 – .2

Bits 3–2

0	Always logic zero
---	-------------------

IES

INTS Interrupt Enable Flag

0	Disable INTS interrupt requests
1	Enable INTS interrupt requests

IRQS

INTS Interrupt Request Flag

–	Generate INTS interrupt (This bit is set and cleared automatically by hardware when serial data transfer completion signal received from serial I/O interface.)
---	---



IET0, IRQT0 — INTT0 Interrupt Enable/Request Flags

CPU

FBCH

Bit	3	2	1	0
Identifier	"0"	"0"	IET0	IRQT0
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

.3 – .2

Bits 3–2

0	Always logic zero
---	-------------------

IET0**INTT0 Interrupt Enable Flag**

0	Disable INTT0 interrupt requests
1	Enable INTT0 interrupt requests

IRQT0**INTT0 Interrupt Request Flag**

–	Generate INTT0 interrupt (This bit is set and cleared automatically by hardware when contents of TCNT0 and TREF0 registers match.)
---	--

IET1, IRQT1 — INTT1 Interrupt Enable/Request Flags

CPU

FBBH

Bit	3	2	1	0
Identifier	"0"	"0"	IET1	IRQT1
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

.3 – .2

Bits 3–2

0	Always logic 0
---	----------------

IET1

INTT1 Interrupt Enable Flag

0	Disable INTT1 interrupt requests
1	Enable INTT1 interrupt requests

IRQT1

INTT1 Interrupt Request Flag

–	Generate INTT1 interrupt (This bit is set and cleared automatically by hardware when contents of TCNT1 and TREF1 registers match.)
---	--

IEW, IRQW — INTW Interrupt Enable/Request Flags

CPU

FBAH

Bit	3	2	1	0
Identifier	"0"	"0"	IEW	IRQW
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W
Bit Addressing	1/4	1/4	1/4	1/4

.3 – .2

Bits 3–2

0	Always logic zero
---	-------------------

IEW**INTW Interrupt Enable Flag**

0	Disable INTW interrupt requests
1	Enable INTW interrupt requests

IRQW**INTW Interrupt Request Flag**

–	Generate INTW interrupt (This bit is set when the timer interval is set to 0.5 seconds or 3.91 milliseconds at the watch timer frequency of 32.768 kHz.)
---	--

NOTE: Since INTW is a quasi-interrupt, the IRQW flag must be cleared by software.

IMOD0 — External Interrupt 0 (INT0) Mode Register

CPU

FB4H

Bit	3	2	1	0
Identifier	.3	"0"	.1	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	4	4	4	4

IMOD0.3**Interrupt Sampling Clock Selection Bit**

0	Select CPU clock as a sampling clock
1	Select sampling clock frequency of the selected system clock (f _{xx} /64)

IMOD0.2**Bit 2**

0	Always logic zero
---	-------------------

IMOD0.1 – .0**External Interrupt Mode Control Bits**

0	0	Interrupt requests are triggered by a rising signal edge
0	1	Interrupt requests are triggered by a falling signal edge
1	0	Interrupt requests are triggered by both rising and falling signal edges
1	1	Interrupt request flag (IRQ _x) cannot be set to logic one

IMOD1 — External Interrupt 1 (INT1) Mode Register

CPU

FB5H

Bit	3	2	1	0
Identifier	"0"	"0"	"0"	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	4	4	4	4

IMOD1.3 – .1**Bits 3–1**

0	Always logic zero
---	-------------------

IMOD1.0**External Interrupt 1 Edge Detection Control Bit**

0	Rising edge detection
1	Falling edge detection

IMOD2 — External Interrupt 2 (INT2) Mode Register

CPU

FB6H

Bit	3	2	1	0
Identifier	"0"	"0"	.1	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	4	4	4	4

IMOD2.3 – .2**Bits 3–2**

0	Always logic zero
---	-------------------

IMOD2.1 – .0**External Interrupt 2 Edge Detection Selection Bit**

0	0	Interrupt request at INT2 pin triggered by rising edge
0	1	Interrupt request at KS4–KS7 triggered by falling edge
1	0	Interrupt request at KS2–KS7 triggered by falling edge
1	1	Interrupt request at KS0–KS7 triggered by falling edge

IPR — Interrupt Priority Register CPU FB2H

Bit	3	2	1	0
Identifier	IME	.2	.1	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	1/4	4	4	4

IME Interrupt Master Enable Bit (MSB)

0	Disable all interrupt processing
1	Enable processing of all interrupt service requests

IPR.2 – .0 Interrupt Priority Assignment Bits

0	0	0	Normal interrupt processing according to default priority settings
0	0	1	Process INTB and INT4 interrupts at highest priority
0	1	0	Process INT0 interrupts at highest priority
0	1	1	Process INT1 interrupts at highest priority
1	0	0	Process INTS interrupts at highest priority
1	0	1	Process INTT0 interrupts at highest priority
1	1	0	Process INTT1 interrupts at highest priority

NOTE: During normal interrupt processing, interrupts are processed in the order in which they occur. If two or more interrupts occur simultaneously, the processing order is determined by the default interrupt priority settings shown below. Using the IPR settings, you can select specific interrupts for high-priority processing in the event of contention. When the high-priority (IPR) interrupt has been processed, waiting interrupts are handled according to their default priorities. The default priorities are as follows ('1' is highest priority; '6' is lowest priority):

INTB, INT4	1
INT0	2
INT1	3
INTS	4
INTT0	5
INTT1	6

PCON — Power Control Register

CPU

FB3H

Bit	3	2	1	0
Identifier	.3	.2	.1	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	4	4	4	4

PCON.3 – .2**CPU Operating Mode Control Bits**

0	0	Enable normal CPU operating mode
0	1	Initiate idle power-down mode
1	0	Initiate stop power-down mode

PCON.1 – .0**CPU Clock Frequency Selection Bits**

0	0	Select fxx/64
1	0	Select fxx/8
1	1	Select fxx/4

NOTE: 'fxx' is the system clock.

PMG1 — Port I/O Mode Flags (Group 1: Ports 0, 4, 5, 7) I/O FE9H, FE8H

Bit	7	6	5	4	3	2	1	0
Identifier	PM7	"0"	PM5	PM4	PM0.3	PM0.2	PM0.1	PM0.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

PM7 Port 7 I/O Mode Selection Flag

0	Set port 7 to input mode
1	Set port 7 to output mode

.6 Bit 6

0	Always logic zero
---	-------------------

PM5 Port 5 I/O Mode Selection Flag

0	Set port 5 to input mode
1	Set port 5 to output mode

PM4 Port 4 I/O Mode Selection Flag

0	Set port 4 to input mode
1	Set port 4 to output mode

PM0.3 P0.3 I/O Mode Selection Flag

0	Set P0.3 to input mode
1	Set P0.3 to output mode

PM0.2 P0.2 I/O Mode Selection Flag

0	Set P0.2 to input mode
1	Set P0.2 to output mode

PM0.1 P0.1 I/O Mode Selection Flag

0	Set P0.1 to input mode
1	Set P0.1 to output mode

PM0.0 P0.0 I/O Mode Selection Flag

0	Set P0.0 to input mode
1	Set P0.0 to output mode

PMG2 — Port I/O Mode Flags (Group 2: Ports 2, 3)

I/O

FEBH, FEAH

Bit	7	6	5	4	3	2	1	0
Identifier	PM3.3	PM3.2	PM3.1	PM3.0	PM2.3	PM2.2	PM2.1	PM2.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

PM3.3

P3.3 I/O Mode Selection Flag

0	Set P3.3 to input mode
1	Set P3.3 to output mode

PM3.2

P3.2 I/O Mode Selection Flag

0	Set P3.2 to input mode
1	Set P3.2 to output mode

PM3.1

P3.1 I/O Mode Selection Flag

0	Set P3.1 to input mode
1	Set P3.1 to output mode

PM3.0

P3.0 I/O Mode Selection Flag

0	Set P3.0 to input mode
1	Set P3.0 to output mode

PM2.3

P2.3 I/O Mode Selection Flag

0	Set P2.3 to input mode
1	Set P2.3 to output mode

PM2.2

P2.2 I/O Mode Selection Flag

0	Set P2.2 to input mode
1	Set P2.2 to output mode

PM2.1

P2.1 I/O Mode Selection Flag

0	Set P2.1 to input mode
1	Set P2.1 to output mode

PM2.0

P2.0 I/O Mode Selection Flag

0	Set P2.0 to input mode
1	Set P2.0 to output mode



PMG3 — Port I/O Mode Flags (Group 3: Ports 6, 8)

I/O FEDH, FECH

Bit	7	6	5	4	3	2	1	0
Identifier	PM8.3	PM8.2	PM8.1	PM8.0	PM6.3	PM6.2	PM6.1	PM6.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

PM8.3 P8.3 I/O Mode Selection Flag

0	Set P8.3 to input mode
1	Set P8.3 to output mode

PM8.2 P8.2 I/O Mode Selection Flag

0	Set P8.2 to input mode
1	Set P8.2 to output mode

PM8.1 P8.1 I/O Mode Selection Flag

0	Set P8.1 to input mode
1	Set P8.1 to output mode

PM8.0 P8.0 I/O Mode Selection Flag

0	Set P8.0 to input mode
1	Set P8.0 to output mode

PM6.3 P6.3 I/O Mode Selection Flag

0	Set P6.3 to input mode
1	Set P6.3 to output mode

PM6.2 P6.2 I/O Mode Selection Flag

0	Set P6.2 to input mode
1	Set P6.2 to output mode

PM6.1 P6.1 I/O Mode Selection Flag

0	Set P6.1 to input mode
1	Set P6.1 to output mode

PM6.0 P6.0 I/O Mode Selection Flag

0	Set P6.0 to input mode
1	Set P6.0 to output mode

PMG4 — Port I/O Mode Flags (Group 4: Ports 9, 10, 11, 12, 13) I/O FEFH, FEEH

Bit	7	6	5	4	3	2	1	0
Identifier	PM13	PM11	PM10	PM9	PM12.3	PM12.2	PM12.1	PM12.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

PM13 Port 13 I/O Mode Selection Flag

0	Set port 13 to input mode
1	Set port 13 to output mode

PM11 Port 11 I/O Mode Selection Flag

0	Set port 11 to input mode
1	Set port 11 to output mode

PM10 Port 10 I/O Mode Selection Flag

0	Set port 10 to input mode
1	Set port 10 to output mode

PM9 Port 9 I/O Mode Selection Flag

0	Set port 9 to input mode
1	Set port 9 to output mode

PM12.3 P12.3 I/O Mode Selection Flag

0	Set P12.3 to input mode
1	Set P12.3 to output mode

PM12.2 P12.2 I/O Mode Selection Flag

0	Set P12.2 to input mode
1	Set P12.2 to output mode

PM12.1 P12.1 I/O Mode Selection Flag

0	Set P12.1 to input mode
1	Set P12.1 to output mode

PM12.0 P12.0 I/O Mode Selection Flag

0	Set P12.0 to input mode
1	Set P12.0 to output mode

PNE 1 — Port Open-Drain Enable Register 1

FDBH, FDAH

Bit	7	6	5	4	3	2	1	0
Identifier	PNE5.3	PNE5.2	PNE5.1	PNE5.0	PNE4.3	PNE4.2	PNE4.1	PNE4.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

PNE5.3**P5.3 Output mode Control Bit**

0	Push-pull output
1	N-channel open-drain output

PNE5.2**P5.2 Output mode Control Bit**

0	Push-pull output
1	N-channel open-drain output

PNE5.1**P5.1 Output mode Control Bit**

0	Push-pull output
1	N-channel open-drain output

PNE5.0**P5.0 Output mode Control Bit**

0	Push-pull output
1	N-channel open-drain output

PNE4.3**P4.3 Output mode Control Bit**

0	Push-pull output
1	N-channel open-drain output

PNE4.2**P4.2 Output mode Control Bit**

0	Push-pull output
1	N-channel open-drain output

PNE4.1**P4.1 Output mode Control Bit**

0	Push-pull output
1	N-channel open-drain output

PNE4.0**P4.0 Output mode Control Bit**

0	Push-pull output
1	N-channel open-drain output

PSW — Program Status Word

CPU

FB1H, FB0H

Bit	7	6	5	4	3	2	1	0
Identifier	C	SC2	SC1	SC0	IS1	IS0	EMB	ERB
RESET Value	(1)	0	0	0	0	0	0	0
Read/Write	R/W	R	R	R	R/W	R/W	R/W	R/W
Bit Addressing	(2)	8	8	8	1/4/8	1/4/8	1/4/8	1/4/8

C**Carry Flag**

0	No overflow or borrow condition exists
1	An overflow or borrow condition does exist

SC2–SC0**Skip Condition Flags**

0	No skip condition exists; no direct manipulation of these bits is allowed
1	A skip condition exists; no direct manipulation of these bits is allowed

IS1, IS0**Interrupt Status Flags**

0	0	Service all interrupt requests
0	1	Service only the high-priority interrupt(s) as determined in the interrupt priority register (IPR)
1	0	Do not service any more interrupt requests
1	1	Undefined

EMB**Enable Data Memory Bank Flag**

0	Restrict program access to data memory to bank 15 (F80H–FFFH) and to the locations 000H–07FH in the bank 0 only
1	Enable full access to data memory banks 0, 1, 2, 3, and 15

ERB**Enable Register Bank Flag**

0	Select register bank 0 as working register area
1	Select register banks 0, 1, 2, or 3 as working register area in accordance with the select register bank (SRB) instruction operand

NOTES:

1. The value of the carry flag after a RESET occurs during normal operation is undefined. If a RESET occurs during power-down mode (IDLE or STOP), the current value of the carry flag is retained.
2. The carry flag can only be addressed by a specific set of 1-bit manipulation instructions. See Section 2 for detailed information.

PUMOD1 — Pull-up Resistor Mode Register 1 I/O FDDH, FDCH

Bit	7	6	5	4	3	2	1	0
Identifier	PUR9	PUR8	PUR7	PUR6	PUR3	PUR2	PUR1	PUR0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

PUR9 **Connect/Disconnect Port 9 Pull-up Resistor Control Bit**

0	Disconnect port 9 pull-up resistor
1	Connect port 9 pull-up resistor

PUR8 **Connect/Disconnect Port 8 Pull-up Resistor Control Bit**

0	Disconnect port 8 pull-up resistor
1	Connect port 8 pull-up resistor

PUR7 **Connect/Disconnect Port 7 Pull-up Resistor Control Bit**

0	Disconnect port 7 pull-up resistor
1	Connect port 7 pull-up resistor

PUR6 **Connect/Disconnect Port 6 Pull-up Resistor Control Bit**

0	Disconnect port 6 pull-up resistor
1	Connect port 6 pull-up resistor

PUR3 **Connect/Disconnect Port 3 Pull-up Resistor Control Bit**

0	Disconnect port 3 pull-up resistor
1	Connect port 3 pull-up resistor

PUR2 **Connect/Disconnect Port 2 Pull-up Resistor Control Bit**

0	Disconnect port 2 pull-up resistor
1	Connect port 2 pull-up resistor

PUR1 **Connect/Disconnect Port 1 Pull-up Resistor Control Bit**

0	Disconnect port 1 pull-up resistor
1	Connect port 1 pull-up resistor

PUR0 **Connect/Disconnect Port 0 Pull-up Resistor Control Bit**

0	Disconnect port 0 pull-up resistor
1	Connect port 0 pull-up resistor

PUMOD2 — Pull-up Resistor Mode Register 2

I/O

FDFH, FDEH

Bit	7	6	5	4	3	2	1	0
Identifier	"0"	"0"	PUR5	PUR4	PUR13	PDR12	PUR11	PUR10
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

.7 – .6

Bits 7–6

0	Always cleared to logic zero
---	------------------------------

PUR5

Connect/Disconnect Port 5 Pull-Up Resistor Control Bit

0	Disconnect port 5 pull-up resistor
1	Connect port 5 pull-up resistor

PUR4

Connect/Disconnect Port 4 Pull-Up Resistor Control Bit

0	Disconnect port 4 pull-up resistor
1	Connect port 4 pull-up resistor

PUR13

Connect/Disconnect Port 13 Pull-Up Resistor Control Bit

0	Disconnect port 13 pull-up resistor
1	Connect port 13 pull-up resistor

PDR12

Connect/Disconnect Port 12 Pull-Down Resistor Control Bit

0	Disconnect port 12 pull-down resistor
1	Connect port 12 pull-down resistor

PUR11

Connect/Disconnect Port 11 Pull-Up Resistor Control Bit

0	Disconnect port 11 pull-up resistor
1	Connect port 11 pull-up resistor

PUR10

Connect/Disconnect Port 10 Pull-Up Resistor Control Bit

0	Disconnect port 10 pull-up resistor
1	Connect port 10 pull-up resistor

SCMOD — System Clock Mode Control Register

CPU

FB7H

Bit	3	2	1	0
Identifier	.3	.2	"0"	.0
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	1	1	1	1

SCMOD.3**Bit 3**

0	Enable main system clock
1	Disable main system clock

SCMOD.2**Bit 2**

0	Enable sub system clock
1	Disable sub system clock

SCMOD.1**Bit 1**

0	Always logic zero
---	-------------------

SCMOD.0**Bit 0**

0	Select main system clock
1	Select sub system clock

NOTES:

- SCMOD bits 3 and 0 cannot be modified simultaneously by a 4-bit instruction; they can only be modified by separate 1-bit instructions.
- Sub-oscillation goes into stop mode only by SCMOD.2. PCON which revokes stop mode cannot stop the sub-oscillation. The stop of sub-oscillation is released only by reset regardless of the value of SCMOD.2.
- You can use SCMOD.2 as follows (ex; after data bank was used, a few minutes have passed):
Main operation → sub-operation → sub-idle → sub-operation → main operation → SCMOD.2 = 1 → main stop mode.

SMOD — Serial I/O Mode Register

SIOFE1H, FE0H

Bit	7	6	5	4	3	2	1	0
Identifier	.7	.6	.5	"0"	.3	.2	.1	.0
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	1/8	8	8	8

SMOD.7 – .5

Serial I/O Clock Selection and SBUF R/W Status Control Bits

0	0	0	Use an external clock at the SCK pin; Enable SBUF when SIO operation is halted or when SCK goes high
0	0	1	Use the TOL0 clock from timer/counter 0; Enable SBUF when SIO operation is halted or when SCK goes high
0	1	x	Use the selected CPU clock (fxx/4, 8, or 64; 'fxx' is the system clock) then, enable SBUF read/write operation. 'x' means 'don't care.'
1	0	0	3.49 kHz clock (fxx/2 ¹⁰)
1	1	1	223.7 kHz clock (fxx/2 ⁴); Note: You cannot select a fxx/2 ⁴ clock frequency if you have selected a CPU clock of fx/64

NOTE: All kHz frequency ratings assume a system clock of 3.579545 MHz.

SMOD.4

Bit 4

0	Always logic zero
---	-------------------

SMOD.3

Initiate Serial I/O Operation Bit

1	Clear IRQS flag and 3-bit clock counter to logic zero; then initiate serial transmission. When SIO transmission starts, this bit is cleared by hardware to logic 0.
---	---

SMOD.2

Enable/Disable SIO Data Shifter and Clock Counter Bit

0	Disable the data shifter and clock counter; the contents of IRQS flag is retained when serial transmission is completed
1	Enable the data shifter and clock counter; The IRQS flag is set to logic one when serial transmission is completed

SMOD.1

Serial I/O Transmission Mode Selection Bit

0	Receive-only mode
1	Transmit-and-receive mode

SMOD.0

LSB/MSB Transmission Mode Selection Bit

0	Transmit the most significant bit (MSB) first
1	Transmit the least significant bit (LSB) first

TMOD0 — Timer/Counter 0 Mode Register

T/C0

F91H, F90H

Bit	3	2	1	0	3	2	1	0
Identifier	"0"	.6	.5	.4	.3	.2	"0"	"0"
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	1/8	8	8	8

TMOD0.7

Bit 7

0	Always logic zero
---	-------------------

TMOD0.6 – .4

Timer/Counter 0 Input Clock Selection Bits

0	0	0	External clock input at TCL0 pin on rising edge
0	0	1	External clock input at TCL0 pin on falling edge
1	0	0	Internal system clock (fxx) of 3.579545 MHz/2 ¹⁰ (3.49 kHz)
1	0	1	Select clock: fxx/2 ⁶ (55.93 kHz at 3.579545 MHz)
1	1	0	Select clock: fxx/2 ⁴ (223.7 kHz at 3.579545 MHz)
1	1	1	Select clock: fxx (3.579545 MHz)

TMOD0.3

Clear Counter and Resume Counting Control Bit

1	Clear TCNT0, IRQT0, and TOL0 and resume counting immediately (This bit is cleared automatically when counting starts.)
---	--

TMOD0.2

Enable/Disable Timer/Counter 0 Bit

0	Disable timer/counter 0; retain TCNT0 contents
1	Enable timer/counter 0

TMOD0.1

Bit 1

0	Always logic zero
---	-------------------

TMOD0.0

Bit 0

0	Always logic zero
---	-------------------

TMOD1 — Timer/Counter 1 Mode Register

T/C1

FA1H, FA0H

Bit	3	2	1	0	3	2	1	0
Identifier	"0"	.6	.5	.4	.3	.2	"0"	"0"
RESET Value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	1/8	8	8	8

TMOD1.7

Bit 7

0	Always logic zero
---	-------------------

TMOD1.6 – .4

Timer/Counter 0 Input Clock Selection Bits

0	0	0	External clock input at TCL1 pin on rising edge
0	0	1	External clock input at TCL1 pin on falling edge
1	0	0	Internal system clock (f _{xx}) of 3.579545 MHz/2 ¹² (0.87 kHz)
1	0	1	Select clock: f _{xx} /2 ¹⁰ (3.49 kHz at 3.579545 MHz)
1	1	0	Select clock: f _{xx} /2 ⁸ (13.98 kHz at 3.579545 MHz)
1	1	1	Select clock: f _{xx} /2 ⁶ (55.93 kHz at 3.579545 MHz)

TMOD1.3

Clear Counter and Resume Counting Control Bit

1	Clear TCNT1, IRQT1, and TOL1 and resume counting immediately (This bit is cleared automatically when counting starts.)
---	--

TMOD1.2

Enable/Disable Timer/Counter 0 Bit

0	Disable timer/counter 1; retain TCNT1 contents
1	Enable timer/counter 1

TMOD1.1

Bit 1

0	Always logic zero
---	-------------------

TMOD1.0

Bit 0

0	Always logic zero
---	-------------------

TOE — Timer Output Enable Flag Register

T/C

F92H

Bit	3	2	1	0
Identifier	TOE1	TOE0	BOE	"0"
RESET Value	0	0	0	0
Read/Write	R/W	R/W	R/W	W
Bit Addressing	1/4	1/4	1/4	1/4

TOE1 Timer/Counter 1 Output Enable Flag

0	Disable timer/counter 1 output to the TCLO1 pin
1	Enable timer/counter 1 output to the TCLO1 pin

TOE0 Timer/Counter 0 Output Enable Flag

0	Disable timer/counter 0 output at the TCLO0 pin
1	Enable timer/counter 0 output at the TCLO0 pin

BOE Basic Timer Output Enable Flag

0	Disable basic timer output at the BTCO pin
1	Enable basic timer output at the BTCO pin

.0 Bit 0

0	Always logic zero
---	-------------------

WDFLAG — Watchdog Timer’s Counter Clear Flag

WT

F9AH

Bit	3	2	1	0
Identifier	WDTCF	"0"	"0"	"0"
RESET Value	0	0	0	0
Read/Write	W	W	W	W
Bit Addressing	1/4	4	4	4

WDTCF

Watchdog Timer's Counter Clear Bit

0	—
1	Clear the WDT's counter to zero and restart the WDT's counter

WDFLAG.2–0

Bits 2–0

0	Always logic zero
---	-------------------



WDMOD — Watchdog Timer Mode Control Register **WT** **F99H,F98H**

Bit	7	6	5	4	3	2	1	0
Identifier	.7	.6	.5	.4	.3	.2	.1	.0
RESET Value	1	0	1	0	0	1	0	1
Read/Write	W	W	W	W	W	W	W	W
Bit Addressing	8	8	8	8	8	8	8	8

WDMOD.7-0

Watchdog Timer Enable/Disable Control

0	1	0	1	1	0	1	0	Disable watchdog timer function
Others								Enable watchdog timer function

WMOD — Watch Timer Mode Register**WT****F89H, F88H**

Bit	3	2	1	0	3	2	1	0
Identifier	.7	.6	.5	.4	.3	.2	.1	.0
RESET Value	0	0	0	0	(note)	0	0	0
Read/Write	W	W	W	W	R	W	W	W
Bit Addressing	8	8	8	8	1	8	8	8

WMOD.7**Enable/Disable Buzzer Output Bit**

0	Disable buzzer (BUZ) signal output
1	Enable buzzer (BUZ) signal output

WMOD.6**Bit 6**

0	Always logic zero
---	-------------------

WMOD.5 – .4**Output Buzzer Frequency Selection Bits**

0	0	fw/16 buzzer (BUZ) signal output (2 kHz)
0	1	fw/8 buzzer (BUZ) signal output (4 kHz)
1	0	fw/4 buzzer (BUZ) signal output (8 kHz)
1	1	fw/2 buzzer (BUZ) signal output (16 kHz)

WMOD.3**XT_{in} Input Level Control Bit**

0	Input level to XT _{in} pin is low; 1-bit read-only addressable for tests
1	Input level to XT _{in} pin is high; 1-bit read-only addressable for tests

WMOD.2**Enable/Disable Watch Timer Bit**

0	Disable watch timer and clear frequency dividing circuits
1	Enable watch timer

WMOD.1**Watch Timer Speed Control Bit**

0	Normal speed; set IRQW to 0.5 seconds
1	High-speed operation; set IRQW to 3.91 ms

WMOD.0**Watch Timer Clock Selection Bit**

0	Select main system clock (f _{xx})/128 as the watch timer clock (fw)
1	Select a subsystem clock as the watch timer clock (fw)

NOTES:

- System clock of 4.19 MHz and typical subsystem clock of 32.768 kHz are assumed.
- RESET sets WMOD.3 to the current input level of the subsystem clock, XT_{in}. If the input level is high, WMOD.3 is set to logic one; if low, WMOD.3 is cleared to zero along with all the other bits in the WMOD register.



NOTES

Oscillator Circuits

Interrupts

Power-Down

RESET

I/O Ports

Timers and Timer/Counters

DTMF Generator

Serial I/O Interface

Electrical Data

Mechanical Data

KS57P5532 OTP

Development Tools

6 OSCILLATOR CIRCUITS

OVERVIEW

The KS57C5532 microcontrollers have two oscillator circuits: a main system clock circuit, and a subsystem clock circuit. The CPU and peripheral hardware operate on the system clock frequency supplied through these circuits. Specifically, a clock pulse is required by the following peripheral modules:

- Basic timer
- Timer/counters 0 and 1
- Watch timer
- Serial I/O interface
- Clock output circuit

CPU Clock Notation

In this document, the following notation is used for descriptions of the CPU clock:

- fx Main system clock
- fxT Subsystem clock
- fxX Selected system clock

Clock Control Registers

When the system clock mode register, SCMOD, and the power control register, PCON, registers are both cleared to zero after RESET, the normal CPU operating mode is enabled, a main system clock of fx/64 is selected, and main system clock oscillation is initiated.

The PCON is used to select normal CPU operating mode or one of two power-down modes — stop or idle. Bits 3 and 2 of the PCON register can be manipulated by a STOP or IDLE instruction to engage stop or idle power-down mode.

The SCMOD, lets you select the *main system clock (fx)* or a *subsystem clock (fxT)* as the CPU clock and to start (or stop) main/sub system clock oscillation. The resulting clock source, either main system clock or subsystem clock, is referred to as the *selected system clock (fxX)*.

The main system clock is selected and oscillation started when all SCMOD bits are cleared to "0". By setting SCMOD.3, SCMOD.2 and SCMOD.0 to different values, you can select a subsystem clock source and start or stop main/sub system clock oscillation. To stop main system clock oscillation, You must use the stop instruction (assuming the main system clock is selected) or manipulate SCMOD.3 to "1" (assuming the sub system clock is selected).

The main system clock frequencies can be divided by 4, 8, or 64 and a subsystem clock frequencies can only be divided by 4. By manipulating PCON bits 1 and 0, you select one of the following frequencies as the CPU clock.

$$\frac{fx}{4}, \frac{fx}{8}, \frac{fx}{64}, \frac{fxt}{4}$$

Using a subsystem clock

If a subsystem clock is being used as the selected system clock, the idle power-down mode can be initiated by executing an IDLE instruction.

The watch timer and buzzer operate normally with a subsystem clock source, since they operate at very low speed (as low as 122 μ s at 32.768 KHz) and with very low power consumption.

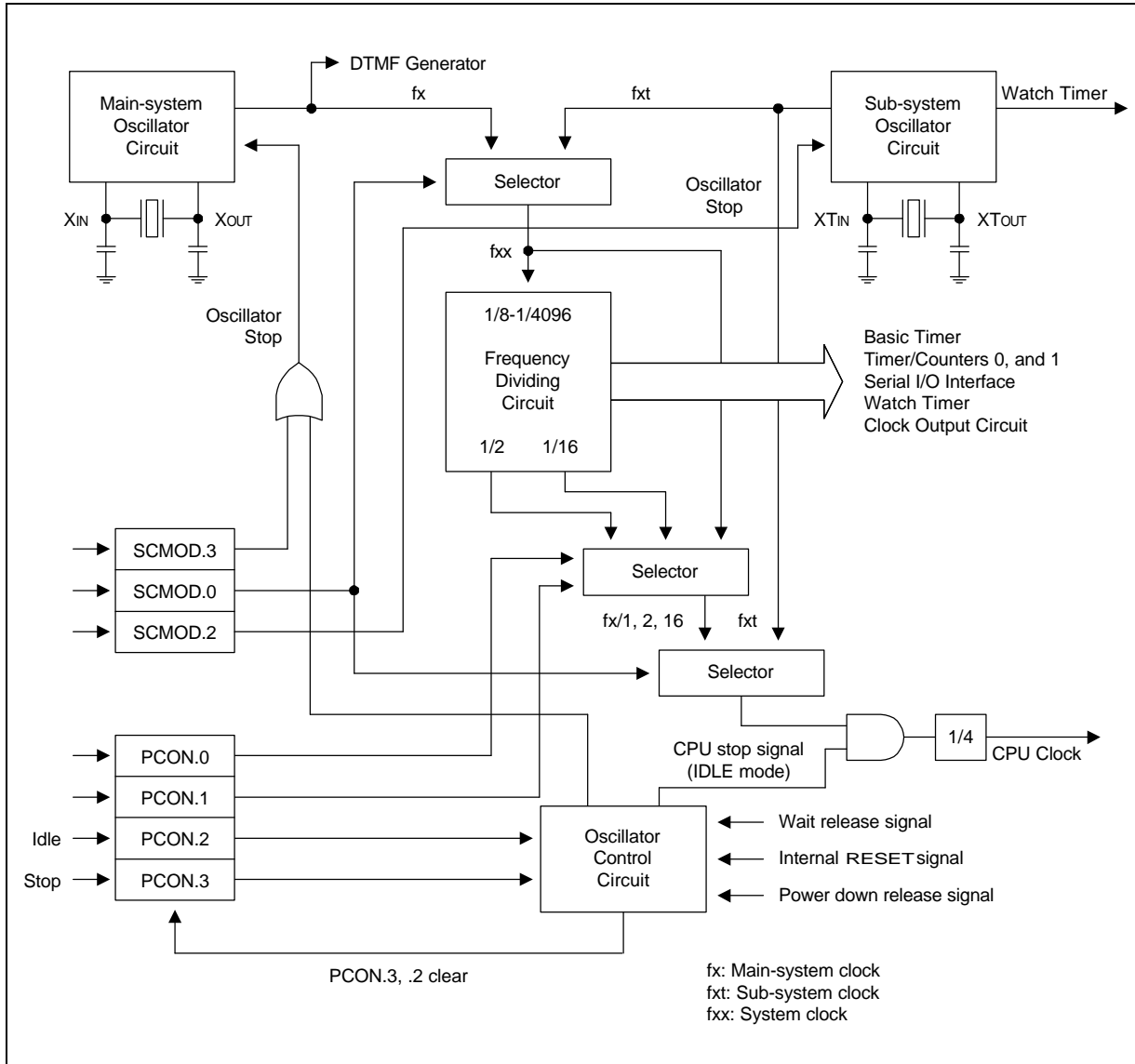


Figure 6-1. Clock Circuit Diagram

MAIN SYSTEM OSCILLATOR CIRCUITS

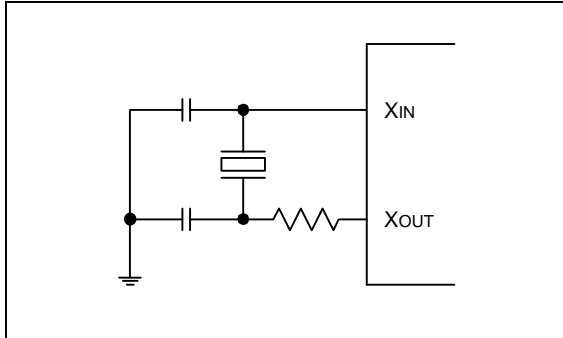


Figure 6-2. Crystal/Ceramic Oscillator

SUBSYSTEM OSCILLATOR CIRCUITS

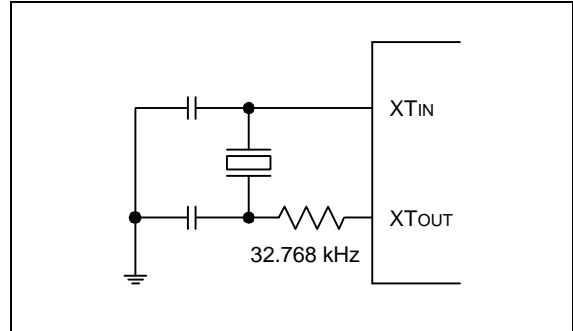


Figure 6-5. Crystal/Ceramic Oscillator

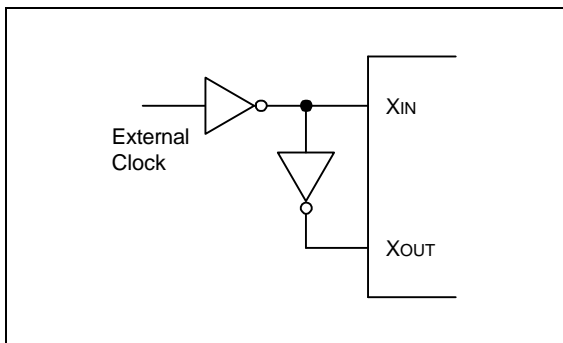


Figure 6-3. External Oscillator (fx)

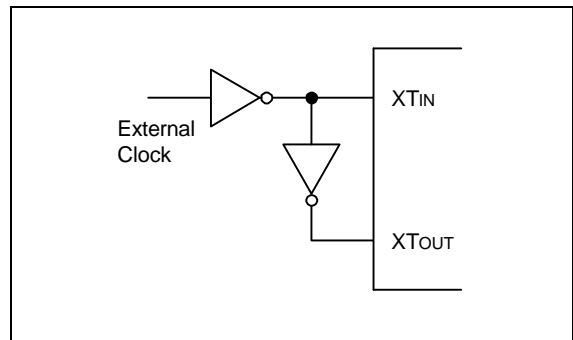


Figure 6-6. External Oscillator

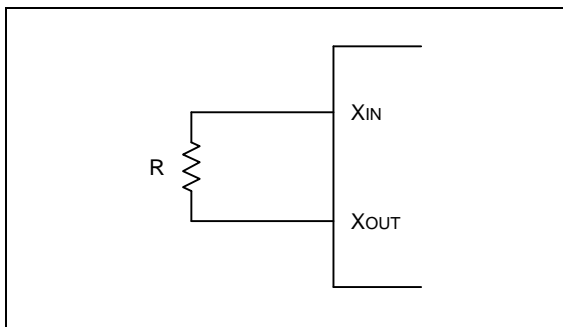
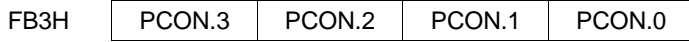


Figure 6-4. RC Oscillator

POWER CONTROL REGISTER (PCON)

The power control register, PCON, is a 4-bit register that is used to select the CPU clock frequency and to control CPU operating and power-down modes. PCON can be addressed directly by 4-bit write instructions or indirectly by the instructions IDLE and STOP.



PCON bits 3 and 2 are addressed by the STOP and IDLE instructions, respectively, to engage the idle and stop power-down modes. Idle and stop modes can be initiated by these instruction despite the current value of the enable memory bank flag (EMB). PCON bits 1 and 0 are used to select a specific system clock frequency. There are two basic choices:

- Main system clock (fx) or subsystem clock (fxt);
- Divided fx clock frequency of 4, 8, or 64.

PCON.1 and PCON.0 settings are also connected with the system clock mode control register, SCMOD. If SCMOD.0 = "0" the main system clock is always selected by the PCON.1 and PCON.0 setting; if SCMOD.0 = "1" the subsystem clock is selected.

RESET sets PCON register values (and SCMOD) to logic zero: SCMOD.3 and SCMOD.0 select the main system clock (fx) and start clock oscillation; PCON.1 and PCON.0 divide the selected fx frequency by 64, and PCON.3 and PCON.2 enable normal CPU operating mode.

Table 6-1. Power Control Register (PCON) Organization

PCON Bit Settings		Resulting CPU Operating Mode
PCON.3	PCON.2	
0	0	Normal CPU operating mode
0	1	Idle power-down mode
1	0	Stop power-down mode

PCON Bit Settings		Resulting CPU Clock Frequency	
PCON.1	PCON.0	If SCMOD.0 = "0"	If SCMOD.0 = "1"
0	0	fx/64	—
1	0	fx/8	—
1	1	fx/4	fxt/4

PROGRAMMING TIP — Setting the CPU Clock

To set the CPU clock to 0.89 MHz at 3.579545 MHz:

```

BITS      EMB
SMB      15
LD        A,#3H
LD        PCON,A
    
```

INSTRUCTION CYCLE TIMES

The unit of time that equals one machine cycle varies depending on whether the main system clock (fx) or a subsystem clock (fxt) is used, and on how the oscillator clock signal is divided (by 4, 8, or 64). Table 6-2 shows corresponding cycle times in microseconds.

Table 6-2. Instruction Cycle Times for CPU Clock Rates

Selected CPU Clock	Resulting Frequency	Oscillation Source	Cycle Time (μsec)
fx/64	55.9 kHz	fx = 3.579545 MHz	17.88
fx/8	447.4 kHz		2.23
fx/4	0.89 MHz		1.12
fxt/4	8.19 kHz	fxt = 32.768 kHz	122.0

SYSTEM CLOCK MODE REGISTER (SCMOD)

The system clock mode register, SCMOD, is a 4-bit register that is used to select the CPU clock and to control main system clock oscillation. RESET clears all SCMOD values to logic zero, selecting the main system clock (fx) as the CPU clock and starting clock oscillation.

Only SCMOD.0, SCMOD.2 and SCMOD.3 bits of the SCMOD register can be manipulated by 1-bit write instructions. (In other words, SCMOD.0 SCMOD.2 and SCMOD.3 cannot be modified simultaneously by a 4-bit write.) Bit 1 is always logic zero.

FB7H	SCMOD.3	SCMOD.2	"0"	SCMOD.0
------	---------	---------	-----	---------

A subsystem clock (fxt) can be selected as the system clock by manipulating the SCMOD.3 and SCMOD.0 bit settings. If SCMOD.3 = "0" and SCMOD.0 = "1", the subsystem clock is selected and main system clock oscillation continues. If SCMOD.3 = "1" and SCMOD.0 = "1", fxt is selected, but main system clock oscillation stops.

Even if you have selected fx as the CPU clock, setting SCMOD.3 to "1" will not stop main system clock oscillation, but malfunction may be occurred. To operate safely, main system clock should be stopped by a stop instruction in main system clock mode.

Table 6-3. System Clock Mode Register (SCMOD) Organization

SCMOD Register Bit Settings		Resulting Clock Selection	
SCMOD.3	SCMOD.0	CPU Clock	fx Oscillation
0	0	fx	On
0	1	fxt	On
1	1	fxt	Off

Table 6-4. SCMOD.2 for Sub-Oscillation on/off

SCMOD.2	Sub-oscillation on/off
0	Enable sub system clock
1	Disable sub system clock

SWITCHING THE CPU CLOCK

Together, bit settings in the power control register, PCON, and the system clock mode register, SCMOD, determine whether a main system or a subsystem clock is selected as the CPU clock, and also how this frequency is to be divided. This makes it possible to switch dynamically between main and subsystem clocks and to modify operating frequencies.

SCMOD.3 and SCMOD.0 select the main system clock (fx) or a subsystem clock (fxt) and start or stop main system clock oscillation. PCON.1 and PCON.0 control the frequency divider circuit, and divide the selected fx clock by 4, 8, or 64.

NOTE

A clock switch operation does not go into effect immediately when you make the SCMOD and PCON register modifications — the previously selected clock continues to run for a certain number of machine cycles.

For example, you are using the default CPU clock (normal operating mode and a main system clock of fx/64) and you want to switch from the fx clock to a subsystem clock and to stop the main system clock. To do this, you first need to set SCMOD.0 to "1". This switches the clock from fx to fxt but allows main system clock oscillation to continue. Before the switch actually goes into effect, a certain number of machine cycles must elapse. After this time interval, you can then disable main system clock oscillation by setting SCMOD.3 to "1".

This same 'stepped' approach must be taken to switch from a subsystem clock to the main system clock: first, clear SCMOD.3 to "0" to enable main system clock oscillation. Then, after a certain number of machine cycles has elapsed, select the main system clock by clearing all SCMOD values to logic zero.

Following a RESET, CPU operation starts with the lowest main system clock frequency of 15.3 μsec at 4.19 MHz after the standard oscillation stabilization interval of 31.3 ms has elapsed. Table 6-5 details the number of machine cycles that must elapse before a CPU clock switch modification goes into effect.

Table 6-5. Elapsed Machine Cycles During CPU Clock Switch

BEFORE	AFTER	SCMOD.0 = 0				SCMOD.0 = 1
		PCON.1 = 0	PCON.0 = 0	PCON.1 = 1	PCON.0 = 1	
SCMOD.0 = 0	PCON.1 = 0	N/A		1 Machine Cycle		N/A
	PCON.0 = 0					
	PCON.1 = 1	8 Machine Cycles		N/A		N/A
	PCON.0 = 0					
	PCON.1 = 1	16 Machine Cycles		16 Machine Cycles		fx/4fxt
SCMOD.0 = 1		N/A		N/A		fx/4fxt (M/C)

NOTES:

1. Even if oscillation is stopped by setting SCMOD.3 during main system clock operation, the stop mode is not entered.
2. Since the Xin input is connected internally to V_{SS} to avoid current leakage due to the crystal oscillator in stop mode, do not set SCMOD.3 to "1", or stop instruction when an external clock is used as the main system clock.
3. When the system clock is switched to the subsystem clock, it is necessary to disable any interrupts which may occur during the time intervals shown in Table 6-5.
4. 'N/A' means 'not available'.

 PROGRAMMING TIP — Switching Between Main System and Subsystem Clock

1. Switch from the main system clock to the subsystem clock:

```
MA2SUB  BITS      SCMOD.0      ; Switches to subsystem clock
        CALL      DLY80        ; Delay 80 machine cycles
        BITS      SCMOD.3      ; Stop the main system clock
        RET
DLY80   LD         A,#0FH
DEL1    NOP
        NOP
        DECS      A
        JR        DEL1
        RET
```

2. Switch from the subsystem clock to the main system clock:

```
SUB2MA  BITR      SCMOD.3      ; Start main system clock oscillation
        CALL      DLY80        ; Delay 80 machine cycles
        BITR      SCMOD.0      ; Switch to main system clock
        RET
```

CLOCK OUTPUT MODE REGISTER (CLMOD)

The clock output mode register, CLMOD, is a 4-bit register that is used to enable or disable clock output to the CLO pin and to select the CPU clock source and frequency. CLMOD is addressable by 4-bit write instructions only.

FD0H	CLMOD.3	"0"	CLMOD.1	CLMOD.0
------	---------	-----	---------	---------

RESET clears CLMOD to logic zero, which automatically selects the CPU clock as the clock source (without initiating clock oscillation), and disables clock output.

CLMOD.3 is the enable/disable clock output control bit; CLMOD.1 and CLMOD.0 are used to select one of four possible clock sources and frequencies: normal CPU clock, fxx/8, fxx/16, or fxx/64.

Table 6-5. Clock Output Mode Register (CLMOD) Organization

CLMOD Bit Settings		Resulting Clock Output	
CLMOD.1	CLMOD.0	Clock Source	Frequency
0	0	CPU clock (fx/4, fx/8, fx/64 or fxt/4)	0.89 MHz, 447.4 kHz, 55.9 kHz
0	1	fxx/8	447.4 kHz
1	0	fxx/16	223.7 kHz
1	1	fxx/64	55.9 kHz

CLMOD.3	Result of CLMOD.3 Setting
0	Clock output is disabled
1	Clock output is enabled

NOTE: Frequencies assume that fxx = 3.579545 MHz.

CLOCK OUTPUT CIRCUIT

The clock output circuit, used to output clock pulses to the CLO pin, has the following components:

- 4-bit clock output mode register (CLMOD)
- Clock selector
- Output latch
- Port mode flag
- CLO output pin (P2.2)

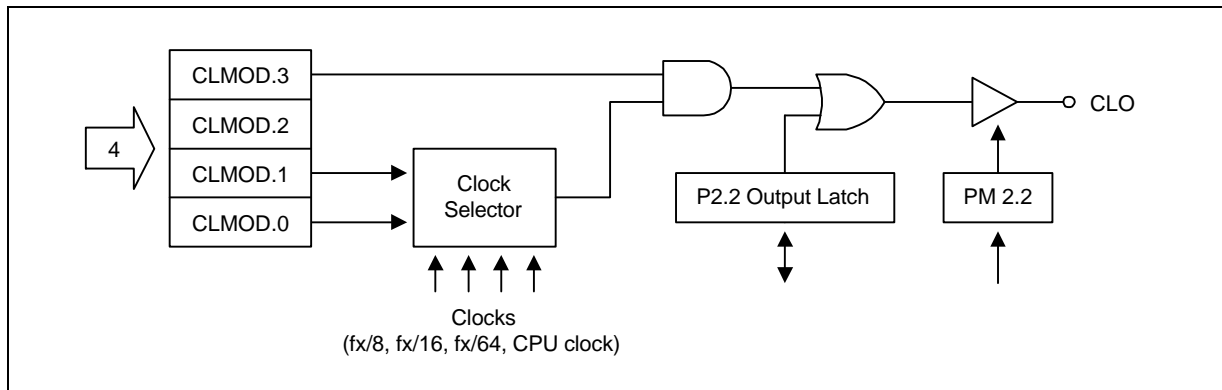


Figure 6-7. CLO Output Pin Circuit Diagram

CLOCK OUTPUT PROCEDURE

The procedure for outputting clock pulses to the CLO pin may be summarized as follows:

1. Disable clock output by clearing CLMOD.3 to logic zero.
2. Set the clock output frequency (CLMOD.1, CLMOD.0).
3. Load a "0" to the output latch of the CLO pin (P2.2).
4. Set the P2.2 mode flag (PM2.2) to output mode.
5. Enable clock output by setting CLMOD.3 to logic one.

 **PROGRAMMING TIP — CPU Clock Output to the CLO Pin**

To output the CPU clock to the CLO pin:

BITS	EMB	
SMB	15	
LD	EA,#04H	
LD	PMG2,EA	; P2.2 ← Output mode
BITR	P2.2	; Clear P2.2 output latch
LD	A,#8H	
LD	CLMOD,A	

7 INTERRUPTS

OVERVIEW

The KS57C5532's interrupt control circuit has five functional components:

- Interrupt enable flags (IE_x)
- Interrupt request flags (IRQ_x)
- Interrupt master enable register (IME)
- Interrupt priority register (IPR)
- Power-down release signal circuit

Three kinds of interrupts are supported:

- Internal interrupts generated by on-chip processes
- External interrupts generated by external peripheral devices
- Quasi-interrupts used for edge detection and as clock sources

Table 7-1. Interrupt Types and Corresponding Port Pin(s)

Interrupt Type	Interrupt Name	Corresponding Port Pin
External interrupts	INT0, INT1, INT4	P1.0, P1.1, P1.3
Internal interrupts	INTB, INTT0, INTT1, INTS	Not applicable
Quasi-interrupts	INT2	P1.2, Ports 6 and 7 (KS0–KS7)
	INTW	Not applicable

Vectored Interrupts

Interrupt requests may be processed as vectored interrupts in hardware, or they can be generated by program software. A vectored interrupt is generated when the following flags and register settings, corresponding to the specific interrupt (INTn) are set to logic one:

- Interrupt enable flag (IEx)
- Interrupt master enable flag (IME)
- Interrupt request flag (IRQx)
- Interrupt status flags (IS0, IS1)
- Interrupt priority register (IPR)

If all conditions are satisfied for the execution of a requested service routine, the start address of the interrupt is loaded into the program counter and the program starts executing the service routine from this address.

EMB and ERB flags for RAM memory banks and registers are stored in the vector address area of the ROM during interrupt service routines. The flags are stored at the beginning of the program with the VENT instruction. The initial flag values determine the vectors for resets and interrupts. Enable flag values are saved during the main routine, as well as during service routines. Any changes that are made to enable flag values during a service routine are not stored in the vector address.

When an interrupt occurs, the EMB and the ERB flag values before the interrupt is initiated are saved along with the program status word (PSW), and the enable flag values for the interrupt are fetched from the respective vector address. Then, if necessary, you can modify the enable flags during the interrupt service routine. When the interrupt service routine is returned to the main routine by the IRET instruction, the original values saved in the stack are restored and the main program continues program execution with these values.

Software-Generated Interrupts

To generate an interrupt request from software, the program manipulates the appropriate IRQx flag. When the interrupt request flag value is set, it is retained until all other conditions for the vectored interrupt have been met, and the service routine can be initiated.

Multiple Interrupts

By manipulating the two interrupt status flags (IS0 and IS1), you can control service routine initialization and thereby process multiple interrupts simultaneously.

If more than four interrupts are being processed at one time, you can avoid possible loss of working register data by using the PUSH RR instruction to save register contents to the stack before the service routines are executed in the same register bank. When the routines have executed successfully, you can restore the register contents from the stack to working memory using the POP instruction.

Power-Down Mode Release

An interrupt (with the exception of INT0) can be used to release power-down mode (stop or idle). Interrupts for power-down mode release are initiated by setting the corresponding interrupt enable flag. Even if the IME flag is cleared to zero, power-down mode will be released by an interrupt request signal when the interrupt enable flag has been set. In such cases, the interrupt routine will not be executed since IME = "0".

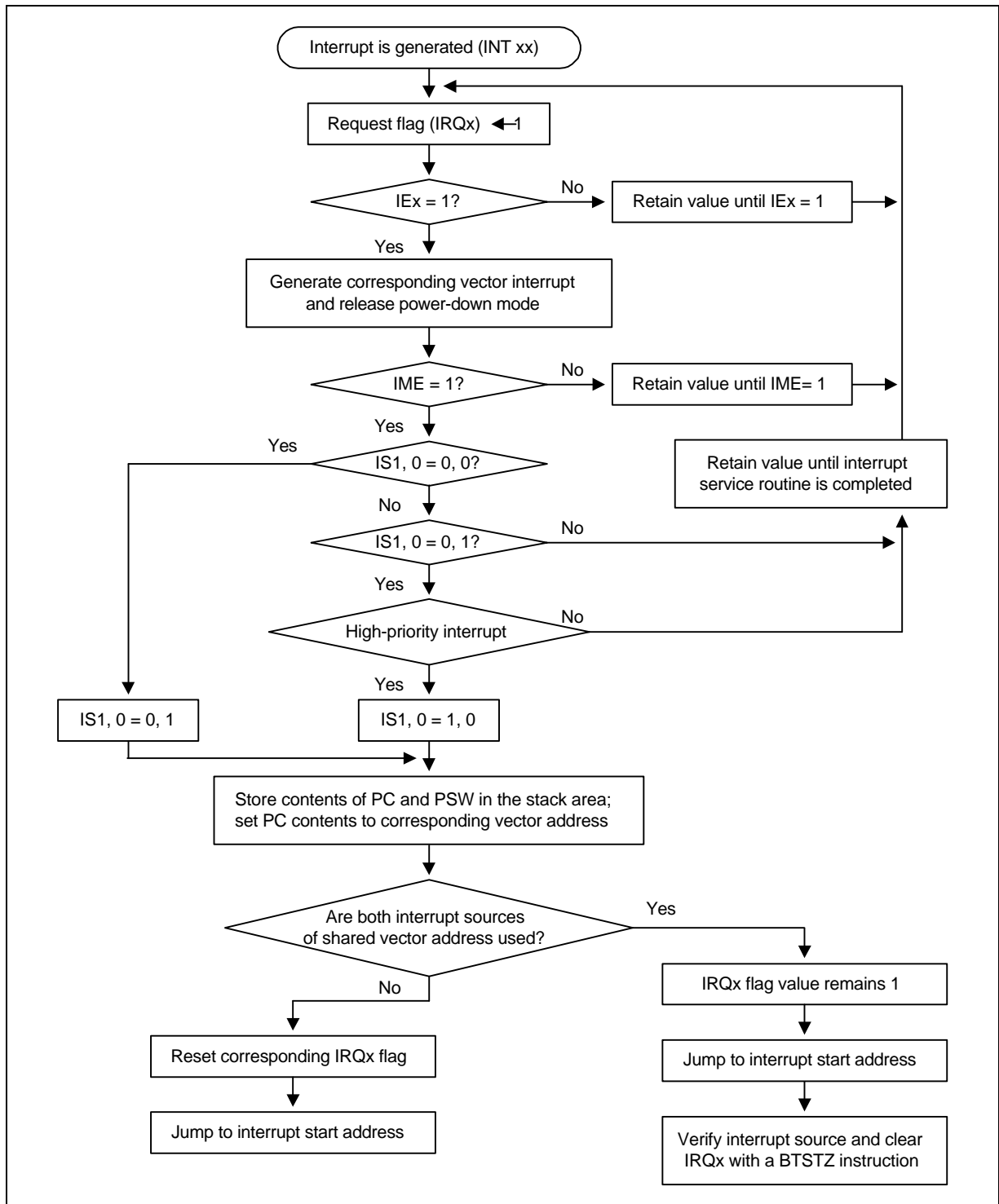


Figure 7-1. Interrupt Execution Flowchart

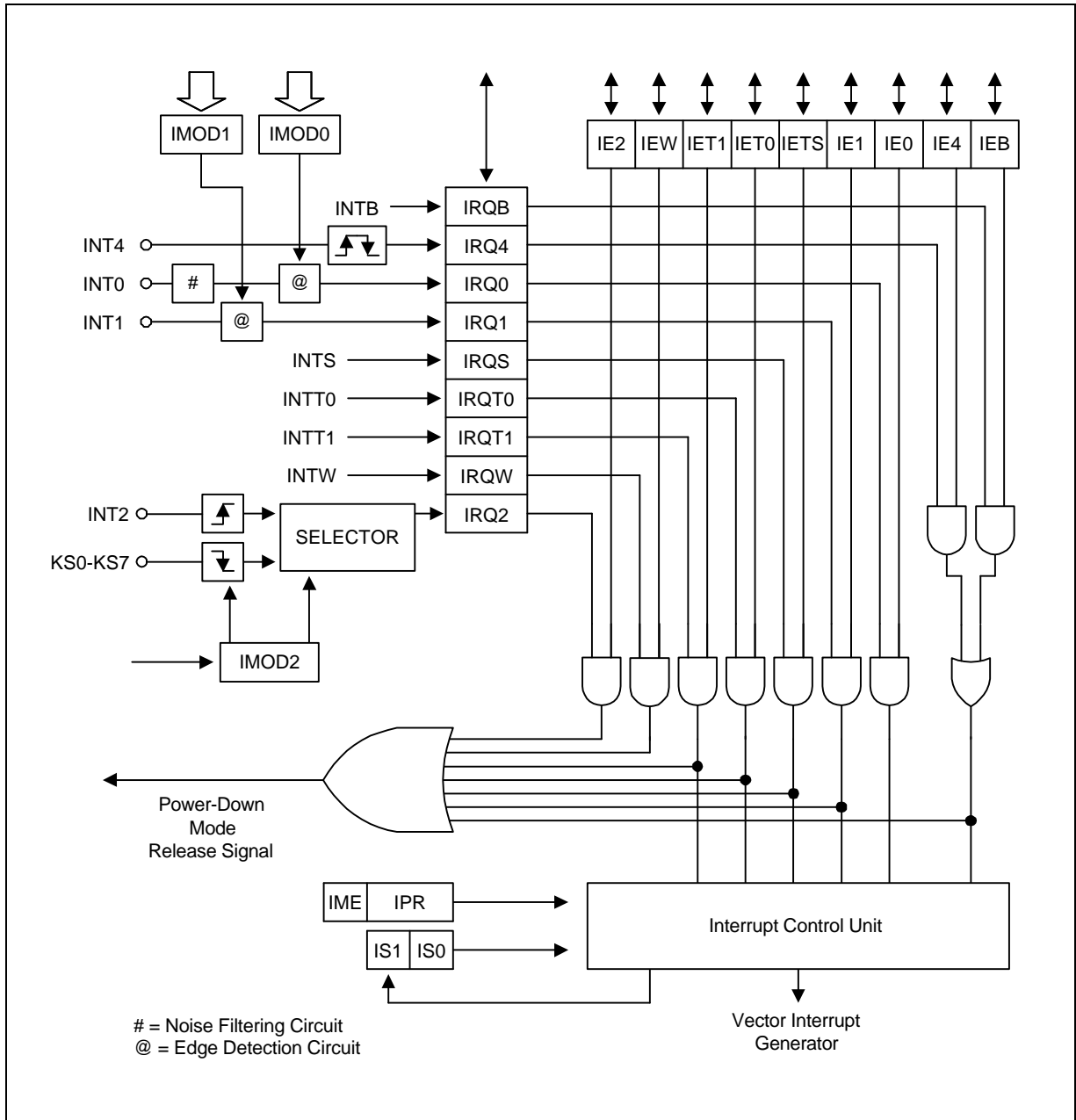


Figure 7-2. Interrupt Control Circuit Diagram

MULTIPLE INTERRUPTS

The interrupt controller can service multiple interrupts in two ways: as two-level interrupts, where either all interrupt requests or only those of highest priority are serviced, or as multi-level interrupts, when the interrupt service routine for a lower-priority request is accepted during the execution of a higher priority routine.

Two-Level Interrupt Handling

Two-level interrupt handling is the standard method for processing multiple interrupts. When the IS1 and IS0 bits of the PSW (FB0H.3 and FB0H.2, respectively) are both logic zero, program execution mode is normal and all interrupt requests are serviced (see Figure 7-3).

Whenever an interrupt request is accepted, IS1 and IS0 are incremented by one, and the values are stored in the stack along with the other PSW bits. After the interrupt routine has been serviced, the modified IS1 and IS0 values are automatically restored from the stack by an IRET instruction.

IS0 and IS1 can be manipulated directly by 1-bit write instructions, regardless of the current value of the enable memory bank flag (EMB). Before you can modify an interrupt status flag, however, you must first disable interrupt processing with a DI instruction.

When IS1 = "0" and IS0 = "1", all interrupt service routines are inhibited except for the highest priority interrupt currently defined by the interrupt priority register (IPR).

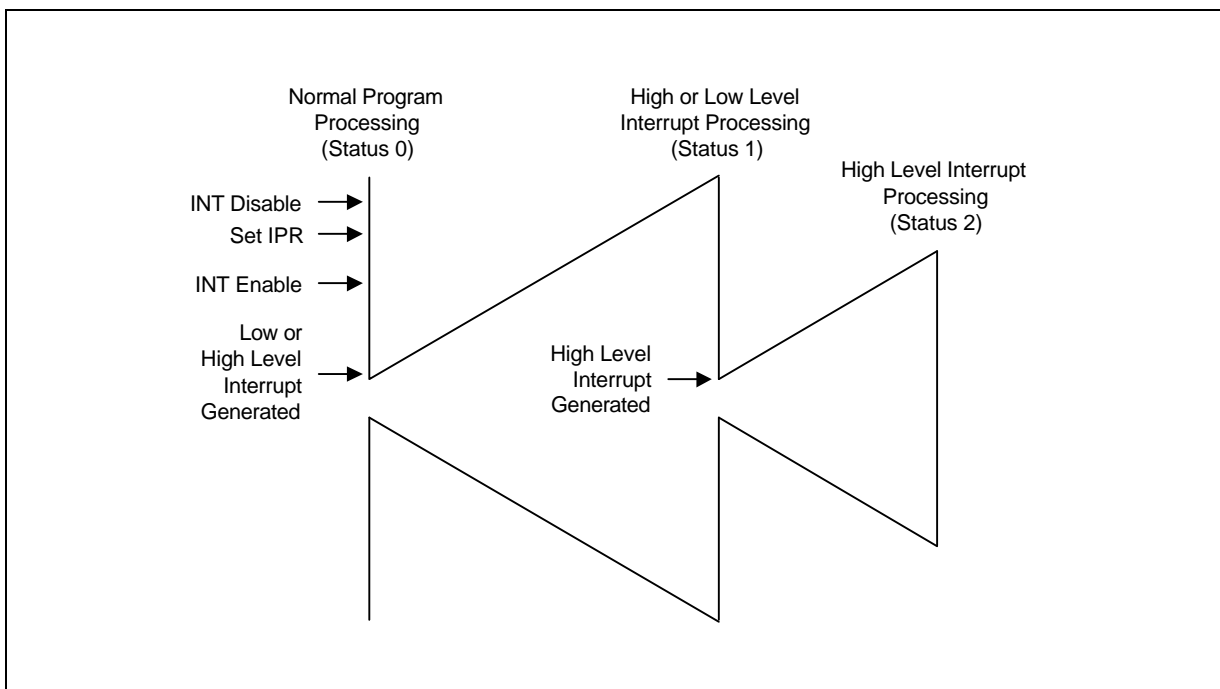


Figure 7-3. Two-Level Interrupt Handling

Multi-Level Interrupt Handling

With multi-level interrupt handling, a lower-priority interrupt request can be executed while a high-priority interrupt is being serviced. This is done by manipulating the interrupt status flags, IS0 and IS1 (see Table 7-2).

When an interrupt is requested during normal program execution, interrupt status flags IS0 and IS1 are set to "1" and "0", respectively. This setting allows only highest-priority interrupts to be serviced. When a high-priority request is accepted, both interrupt status flags are then cleared to "0" by software so that a request of any priority level can be serviced. In this way, the high- and low-priority requests can be serviced in parallel (see Figure 7-4).

Table 7-2. IS1 and IS0 Bit Manipulation for Multi-Level Interrupt Handling

Process Status	Before INT		Effect of ISx Bit Setting	After INT ACK	
	IS1	IS0		IS1	IS0
0	0	0	All interrupt requests are serviced.	0	1
1	0	1	Only high-priority interrupts as determined by the current settings in the IPR register are serviced.	1	0
2	1	0	No additional interrupt requests will be serviced.	-	-
-	1	1	Value undefined	-	-

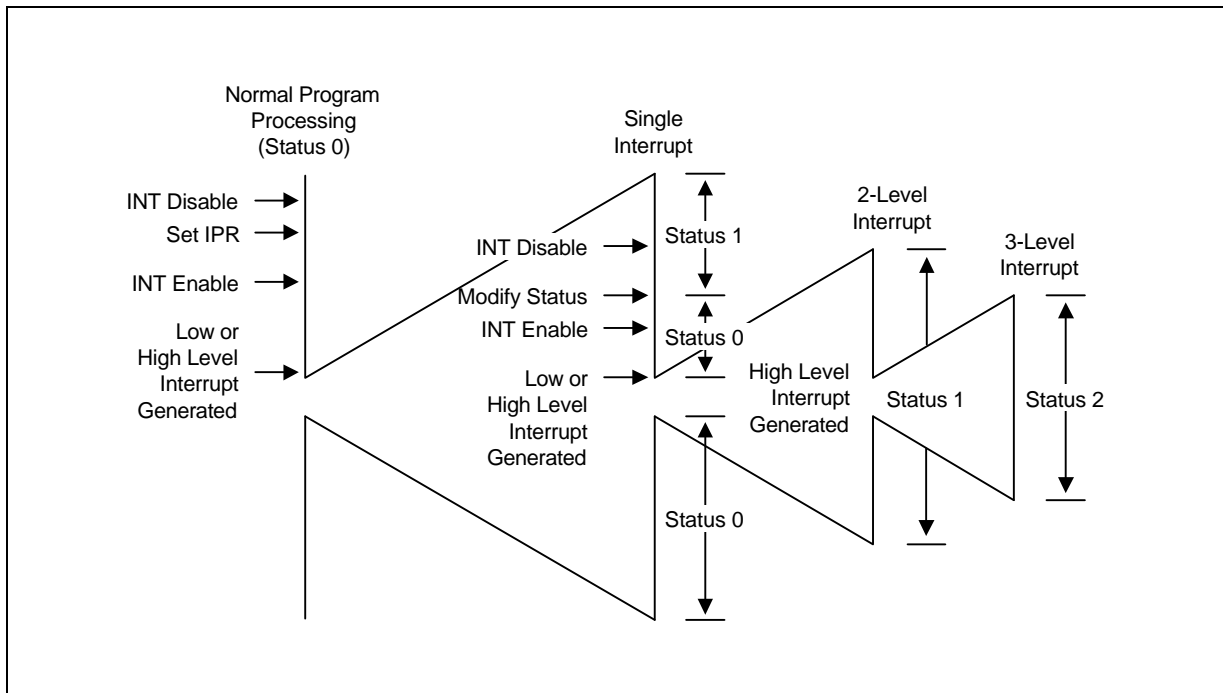


Figure 7-4. Multi-Level Interrupt Handling

INTERRUPT PRIORITY REGISTER (IPR)

The 4-bit interrupt priority register (IPR) is used to control multi-level interrupt handling. Its reset value is logic zero. Before the IPR can be modified by 4-bit write instructions, all interrupts must first be disabled by a DI instruction.

FB2H	IME	IPR.2	IPR.1	IPR.0
------	-----	-------	-------	-------

By manipulating the IPR settings, you can choose to process all interrupt requests with the same priority level, or you can select one type of interrupt for high-priority processing. A low-priority interrupt can itself be interrupted by a high-priority interrupt, but not by another low-priority interrupt. A high-priority interrupt cannot be interrupted by any other interrupt source.

Table 7-3. Standard Interrupt Priorities

Interrupt	Default Priority
INTB, INT4	1
INT0	2
INT1	3
INTS	4
INTT0	5
INTT1	6

The MSB of the IPR, the interrupt master enable flag (IME), enables and disables all interrupt processing. Even if an interrupt request flag and its corresponding enable flag are set, a service routine cannot be executed until the IME flag is set to logic one. The IME flag can be directly manipulated by EI and DI instructions, regardless of the current enable memory bank (EMB) value.

Table 7-4. Interrupt Priority Register Settings

IPR.2	IPR.1	IPR.0	Result of IPR Bit Setting
0	0	0	Normal interrupt handling according to default priority settings
0	0	1	Process INTB and INT4 interrupts at highest priority
0	1	0	Process INT0 interrupts at highest priority
0	1	1	Process INT1 interrupts at highest priority
1	0	0	Process INTS interrupts at highest priority
1	0	1	Process INTT0 interrupts at highest priority
1	1	0	Process INTT1 interrupts at highest priority

NOTE: During normal interrupt processing, interrupts are processed in the order in which they occur. If two or more interrupts occur simultaneously, the processing order is determined by the default interrupt priority settings shown in Table 7-3. Using the IPR settings, you can select specific interrupts for high-priority processing in the event of contention. When the high-priority (IPR) interrupt has been processed, waiting interrupts are handled according to their default priorities.

 **PROGRAMMING TIP — Setting the INT Interrupt Priority**

The following instruction sequence sets the INT1 interrupt to high priority:

```

BITS      EMB
SMB      15
DI                          ; IPR.3 (IME) ← 0
LD        A,#3H
LD        IPR,A
EI                          ; IPR.3 (IME) ← 1
    
```

EXTERNAL INTERRUPT 0 and 1 MODE REGISTERS (IMOD0, IMOD1)

The following components are used to process external interrupts at the INT0 and INT1 pin:

- Noise filtering circuit for INT0
- Edge detection circuit
- Two mode registers, IMOD0 and IMOD1

The mode registers are used to control the triggering edge of the input signal. IMOD0 and IMOD1 settings let you choose either the rising or falling edge of the incoming signal as the interrupt request trigger. The INT4 interrupt is an exception since its input signal generates an interrupt request on both rising and falling edges.

FB4H	IMOD0.3	"0"	IMOD0.1	IMOD0.0
FB5H	"0"	"0"	"0"	IMOD1.0

IMOD0 and IMOD1 bits are addressable by 4-bit write instructions. RESET clears all IMOD values to logic zero, selecting rising edges as the trigger for incoming interrupt requests.

Table 7-5. IMOD0 and IMOD1 Register Organization

IMOD0	IMOD0.3	0	IMOD0.1	IMOD0.0	Effect of IMOD0 Settings	
	0					Select CPU clock for sampling
1					Select fxx/64 sampling clock	
			0	0	Rising edge detection	
			0	1	Falling edge detection	
			1	0	Both rising and falling edge detection	
			1	1	IRQ0 flag cannot be set to "1"	
IMOD1	0	0	0	IMOD1.0	Effect of IMOD1 Settings	
				0		Rising edge detection
				1		Falling edge detection

EXTERNAL INTERRUPT 0 and 1 MODE REGISTERS (Continued)

When a sampling clock rate of $fx/64$ is used for INT0, an interrupt request flag must be cleared before 16 machine cycles have elapsed. Since the INT0 pin has a clock-driven noise filtering circuit built into it, please take the following precautions when you use it:

- To trigger an interrupt, the input signal width at INT0 must be at least two times wider than the pulse width of the clock selected by IMOD0. This is true even when the INT0 pin is used for general-purpose input.
- Since the INT0 input sampling clock does not operate during stop or idle mode, you cannot use INT0 to release power-down mode.

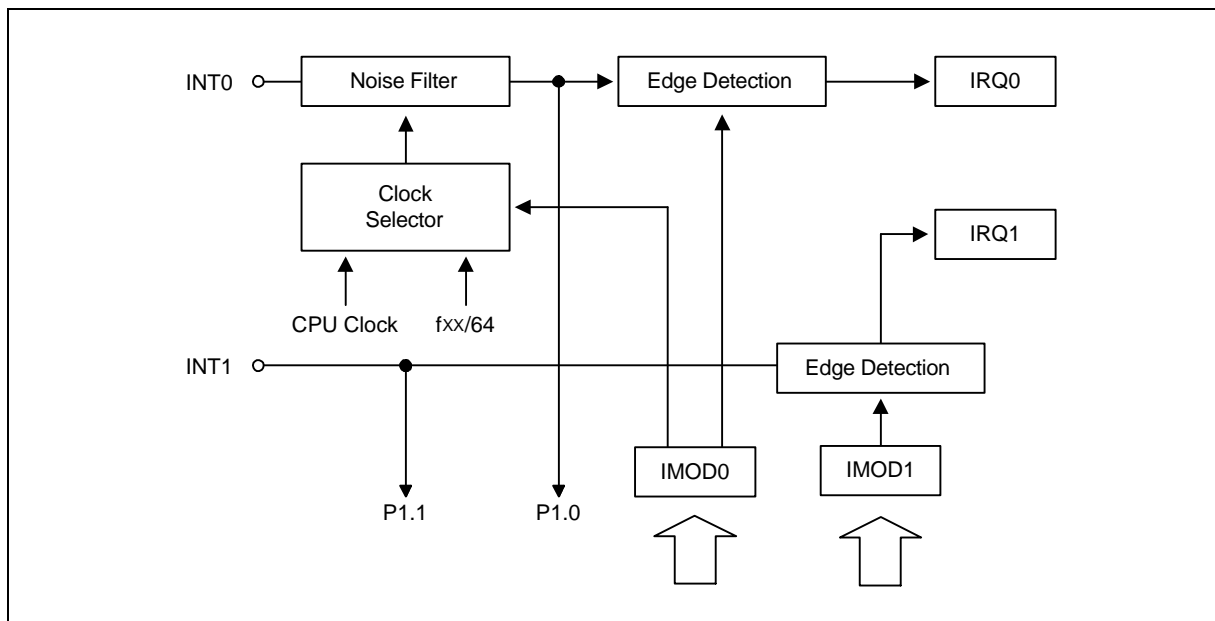


Figure 7-5. Circuit Diagram for INT0 and INT1 Pins

When modifying the IMOD0 and IMOD1 registers, it is possible to accidentally set an interrupt request flag. To avoid unwanted interrupts, take these precautions when writing your programs:

1. Disable all interrupts with a DI instruction.
2. Modify the IMOD0 or IMOD1 register.
3. Clear all relevant interrupt request flags.
4. Enable the interrupt by setting the appropriate IEx flag.
5. Enable all interrupts with an EI instructions.

EXTERNAL INTERRUPT 2 MODE REGISTER (IMOD2)

The mode register for external interrupts at the INT2 pin, IMOD2 is addressable only by 4-bit write instructions. RESET clears all IMOD2 bits to logic zero.

FB6H	"0"	"0"	IMOD2.1	IMOD2.0
------	-----	-----	---------	---------

When IMOD2 is cleared to logic zero, INT2 uses the rising edge of an incoming signal as the interrupt request trigger. If a rising edge is detected at the INT2 pin, or when a falling edge is detected at any one of the pins KS0–KS7, the IRQ2 flag is set to logic one and a release signal for power-down mode is generated.

If one or more of the pins which are configured as key interrupt (KS0–KS1) are in low input, the key interrupt can not be occurred.

Table 7-6. IMOD2 Register Bit Settings

IMOD2	0	0	IMOD2.1	IMOD2.0	Effect of IMOD2 Settings
			0	0	Select rising edge at INT2 pin
			0	1	Select falling edge at KS4–KS7
			1	0	Select falling edge at KS2–KS7
			1	1	Select falling edge at KS0–KS7

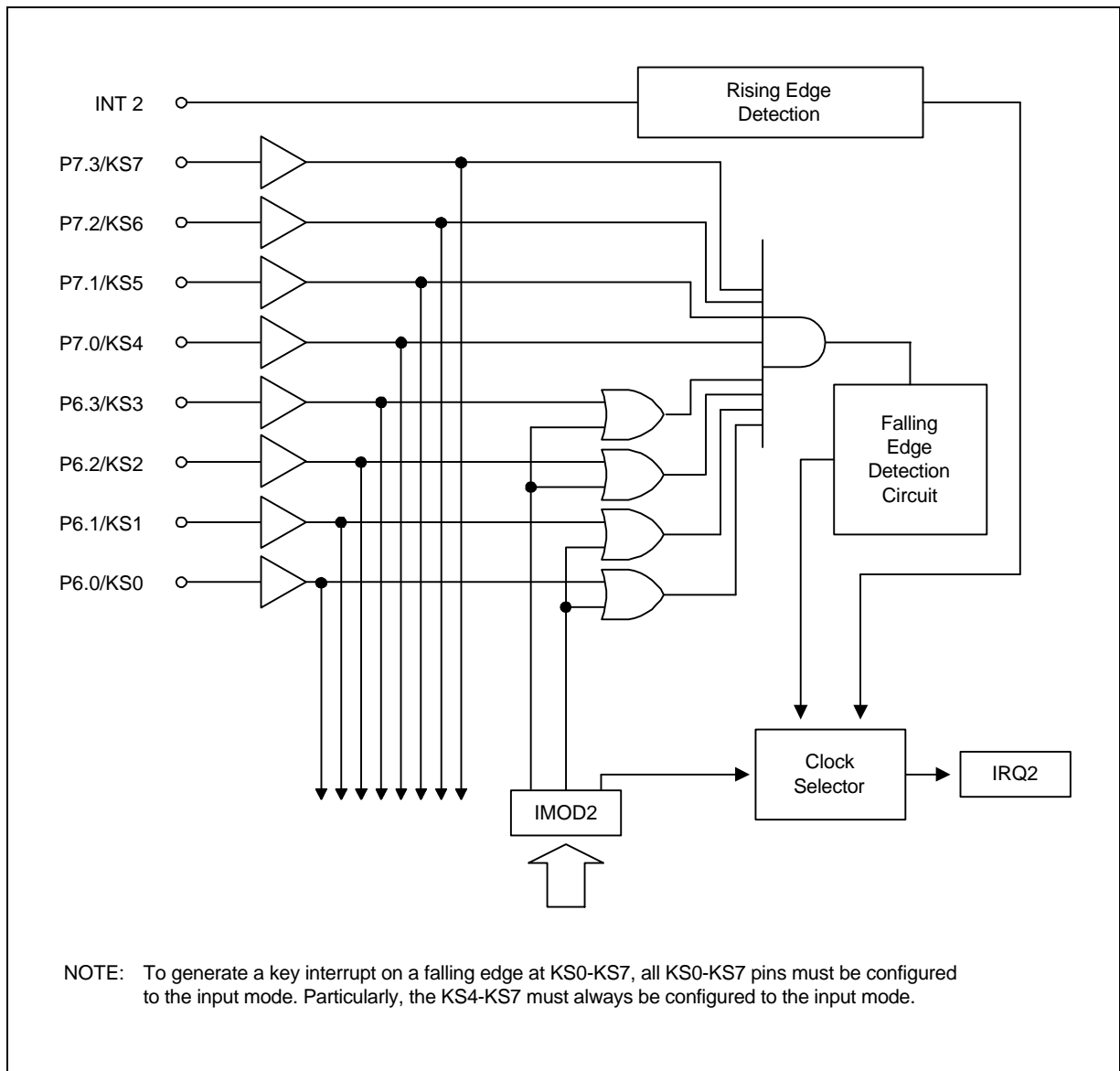


Figure 7-6. Circuit Diagram for INT2 and KS0-KS7 Pins

PROGRAMMING TIP — Using INT2 as a Key Input Interrupt

When the INT2 interrupt is used as a key interrupt, the selected key interrupt source pin must be set to input:

1. When KS0–KS7 are selected (eight pins):

```

BITS      EMB
SMB       15
LD        A,#3H
LD        IMOD2,A           ; (IMOD2) ← #3H, KS0–KS7 falling edge select
LD        EA,#0FH
LD        PMG1,EA          ; P7 ← input mode
LD        EA,#00H
LD        PMG3,EA          ; P6 ← input mode
LD        EA,#30H
LD        PUMOD1,EA        ; Enable P6 and P7 pull-up resistors

```

2. When KS2–KS7 are selected (six pins):

```

BITS      EMB
SMB       15
LD        A,#2H
LD        IMOD2,A           ; (IMOD2) ← #2H, KS2–KS7 falling edge select
LD        EA,#0FH
LD        PMG1,EA          ; P7 ← input mode
LD        EA,#0CH
LD        PMG3,EA          ; P6.2–P6.3 ← input mode
LD        EA,#30H
LD        PUMOD1,EA        ; Enable P6 and P7 pull-up resistors

```

3. When KS4–KS7 are selected (four pins), P7 must be specified as a key strobe signal input:

```

BITS      EMB
SMB       15
LD        A,#1H
LD        IMOD2,A           ; (IMOD2) ← #1H, KS4–KS7 falling edge select
LD        EA,#0FH
LD        PMG1,EA          ; P7 ← input mode
LD        EA,#20H
LD        PUMOD1,EA        ; Enable P7 pull-up resistor

```

INTERRUPT FLAGS

There are three types of interrupt flags: interrupt request and interrupt enable flags that correspond to each interrupt, the interrupt master enable flag, which enables or disables all interrupt processing.

Interrupt Master Enable Flag (IME)

The interrupt master enable flag, IME, enables or disables all interrupt processing. Therefore, even when an IRQx flag is set and its corresponding IEx flag is enabled, the interrupt service routine is not executed until the IME flag is set to logic one.

The IME flag is located in the IPR register (IPR.3). It can be directly be manipulated by EI and DI instructions, regardless of the current value of the enable memory bank flag (EMB).

IME	IPR.2	IPR.1	IPR.0	Effect of Bit Settings
0				Inhibit all interrupts
1				Enable all interrupts

Interrupt Enable Flags (IEx)

IEx flags, when set to logical one, enable specific interrupt requests to be serviced. When the interrupt request flag is set to logic one, an interrupt will not be serviced until its corresponding IEx flag is also enabled.

Interrupt enable flags can be read, written, or tested directly by 1-bit instructions (BITS and BITR) or 4-bit instructions. IEx flags can be addressed directly at their specific RAM addresses, despite the current value of the enable memory bank (EMB) flag.

Table 7-7. Interrupt Enable and Interrupt Request Flag Addresses

Address	Bit 3	Bit 2	Bit 1	Bit 0
FB8H	IE4	IRQ4	IEB	IRQB
FBAH	0	0	IEW	IRQW
FBBH	0	0	IET1	IRQT1
FBCH	0	0	IET0	IRQT0
FBDH	0	0	IES	IRQS
FBEH	IE1	IRQ1	IE0	IRQ0
FBFH	0	0	IE2	IRQ2

NOTES:

1. IEx refers to all interrupt enable flags.
2. IRQx refers to all interrupt request flags.
3. IEx = 0 is interrupt disable mode.
4. IEx = 1 is interrupt enable mode.

Interrupt Request Flags (IRQx)

Interrupt request flags, are read/write addressable by 1-bit or 4-bit instructions. IRQx flags can be addressed directly at their specific RAM addresses, regardless of the current value of the enable memory bank (EMB) flag.

When a specific IRQx flag is set to logic one, the corresponding interrupt request is generated. The flag is then automatically cleared to logic zero when the interrupt has been serviced. Exceptions are the watch timer interrupt request flags, IRQW, and the external interrupt 2 flag IRQ2, which must be cleared by software after the interrupt service routine has executed. IRQx flags are also used to execute interrupt requests from software. In summary, follow these guidelines for using IRQx flags:

1. IRQx is set to request an interrupt when an interrupt meets the set condition for interrupt generation.
2. IRQx is set to "1" by hardware and then cleared by hardware when the interrupt has been serviced (with the exception of IRQW and IRQ2).
3. If IRQx is set to "1" by software, an interrupt is also generated.

When two interrupts share the same service routine start address, interrupt processing may occur in one of two ways:

- When only one interrupt is enabled, the IRQx flag is cleared automatically when the interrupt has been serviced.
- When two interrupts are enabled, the request flag is not automatically cleared so that the user has an opportunity to locate the source of the interrupt request. In this case, the IRQx setting must be cleared manually using a BTSTZ instruction.

Table 7-8. Interrupt Request Flag Conditions and Priorities

Interrupt Source	Internal / External	Pre-condition for IRQx Flag Setting	Interrupt Priority	IRQ Flag Name
INTB	I	Reference time interval signal from basic timer	1	IRQB
INT4	E	Both rising and falling edges detected at INT4	1	IRQ4
INT0	E	Rising or falling edge detected at INT0 pin	2	IRQ0
INT1	E	Rising or falling edge detected at INT1 pin	3	IRQ1
INTS	I	Completion signal for serial transmit-and-receive or receive-only operation	4	IRQS
INTT0	I	Signals for TCNT0 and TREF0 registers match	5	IRQT0
INTT1	I	Signals for TCNT1 and TREF1 registers match	6	IRQT1
INT2 ^(note)	E	Rising edge detected at INT2 or else a falling edge is detected at any of the KS0–KS7 pins	—	IRQ2
INTW	I	Time interval of 0.5 secs or 3.19 msecs	—	IRQW

NOTE: The quasi-interrupt INT2 is only used for testing incoming signals.

 **PROGRAMMING TIP — Enabling the INTB and INT4 Interrupts**

To simultaneously enable INTB and INT4 interrupts:

```

INTB      DI
          BTSTZ      IRQB      ; IRQB = 1 ?
          JR         INT4      ; If no, INT4 interrupt; if yes, INTB interrupt is processed
          .
          .
          .
          EI
          IRET
;
INT4      BITR       IRQ4      ; INT4 is processed
          .
          .
          .
          EI
          IRET

```

To simultaneously enable INTT0 and INTT1B interrupts:

```

INTT0     DI
          BTSTZ     IRQT0     ; IRQB = 1 ?
          JR       INTT1B    ; If no, INTT1B interrupt; if yes, INTT0 interrupt is
          .                ; processed
          .
          .
          EI
          IRET
;
INTT1B    BITR     IRQT2     ; INTT1B is processed
          .
          .
          .
          EI
          IRET

```

NOTES

8 POWER-DOWN

OVERVIEW

The KS57C5532 microcontroller has two power-down modes to reduce power consumption: idle and stop. Idle mode is initiated by the IDLE instruction and stop mode by the instruction STOP. (Several NOP instructions must always follow an IDLE or STOP instruction in a program.) In idle mode, the CPU clock stops while peripherals and the oscillation source continue to operate normally.

When RESET occurs during normal operation or during a power-down mode, a reset operation is initiated and the CPU enters idle mode. When the standard oscillation stabilization time interval (31.3 ms at 4.19 MHz) has elapsed, normal CPU operation resumes.

In stop mode, main system clock oscillation is halted (assuming it is currently operating), and peripheral hardware components are powered-down. The effect of stop mode on specific peripheral hardware components — CPU, basic timer, serial I/O, timer/counters, and watch timer — and on external interrupt requests, is detailed in Table 8-1.

Idle or stop modes are terminated either by a RESET, or by an interrupt with the exception of INT0, which are enabled by the corresponding interrupt enable flag, IEx. When power-down mode is terminated by RESET input, a normal reset operation is executed. Assuming that both the interrupt enable flag and the interrupt request flag are set to "1", power-down mode is released immediately upon entering power-down mode.

When an interrupt is used to release power-down mode, the operation differs depending on the value of the interrupt master enable flag (IME):

- If the IME flag = "0", if the power down mode release signal is generated, after releasing the power-down mode, program execution starts immediately under the instruction to enter power down mode without execution of interrupt service routine. The interrupt request flag remains set to logic one.
- If the IME flag = "1", if the power down mode release signal is generated, after releasing the power down mode, two instructions following the instruction to enter power down mode are executed first and the interrupt service routine is executed, finally program is resumed. However, when the release signal is caused by INT2 or INTW, the operations is identical to the IME = "0" condition because INT2 and INTW are a quasi-interrupt.

NOTE

Do not use stop mode if you are using an external clock source because X_{in} input must be restricted internally to V_{SS} to reduce current leakage

Table 8-1. Hardware Operation During Power-Down Modes

Operation	Stop Mode (STOP)	Idle Mode (IDLE)
Clock oscillator	System clock oscillation stops	CPU clock oscillation stops (system clock oscillation continues)
Basic timer	Basic timer stops	Basic timer operates (with IRQB set at each reference interval)
Serial interface	Operates only if external SCK input is selected as the serial I/O clock	Operates if a clock other than the CPU clock is selected as the serial I/O clock
Timer/counter 0	Operates only if TCL0 is selected as the counter clock	Timer/counter 0 operates
Timer/counter 1	Operates only if TCL1 is selected as the counter clock	Timer/counter 1 operates
Watch timer	Watch timer operation is stopped	Watch timer operates
External interrupts	INT0, INT1, INT2, and INT4 are acknowledged	INT1, INT2, and INT4 are acknowledged; INT0 is not serviced
CPU	All CPU operations are disabled	All CPU operations are disabled
Power-down mode release signal	Interrupt request signals (except INT0) are enabled by an interrupt enable flag or by RESET input	Interrupt request signals (except INT0) are enabled by an interrupt enable flag or by RESET input

IDLE MODE TIMING DIAGRAMS

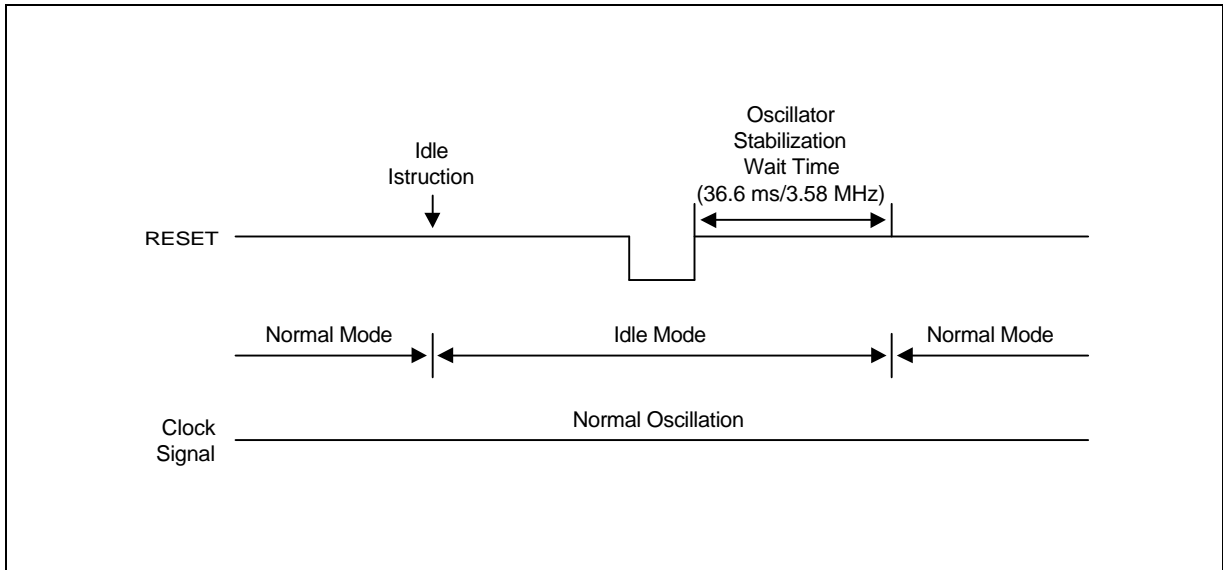


Figure 8-1. Timing When Idle Mode is Released by RESET

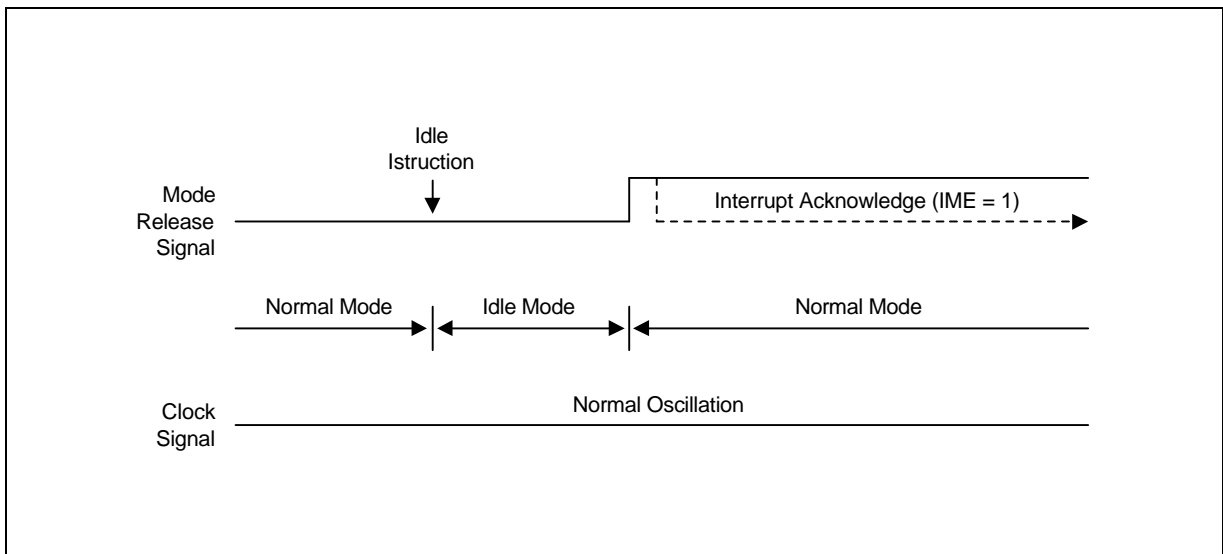


Figure 8-2. Timing When Idle Mode is Released by an Interrupt

STOP MODE TIMING DIAGRAMS

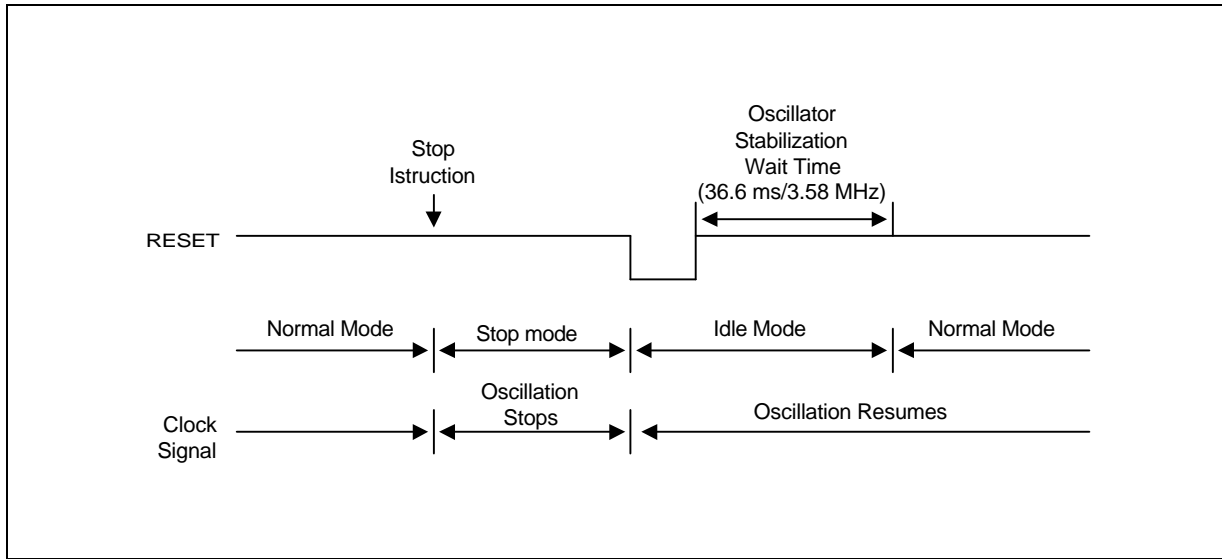


Figure 8-3. Timing When Stop Mode is Released by RESET

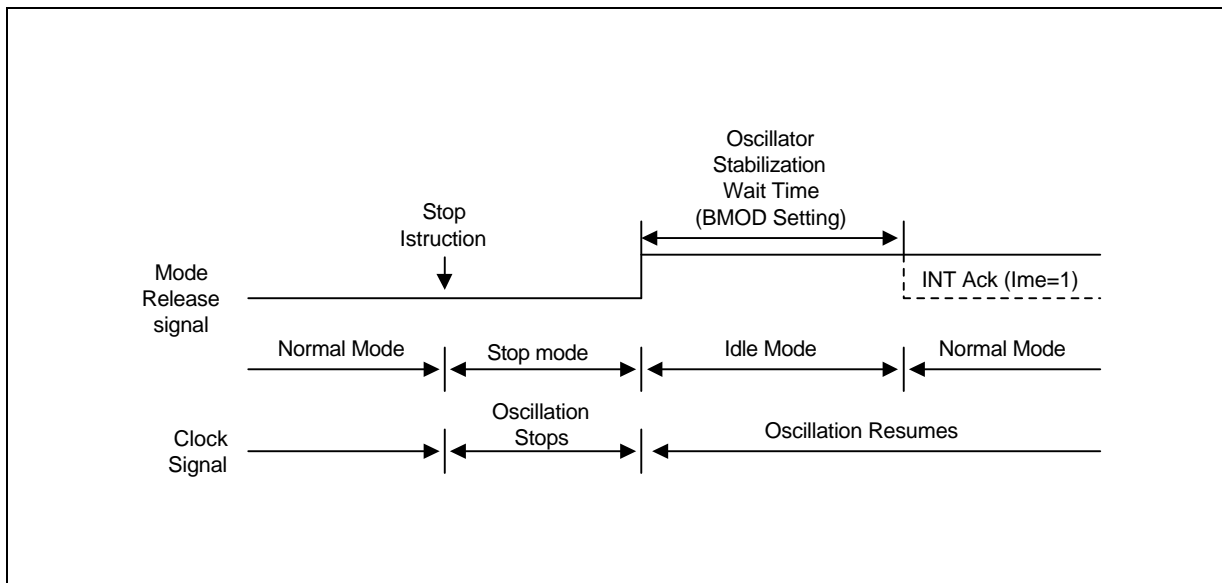


Figure 8-4. Timing When Stop Mode is Released by an Interrupt

PROGRAMMING TIP — Reducing Power Consumption for Key Input Interrupt Processing

The following code shows interrupt processing for key inputs to reduce power consumption. In this example, the system clock source is switched from the main system clock to a subsystem clock:

```

KEYCLK  DI
        CALL      MA2SUB          ; Main system clock → subsystem clock switch
                                   ;      subroutine
        SMB      15
        LD       EA,#00H
        LD       P4,EA           ; All key strobe outputs to low level
        LD       A,#3H
        LD       IMOD2,A        ; Select KS0–KS7 enable
        SMB      0
        BITR     IRQ2
        BITS     IE2
CLKS1   BTSTZ    IRQ2
        JR       CIDLE
        CALL     SUB2MA          ; Subsystem clock → main system clock switch
                                   ;      subroutine
        EI
        RET
CIDLE   IDLE     ; Engage idle mode
        NOP
        NOP
        NOP
        JPS     CLKS1

```

PORT PIN CONFIGURATION FOR POWER-DOWN

The following method describes how to configure I/O port pins to reduce power consumption during power-down modes (stop, idle):

Condition 1: If the microcontroller is not configured to an external device:

1. Connect unused port pins according to the information in Table 8–2.
2. Disable all pull-up resistors for output pins by making the appropriate modifications to the pull-up resistor mode register, PUMOD. Reason: If output goes low when the pull-up resistor is enabled, there may be unexpected surges of current through the pull-up.
3. Disable pull-up resistors for input pins configured to V_{DD} or V_{SS} levels in order to check the current input option. Reason: If the input level of a port pin is set to V_{SS} when a pull-up resistor is enabled, it will draw an unnecessarily large current.

Condition 2: If the microcontroller is configured to an external device and the external device's V_{DD} source is turned off in power-down mode.

1. Connect unused port pins according to the information in Table 8–2.
2. Disable the pull-up resistors of output pins by making the appropriate modifications to the pull-up resistor mode register, PUMOD. Reason: If output goes low when the pull-up resistor is enabled, there may be unexpected surges of current through the pull-up.
3. Disable pull-up resistors for input pins configured to V_{DD} or V_{SS} levels in order to check the current input option. Reason: If the input level of a port pin is set to V_{SS} when a pull-up resistor is enabled, it will draw an unnecessarily large current.
4. Disable the pull-up resistors of input pins connected to the external device by making the necessary modifications to the PUMOD register.
5. Configure the output pins that are connected to the external device to low level. Reason: When the external device's V_{DD} source is turned off, and if the microcontroller's output pins are set to high level, $V_{DD} - 0.7$ V is supplied to the V_{DD} of the external device through its input pin. This causes the device to operate at the level $V_{DD} - 0.7$ V. In this case, total current consumption would not be reduced.
6. Determine the correct output pin state necessary to block current pass in according with the external transistors (PNP, NPN).

RECOMMENDED CONNECTIONS FOR UNUSED PINS

To reduce overall power consumption, please configure unused pins according to the guidelines described in Table 8-2.

Table 8-2. Unused Pin Connections for Reducing Power Consumption

Pin/Share Pin Names	Recommended Connection
P0.0 / SCK P0.1 / SO P0.2 / SI P0.3 / BTCO	Input mode: Connect to V_{DD} Output mode: No connection
P1.0 / INT0–P1.2 / INT2	Connect to V_{DD}
P1.3 / INT4	Connect to V_{SS}
P2.0 / TCLO0 P2.1 / TCLO1 P2.2 / CLO P2.3 / BUZ P3.0 / TCL0 P3.1 / TCL1 P3.2 P3.3 P4.0–P4.3 P5.0–P5.3 P6.0 / KS0–P6.3 / KS3 P7.0 / KS4–P7.3 / KS7 P8.0–P8.3 P9.0–P9.3 P10.0–P10.3 P11.0–P11.3 P13.0–P13.2	Input mode: Connect to V_{DD} Output mode: No connection
P12.0–P12.3	Input mode: Connect to V_{SS} Output mode: No connection
DTMF	No connection
NC	Connect to V_{SS}

NOTES

9

RESET

OVERVIEW

When a RESET signal is input during normal operation or power-down mode, a hardware RESET operation is initiated and the CPU enters idle mode. Then, when the standard oscillation stabilization interval of 36.6 ms at 3.579545 MHz has elapsed, normal system operation resumes.

Regardless of when the RESET occurs — during normal operating mode or during a power-down mode — most hardware register values are set to the RESET values described in Table 9–1. The current status of several register values is, however, always retained when a RESET occurs during idle or stop mode; If a RESET occurs during normal operating mode, their values are undefined. Current values that are retained in this case are as follows:

- Carry flag
- General-purpose registers E, A, L, H, X, W, Z, and Y
- Serial I/O buffer register (SBUF)

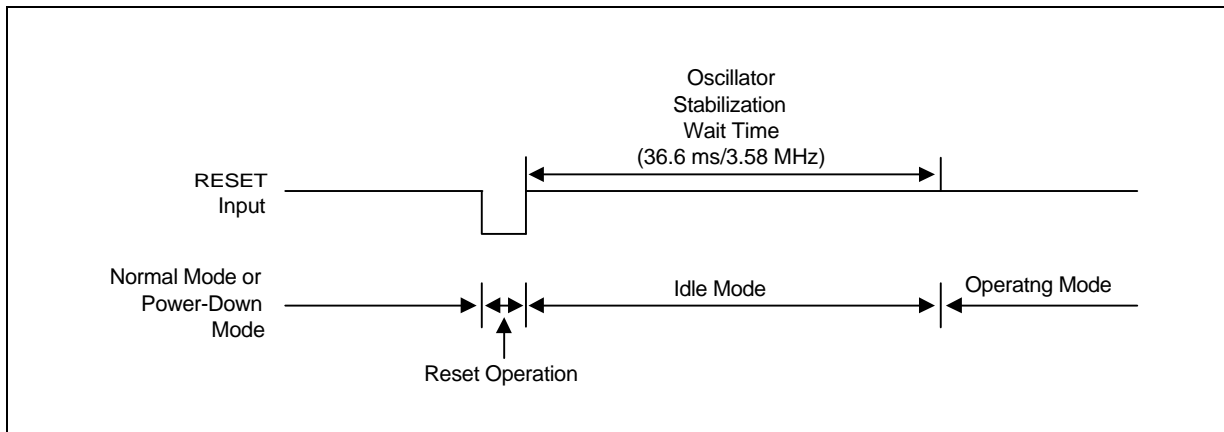


Figure 9-1. Timing for Oscillation Stabilization after RESET

HARDWARE REGISTER VALUES AFTER RESET

Table 9-1 gives you detailed information about hardware register values after a RESET occurs during power-down mode or during normal operation.

Table 9-1. Hardware Register Values after RESET

Hardware Component or Subcomponent	If RESET Occurs During Power-Down Mode	If RESET Occurs During Normal Operation
Program counter (PC)	Lower six bits of address 0000H are transferred to PC13–8, and the contents of 0001H to PC7–0.	Lower six bits of address 0000H are transferred to PC13–8, and the contents of 0001H to PC7–0.
Program Status Word (PSW):		
Carry flag ©	Values retained	Undefined
Skip flag (SC0–SC2)	0	0
Interrupt status flags (IS0, IS1)	0	0
Bank enable flags (EMB, ERB)	Bit 6 of address 0000H in program memory is transferred to the ERB flag, and bit 7 of the address to the EMB flag.	Bit 6 of address 0000H in program memory is transferred to the ERB flag, and bit 7 of the address to the EMB flag.
Stack pointer (SP)	Undefined	Undefined
Data Memory (RAM):		
General registers E, A, L, H, X, W, Z, Y	Values retained	Undefined
General-purpose registers	Values retained (note)	Undefined
Bank selection registers (SMB, SRB)	0, 0	0, 0
BSC register (BSC0-BSC3)	0	0
Clocks:		
Power control register (PCON)	0	0
Clock output mode register (CLMOD)	0	0
System clock mode register (SCMOD)	0	0
Interrupts:		
Interrupt request flags (IRQx)	0	0
Interrupt enable flags (IEx)	0	0
Interrupt priority flag (IPR)	0	0
Interrupt master enable flag (IME)	0	0
INT0 mode register (IMOD0)	0	0
INT1 mode register (IMOD1)	0	0
INT2 mode register (IMOD2)	0	0

NOTE: The values of the 0F8H – 0FDH are not retained when a RESET signal is input.

Table 9-1. Hardware Register Values after RESET (Continued)

Hardware Component or Subcomponent	If RESET Occurs During Power-Down Mode	If RESET Occurs During Normal Operation
I/O Ports:		
Output buffers	Off	Off
Output latches	0	0
Port mode flags (PM)	0	0
Pull-up resistor mode reg (PUMOD1/2)	0	0
Basic Timer:		
Count register (BCNT)	Undefined	Undefined
Mode register (BMOD)	0	0
Mode register (WDMOD)	A5H	A5H
Counter clear flag (WDTCF)	0	0
Timer/Counters 0 and 1:		
Count registers (TCNT0/1)	0	0
Reference registers (TREF0/TREF1)	FFH,FFFFH	FFH,FFFFH
Mode registers (TMOD0/TMOD1)	0	0
Output enable flags (TOE0/1)	0	0
Watch Timer:		
Watch timer mode register (WMOD)	0	0
Serial I/O interface:		
SIO mode register (SMOD)	0	0
SIO interface buffer (SBUF)	Values retained	Undefined
N-Channel Open-Drain Mode Register:		
PNE1	0	0
DTMF Generator:		
DTMF mode register (DTMR)	0	0

NOTES

10 I/O PORTS

OVERVIEW

The KS57C5532 has 1 input port and 13 I/O ports. Pin addresses for all I/O ports are mapped in bank 15 of the RAM. The contents of I/O port pin latches can be read, written, or tested at the corresponding address using bit manipulation instructions.

There are total of 4 input pins and 51 configurable I/O pin for a maximum number of 55 I/O pins.

Port Mode Flags

Port mode flags (PM) are used to configure I/O ports 0, 4, 5, and 7 (port mode group 1), ports 2 and 3 (port mode group 2), ports 6 and 8 (port mode group 3), and ports 9, 10, 11, 12, and 13 (port mode group 4) to input or output mode by setting or clearing the corresponding I/O buffer. PM flags are grouped in four 8-bit registers, and are addressable by 8-bit write instructions only.

PUMOD Control Register

The pull-up register mode registers (PUMOD1 and 2) are 8-bit registers used to assign internal pull-up resistors by software to specific I/O ports and pull-down resistors to port 12.

When configurable I/O ports 0, 2, 3, 6, 8, 9, 10, 11, 12, and 13 serves as an output pin, its assigned pull-up/down resistor is automatically disabled, even though the pin's pull-up/down resistor is enabled by a corresponding bit setting in the pull-up resistor mode register (PUMOD).

PUMOD1 and 2 are addressable by 8-bit write instructions only. RESET clears PUMOD register values to logic zero, automatically disconnecting all software-assignable port pull-up/down resistors.

Table 10-1. I/O Port Overview

Port	I/O	Pins	Pin Names	Address	Function Description
0	I/O	4	P0.0–P0.3	FF0H	4-bit I/O port. 1-bit and 4-bit read/write and test is possible. Individual pins are software configurable as input or output. 4-bit pull-up resistors are assignable by software.; pull-up resistors are automatically disabled for output pins.
1	I	4	P1.0–P1.3	FF1H	4-bit input port. 1-bit and 4-bit read and test is possible. 4-bit pull-up resistors are software assignable by software to port 1.
2	I/O	4	P2.0–P2.3	FF2H	Same as port 0.
3	I/O	4	P3.0–P3.3	FF3H	Same as port 0.

Table 10-1. I/O Port Overview (Continued)

Port	I/O	Pins	Pin Names	Address	Function Description
4, 5	I/O	8	P4.0–P4.3 P5.0–P5.3	FF4H FF5H	4-bit I/O ports. 1-bit and 4-bit read/write/test is possible. 4-bit pull-up resistors are software assignable to input pins and are automatically disabled for output pins. N-channel open-drain or push-pull output can be selected by software. Ports 4 and 5 can be paired to support 8-bit data transfer.
6, 7	I/O	8	P6.0–P6.3 P7.0–P7.3	FF6H FF7H	4-bit I/O ports. 1-bit and 4-bit read/write/test is possible. Port 6 pins are individually software configurable as input or output. 4-bit pull-up resistors are software assignable; pull-up resistors are automatically disabled for output pins. Ports 6 and 7 can be paired for 8-bit data transfer.
8	I/O	4	P8.0–P8.3	FF8H	Same as port 0.
9	I/O	4	P9.0–P9.3	FF9H	4-bit I/O port. 1-bit and 4-bit read/write and test is possible. 4-bit pull-up resistors are assignable by software.; pull-up resistors are automatically disabled for output pins.
10, 11	I/O	4	P10.0–P10.3	FFAH FFBH	Same as port 9. Ports 10 and 11 can be paired to support 8-bit data transfer.
12	I/O	4	P12.0–P12.3	FFCH	4-bit I/O port. 1-bit and 4-bit read/write and test is possible. Individual pins are software configurable as input or output. 4-bit pull-down resistors are assignable by software.; pull-down resistors are automatically disabled for output pins.
13	I/O	4	P13.0–P13.2	FFDH	3-bit I/O port. 1-bit and 4-bit read/write and test is possible. 3-bit pull-up resistors are assignable by software.; pull-up resistors are automatically disabled for output pins.

Table 10-2. Port Pin Status During Instruction Execution

Instruction Type	Example	Input Mode Status	Output Mode Status
1-bit test 1-bit input 4-bit input 8-bit input	BTST P0.1 LDB C,P1.3 LD A,P7 LD EA,P4	Input or test data at each pin	Input or test data at output latch
1-bit output	BITR P2.3	Output latch contents undefined	Output pin status is modified
4-bit output 8-bit output	LD P2,A LD P6,EA	Transfer accumulator data to the output latch	Transfer accumulator data to the output pin

PORT MODE FLAGS (PM FLAGS)

Port mode flags (PM) are used to configure I/O ports 0 and 2–13 to input or output mode by setting or clearing the corresponding I/O buffer.

For convenient program reference, PM flags are organized into four groups — PMG1, PMG2, PMG3, and PMG4 as shown in Table n. PM flags are addressable by 8-bit write instructions only.

When a PM flag is "0", the port is set to input mode; when it is "1", the port is enabled for output. RESET clears all port mode flags to logic zero, automatically configuring the corresponding I/O ports to input mode.

Table 10-3. Port Mode Group Flags

PM Group ID	Address	Bit 3	Bit 2	Bit 1	Bit 0
PMG1	FE8H	PM0.3	PM0.2	PM0.1	PM0.0
	FE9H	PM7	"0"	PM5	PM4
PMG2	FEAH	PM2.3	PM2.2	PM2.1	PM2.0
	FEBH	PM3.3	PM3.2	PM3.1	PM3.0
PMG3	FECH	PM6.3	PM6.2	PM6.1	PM6.0
	FEDH	PM8.3	PM8.2	PM8.1	PM8.0
PMG4	FEEH	PM12.3	PM12.2	PM12.1	PM12.0
	FEFH	PM13	PM11	PM10	PM9

NOTE: If bit = "0", the corresponding I/O pin is set to input mode. If bit = "1", the pin is set to output mode: PM0.0 for P0.0 PM4 for port 4 and so on.. All flags are cleared to "0" following RESET.

 PROGRAMMING TIP — Configuring I/O Ports to Input or Output

Configure P0.3 and P2 as an output port and the other ports as input ports:

```
BITS      EMB
SMB       15
LD        EA,#08H
LD        PMG1,EA      ; P0.3 ← Output, P0.0–0.2, P4, P5, P7 ← Input
LD        EA,#0FH
LD        PMG2,EA      ; P2 ← Output, P3 ← Input
LD        EA,#00H
LD        PMG3,EA      ; P6, P8 ← Input
LD        PMG4,EA      ; P9, P10, P11, P12, P13 ← Input
```


PULL-UP RESISTOR MODE REGISTER (PUMOD)

The pull-up resistor mode registers (PUMOD1 and 2) are 8-bit registers used to assign internal pull-up resistors by software to specific I/O ports and pull-down resistor to port 12. When a configurable I/O port pin is used as an output pin, its assigned pull-up resistors automatically disabled, even though the pin's pull-up is enabled by a corresponding PUMOD bit setting.

PUMOD1 and PUMOD2 are addressable by 8-bit write instructions only. RESET clears PUMOD register values to logic zero, automatically disconnecting all software-assignable port pull-up and down resistors.

Table 10-4. Pull-up Resistor Mode Register (PUMOD) Organization

PUMOD ID	Address	Bit 3	Bit 2	Bit 1	Bit 0
PUMOD1	FDCH	PUR3	PUR2	PUR1	PUR0
	FDDH	PUR9	PUR8	PUR7	PUR6
PUMOD2	FDEH	PUR13	PDR12	PUR11	PUR10
	PDFH	"0"	"0"	PUR5	PUR4

NOTE: When bit = "1", pull-up resistors are assigned to the corresponding I/O port: PUR3 for port 3, PUR2 for port 2, and so on. If bit PDR12 is set to 1, pull-down resistors are assigned to port 12.

PROGRAMMING TIP — Enabling and Disabling I/O Port Pull-up Resistors

P6–P9 enable pull-up resistors, P0–P3 disable pull-up resistors.

```

BITS      EMB
SMB      15
LD       EA,#0F0H
LD       PUMOD1,EA      ; P6–P9 enable

```

N-CHANNEL OPEN DRAIN MODE REGISTER (PNE)

The n-channel open-drain mode register (PNE1) is ports 4, 5 to n-channel, open-drain or as push-pull outputs, when a bit in the PNE register is set to "1", the corresponding output pin is configured to n-channel open-drain; when set to "0", the output pin is configured to push-pull. The all PNE registers consist of 8-bit registers only.

Table 10-5. N-Channel Open Drain Move Register (PNE) Organization

PNE ID	Address	Bit 3	Bit 2	Bit 1	Bit 0
PNE1	FDAH	PNE4.3	PNE4.2	PNE4.1	PNE4.0
	FDBH	PNE5.3	PNE5.2	PNE5.1	PNE.0

PORT 0 CIRCUIT DIAGRAM

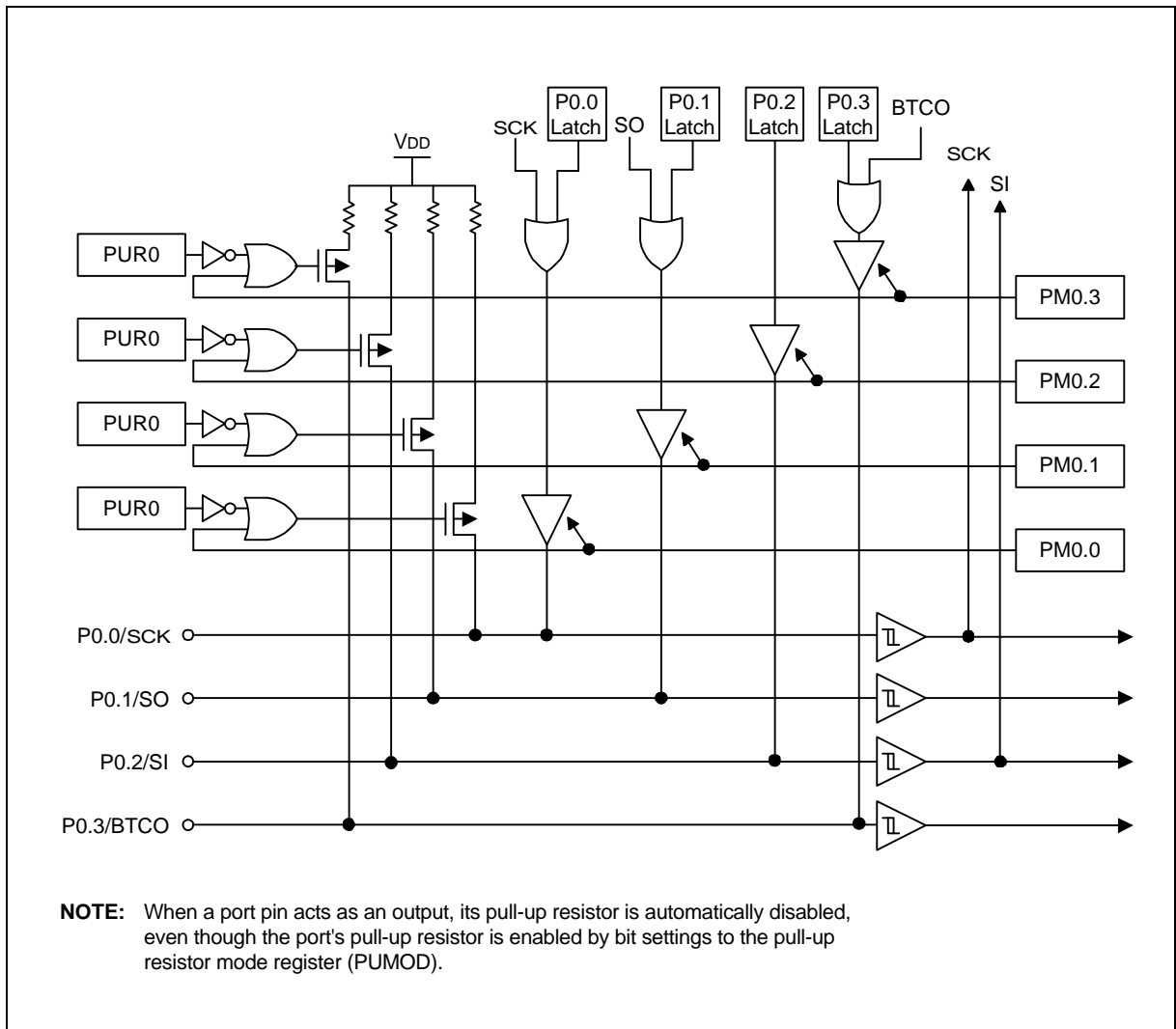


Figure 10-1. Port 0 Circuit Diagram

PORT 1 CIRCUIT DIAGRAM

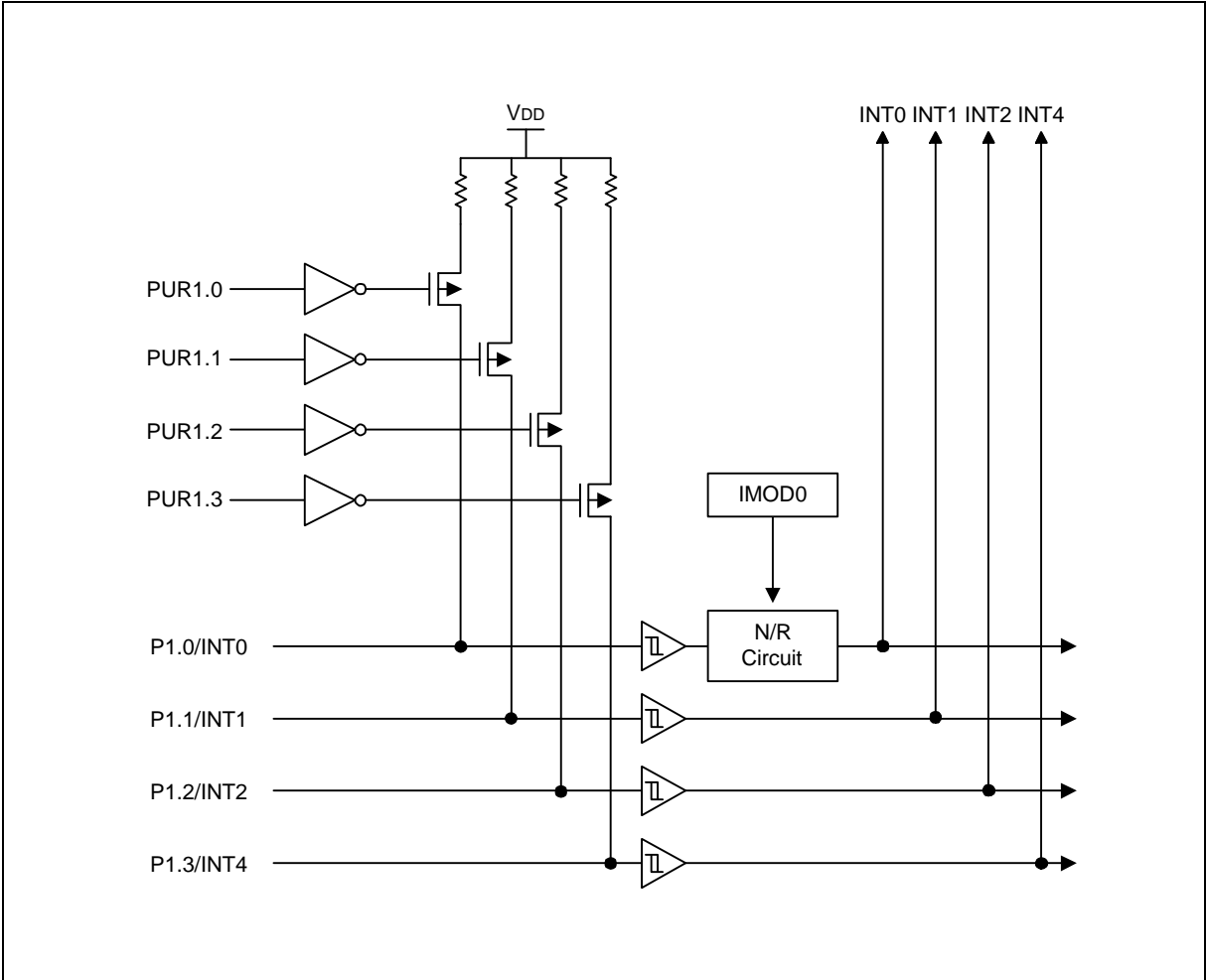


Figure 10-2. Port 1 Circuit Diagram

PORT 0, 2, 3, 6, 8 CIRCUIT DIAGRAM

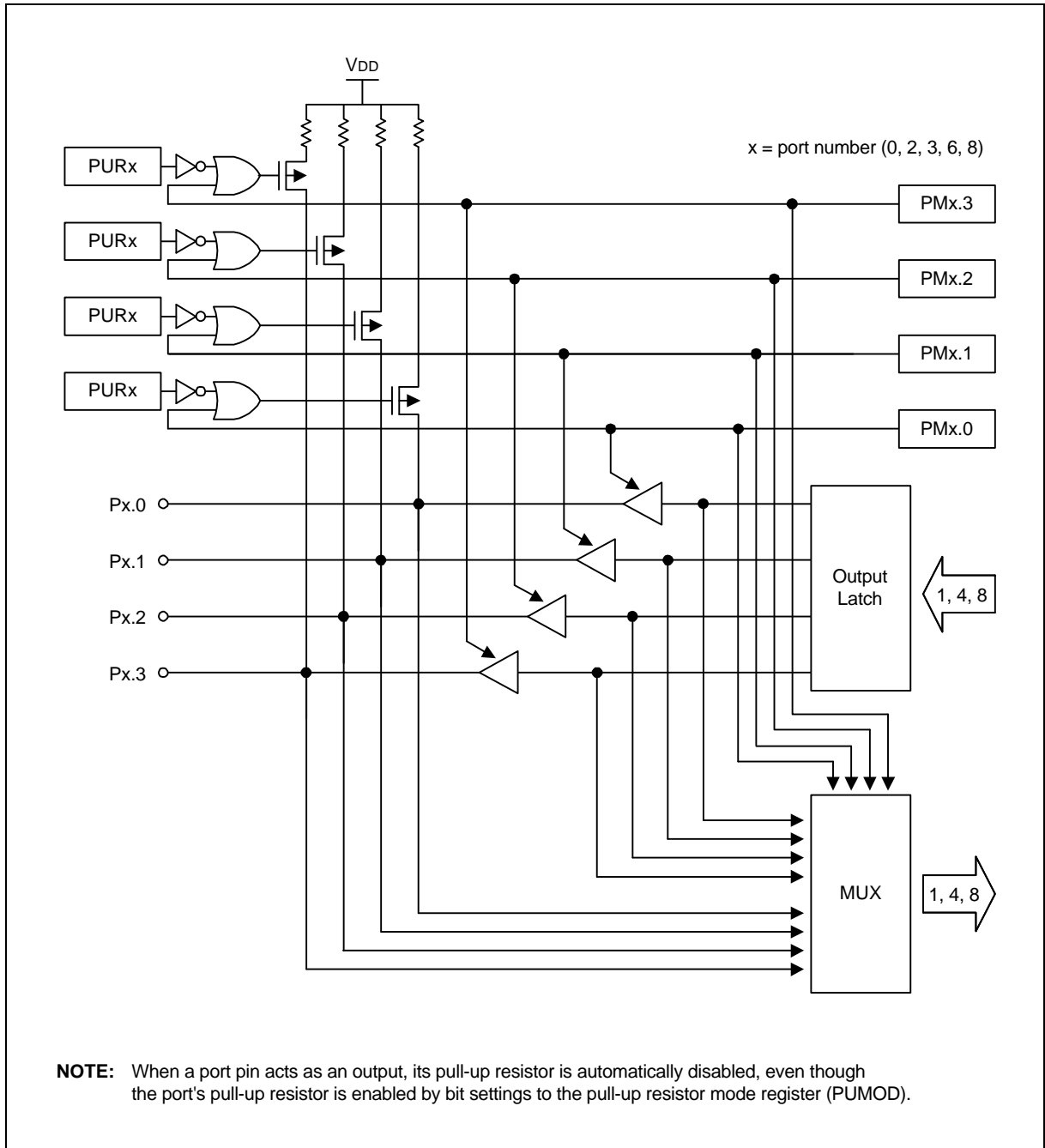


Figure 10-3. Port 0, 2, 3, 6, and 8 Circuit Diagram

PORT 4, 5 CIRCUIT DIAGRAM

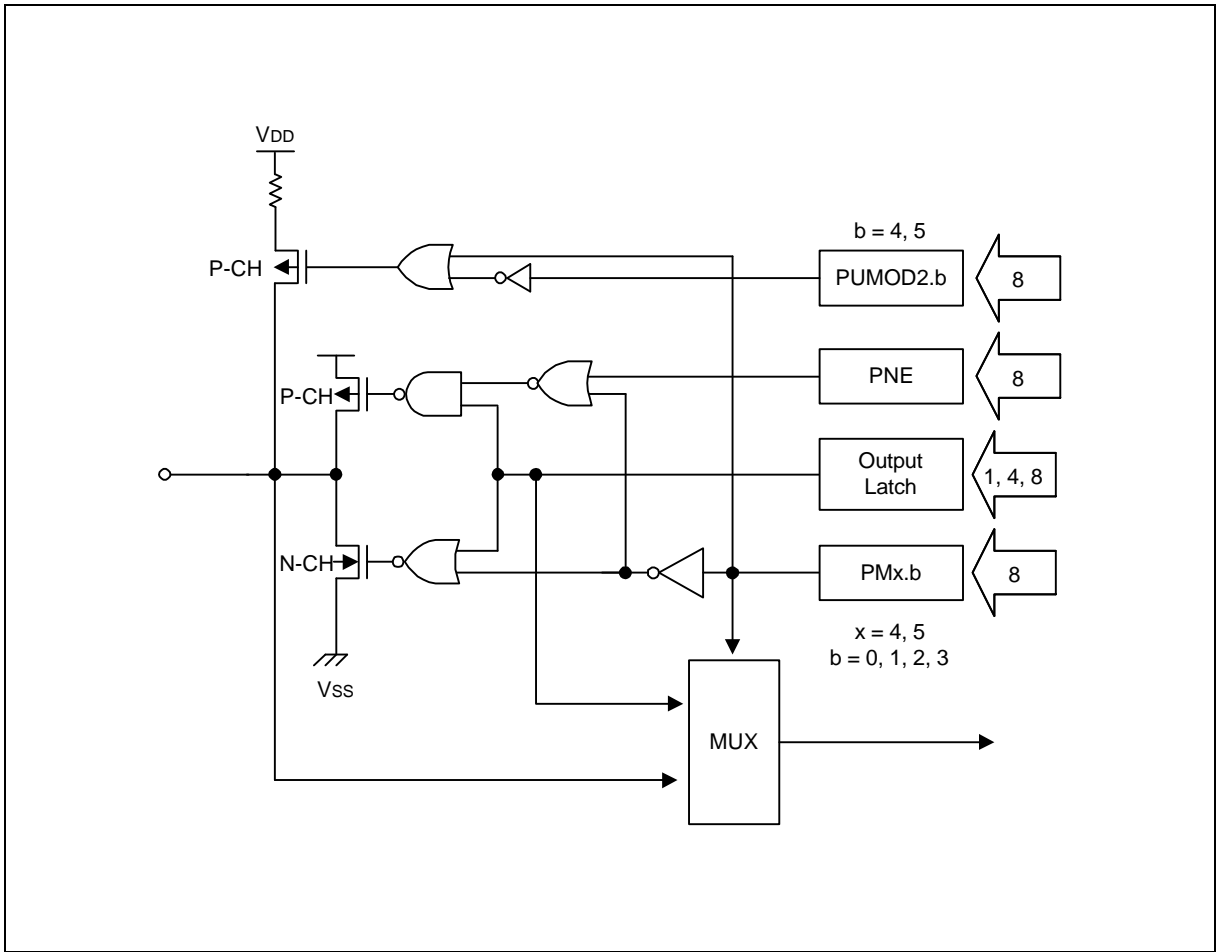


Figure 10-4. Port 4 and 5 Circuit Diagram

PORT 7, 9, 10, 11, 13 CIRCUIT DIAGRAM

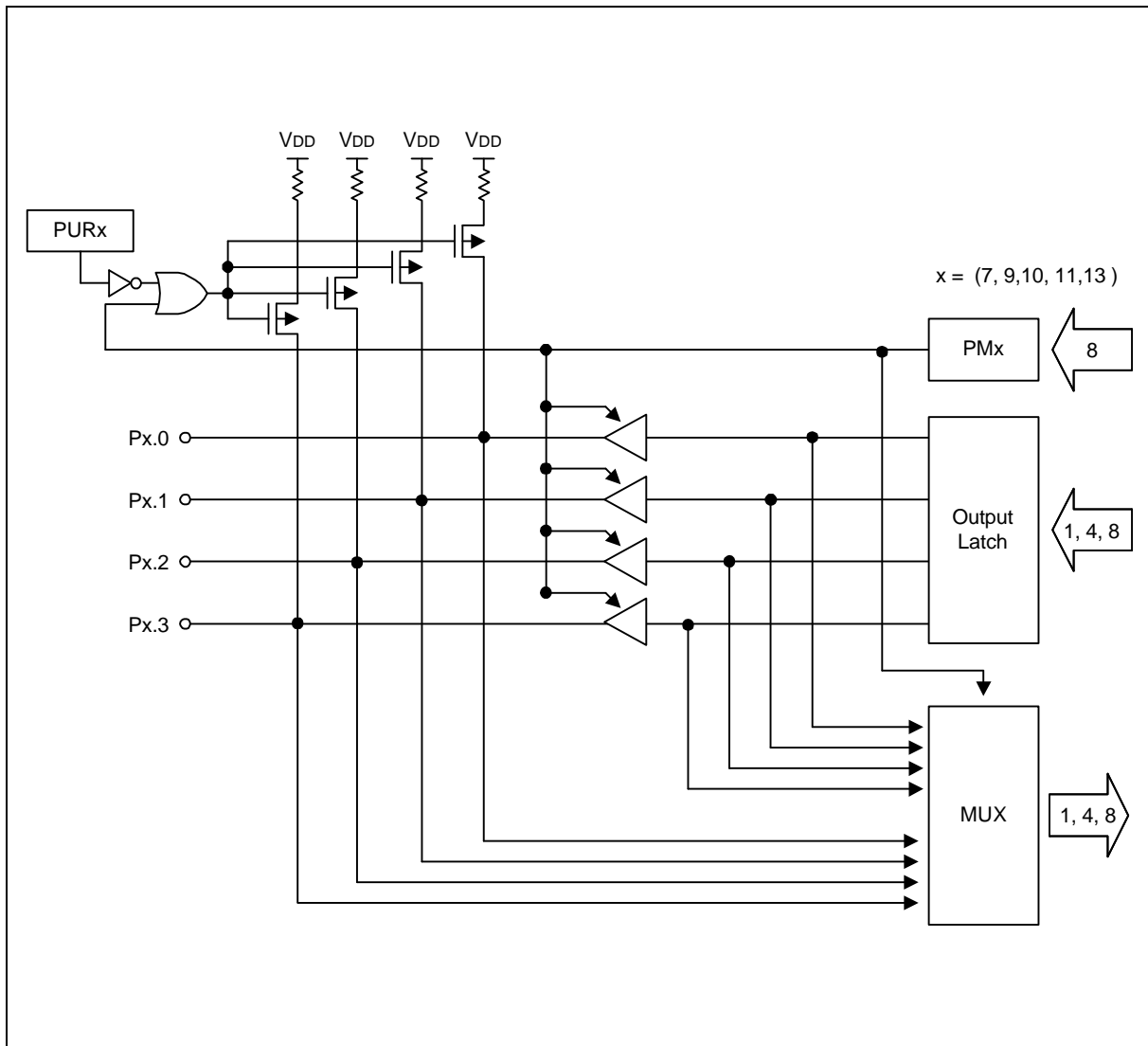


Figure 10-5. Port 7, 9, 10, 11, and 13 Circuit Diagram

PORT 12 CIRCUIT DIAGRAM

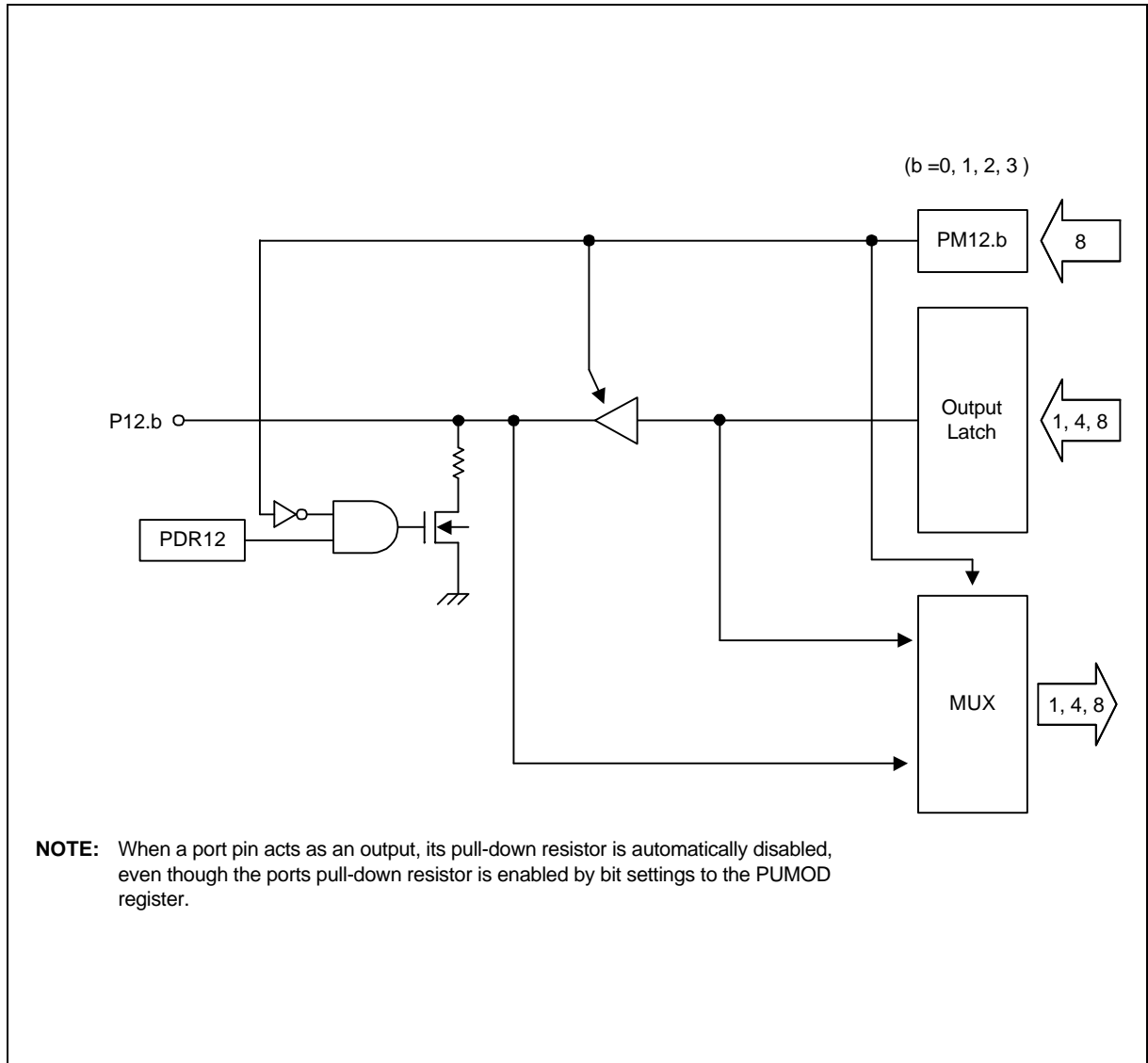


Figure 10-6. Port 12 Circuit Diagram

NOTES

11

TIMERS and TIMER/COUNTERS

OVERVIEW

The KS57C5532 microcontroller has four timer and timer/counter modules:

- 8-bit basic timer (BT)
- 8-bit timer/counters (TC0, 1)
- Watch timer (WT)

The 8-bit basic timer (BT) is the microcontroller's main interval timer. It generates an interrupt request at a fixed time interval when the appropriate modification is made to its mode register. When the contents of the basic timer counter register BCNT overflows, a pulse is output to the basic timer output pin, BTCO. The basic timer also functions as a 'watchdog' timer and is used to determine clock oscillation stabilization time when stop mode is released by an interrupt and after a RESET.

The 8-bit timer/counters (TC0, 1) are programmable timer/counters that are used primarily for event counting and for clock frequency modification and output. In addition, TC0 generates a clock signal that can be used by the serial I/O interface.

The watch timer (WT) module consists of an 8-bit watch timer mode register, a clock selector, and a frequency divider circuit. Watch timer functions include real-time and watch-time measurement, system clock interval timing, and buzzer output generation.

BASIC TIMER (BT)

OVERVIEW

The 8-bit basic timer (BT) has six functional components:

- Clock selector logic
- 4-bit mode register (BMOD)
- 8-bit counter register (BCNT)
- Output enable flag (BOE)
- 8-bit watchdog timer mode register (WDMOD)
- Watchdog timer counter clear flag (WDTCF)

The basic timer generates interrupt requests at precise intervals, based on the frequency of the system clock. Timer pulses are output from the basic timer's counter register BCNT to the output pin BCO when an overflow occurs in the counter register BCNT. You can use the basic timer as a "watchdog" timer for monitoring system events or use BT output to stabilize clock oscillation when stop mode is released by an interrupt and after a RESET. Bit settings in the basic timer mode register BMOD turns the BT module on and off, selects the input clock frequency, and controls interrupt or stabilization intervals.

Interval Timer Function

The basic timer's primary function is to measure elapsed time intervals. The standard time interval is equal to 256 basic timer clock pulses.

To restart the basic timer, one bit setting is required: bit 3 of the mode register BMOD is set to logic one. The input clock frequency and the interrupt and stabilization interval are selected by loading the appropriate bit values to BMOD.2–BMOD.0.

The 8-bit counter register, BCNT, is incremented each time a clock signal is detected that corresponds to the frequency selected by BMOD. BCNT continues incrementing as it counts BT clocks until an overflow occurs (255). An overflow causes the BT interrupt request flag (IRQB) to be set to logic one to signal that the designated time interval has elapsed. An interrupt request is then generated, BCNT is cleared to logic zero, and counting continues from 00H.

Watchdog Timer Function

The basic timer can also be used as a "watchdog" timer to signal the occurrence of system or program operation error. For this purpose, instruction that clear the watchdog timer (BITS WDTCF) should be executed at proper points in a program within given period. If an instruction that clears the watchdog timer is not executed within the given period and the watchdog timer overflows, reset signal is generated and the system restarts with reset status. An operation of watchdog timer is as follows:

- Write some values (except #5AH) to watchdog timer mode register, WDMOD
- If WDCNT overflows, system reset is generated.

Oscillation Stabilization Interval Control

Bits 2–0 of the BMOD register are used to select the input clock frequency for the basic timer. This setting also determines the time interval (also referred to as 'wait time') required to stabilize clock signal oscillation when stop mode is released by an interrupt. When a RESET signal is input, the standard stabilization interval for system clock oscillation after a the RESET is 36.6 ms at 3.58 MHz.

Table 11-1. Basic Timer Register Overview

Register Name	Type	Description	Size	RAM Address	Addressing Mode	Reset Value
BMOD	Control	Controls the clock frequency (mode) of the basic timer; also, the oscillation stabilization interval after stop mode release or RESET	4-bit	F85H	4-bit write-only; BMOD.3: 1-bit writeable	"0"
BCNT	Counter	Counts clock pulses matching the BMOD frequency setting	8-bit	F86H–F87H	8-bit read-only	U (note)
BOE	Flag	Controls output of basic timer output latch to the BTCO pin	1-bit	F92H.1	1-, 4-bit read/write	"0"
WDMOD	Control	Controls watchdog timer operation.	8-bit	F98H–F99H	8-bit write-only	A5H
WDTCF	Control	Clears the watchdog timer's counter.	1-bit	F9AH.3	1-, 4-bit write-only	"0"

NOTE: 'U' means the value is undetermined after a RESET.

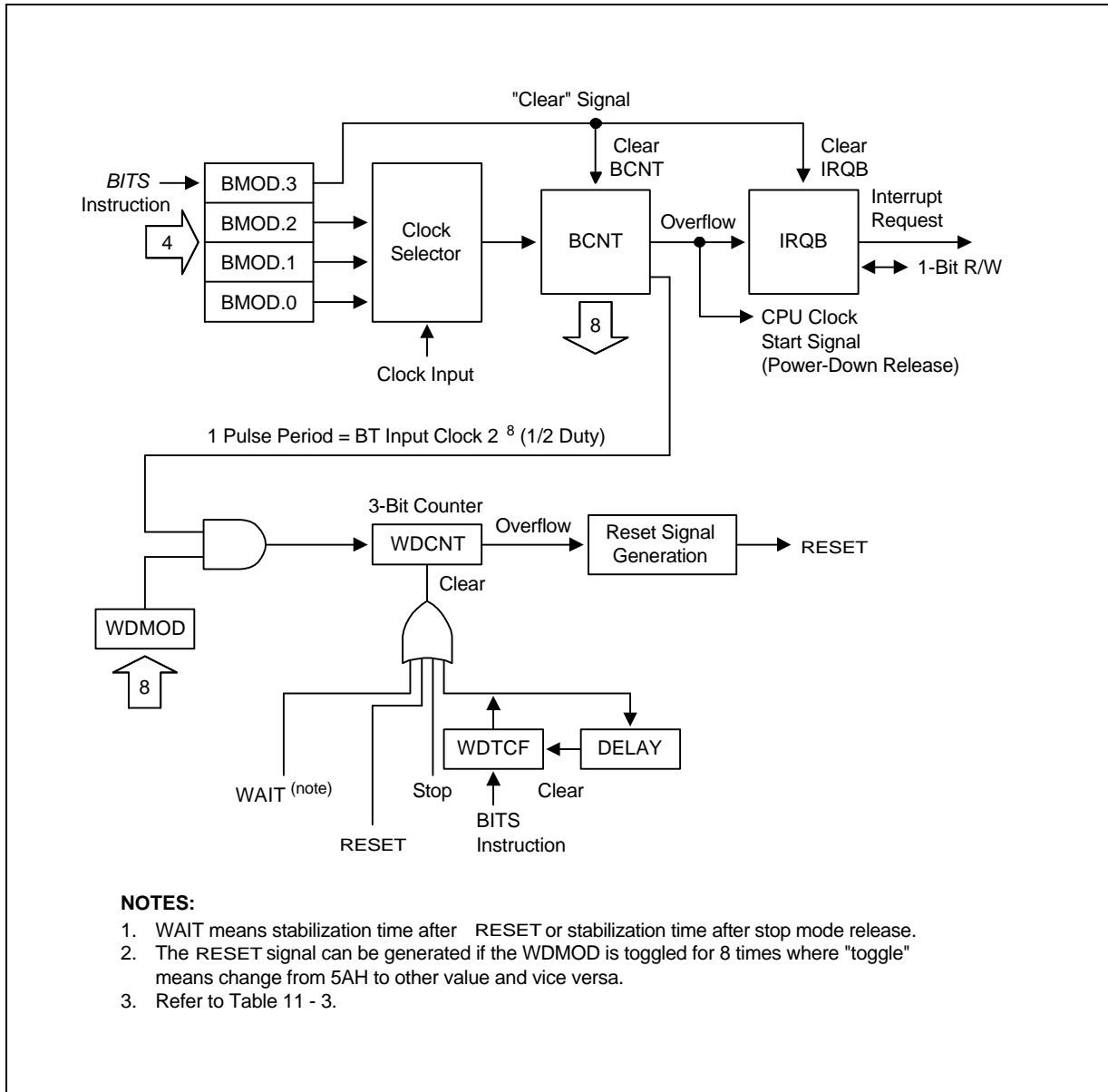


Figure 11-1. Basic Timer Circuit Diagram

BASIC TIMER MODE REGISTER (BMOD)

The basic timer mode register, BMOD, is a 4-bit write-only register. Bit 3, the basic timer start control bit, is also 1-bit addressable. All BMOD values are set to logic zero following RESET and interrupt request signal generation is set to the longest interval. (BT counter operation cannot be stopped.) BMOD settings have the following effects:

- Restart the basic timer;
- Control the frequency of clock signal input to the basic timer;
- Determine time interval required for clock oscillation to stabilize following the release of stop mode by an interrupt.

By loading different values into the BMOD register, you can dynamically modify the basic timer clock frequency during program execution. Four BT frequencies, ranging from $fx/2^{12}$ to $fx/2^5$, are selectable. Since BMOD's reset value is logic zero, the default clock frequency setting is $fx/2^{12}$.

The most significant bit of the BMOD register, BMOD.3, is used to restart the basic timer. When BMOD.3 is set to logic one by a 1-bit write instruction, the contents of the BT counter register (BCNT) and the BT interrupt request flag (IRQB) are both cleared to logic zero, and timer operation is restarted.

The combination of bit settings in the remaining three registers — BMOD.2, BMOD.1, and BMOD.0 — determine the clock input frequency and oscillation stabilization interval.

Table 11-2. Basic Timer Mode Register (BMOD) Organization

BMOD.3			Basic Timer Start Control Bit	
1			Start basic timer; clear IRQB, BCNT, and BMOD.3 to "0"	

BMOD.2	BMOD.1	BMOD.0	Basic Timer Input Clock	Interrupt Interval Time (wait time when stop mode is released)
0	0	0	$fx/2^{12}$ (0.87 kHz)	$2^{20}/fx$ (292.9 ms)
0	1	1	$fx/2^9$ (6.99 kHz)	$2^{17}/fx$ (36.6 ms)
1	0	1	$fx/2^7$ (27.9 kHz)	$2^{15}/fx$ (9.15 ms)
1	1	1	$fx/2^5$ (111.8 kHz)	$2^{13}/fx$ (2.29 ms)

NOTES:

1. Clock frequencies and interrupt interval time assume a system oscillator clock frequency (fx) of 3.579545 MHz.
2. fx = system clock frequency.
3. Wait time is the time required to stabilize clock signal oscillation after stop mode is released.
4. The standard stabilization time for system clock oscillation following a RESET is 36.6 ms at 3.579545 MHz.

BASIC TIMER COUNTER (BCNT)

BCNT is an 8-bit counter for the basic timer. It can be addressed by 8-bit read instructions. RESET leaves the BCNT counter value undetermined. BCNT is automatically cleared to logic zero whenever the BMOD register control bit (BMOD.3) is set to "1" to restart the basic timer. It is incremented each time a clock pulse of the frequency determined by the current BMOD bit settings is detected.

When BCNT has incremented to hexadecimal 'FFH' (255 clock pulses), it is cleared to '00H' and an overflow is generated. The overflow causes the interrupt request flag, IRQB, to be set to logic one. When the interrupt request is generated, BCNT immediately resumes counting incoming clock signals.

NOTE

Always execute a BCNT read operation twice to eliminate the possibility of reading unstable data while the counter is incrementing. If, after two consecutive reads, the BCNT values match, you can select the latter value as valid data. Until the results of the consecutive reads match, however, the read operation must be repeated until the validation condition is met.

BASIC TIMER OUTPUT ENABLE FLAG (BOE)

The basic timer output enable flag (BOE) enables and disables basic timer output to the BTCO pin at I/O port 0 (P0.3). When BOE is logic zero, basic timer output to the BTCO pin is disabled; when it is logic one, BT output to the BTCO pin is enabled. A RESET clears the BOE flag to "0", disabling basic timer output to the BTCO pin. When the BOE flag is set to "1" and the BCNT register overflows, the overflow signal is sent to the BTCO pin. BOE can be addressed by 1-bit read and write instructions.

	Bit 3	Bit 2	Bit 1	Bit 0
F92H	TOE1	TOE0	BOE	0

BASIC TIMER OPERATION SEQUENCE

The basic timer's sequence of operations may be summarized as follows:

1. Set BMOD.3 to logic one to restart the basic timer
2. BCNT is then incremented by one after each clock pulse corresponding to BMOD selection
3. BCNT overflows if BCNT 255 (BCNT = FFH)
4. When an overflow occurs, the IRQB flag is set by hardware to logic one
5. The interrupt request is generated
6. BCNT is then cleared by hardware to logic zero
7. Basic timer resumes counting clock pulses

PROGRAMMING TIP — Using the Basic Timer

1. To read the basic timer count register (BCNT):

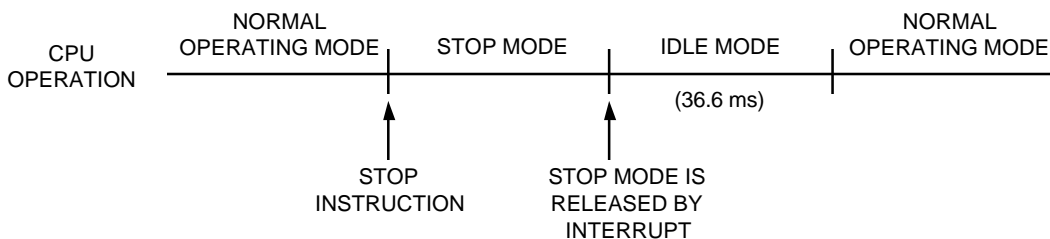
```

        BITS      EMB
        SMB      15
BCNTR  LD      EA,BCNT
        LD      YZ,EA
        LD      EA,BCNT
        CPSE   EA,YZ
        JR      BCNTR
    
```

2. When stop mode is released by an interrupt, set the oscillation stabilization interval to 36.6 ms:

```

        BITS      EMB
        SMB      15
        LD      A,#0BH
        LD      BMOD,A           ; Wait time is 36.6 ms
        NOP
        STOP                    ; Set stop power-down mode
        NOP
        NOP
        NOP
    
```



3. To set the basic timer interrupt interval time to 2.29 ms (at 3.579545 MHz):

```

        BITS      EMB
        SMB      15
        LD      A,#0FH
        LD      BMOD,A
        EI
        BITS      IEB           ; Basic timer interrupt enable flag is set to "1"
    
```

4. Clear BCNT and the IRQB flag and restart the basic timer:

```

        BITS      EMB
        SMB      15
        BITS      BMOD.3
    
```

WATCHDOG TIMER MODE REGISTER (WDMOD)

The watchdog timer mode register, WDMOD, is a 8-bit write-only register. WDMOD register controls to enable or disable the watchdog function. WDMOD values are set to logic "A5H" following RESET and this value enables the watchdog timer. Watchdog timer is set to the longest interval because BT overflow signal is generated with the longest interval.

WDMOD	Watchdog Timer Enable/Disable Control
5AH	Disable watchdog timer function
Any other value	Enable watchdog timer function

WATCHDOG TIMER COUNTER (WDCNT)

The watchdog timer counter, WDCNT, is a 3-bit counter. WDCNT is automatically cleared to logic zero, and restarts whenever the WDTCF register control bit is set to "1". RESET, stop, and wait signal clears the WDCNT to logic zero also.

WDCNT increments each time a clock pulse of the overflow frequency determined by the current BMOD bit setting is generated. When WDCNT has incremented to hexadecimal '07H', it is cleared to '00H' and an overflow is generated. The overflow causes the system RESET. When the interrupt request is generated, BCNT immediately resumes counting incoming clock signals.

WATCHDOG TIMER COUNTER CLEAR FLAG (WDTCF)


The watchdog timer counter clear flag, WDTCF, is a 1-bit write instruction. When WDTCF is set to one, it clears the WDCNT to zero and restarts the WDCNT. WDTCF register bits 2–0 are always logic zero.

Table 11-3. Watchdog Timer Interval Time

BMOD	BT Input Clock	WDCNT Input Clock	WDT Interval Time
x000b	$f_{xx}/2^{12}$	$f_{xx}/(2^{12} \times 2^8)$	$(7-8) \times (2^{12} \times 2^8) / f_{xx} = 1.75-2 \text{ sec}$
x011b	$f_{xx}/2^9$	$f_{xx}/(2^9 \times 2^8)$	$(7-8) \times (2^9 \times 2^8) / f_{xx} = 218.7-250 \text{ ms}$
x101b	$f_{xx}/2^7$	$f_{xx}/(2^7 \times 2^8)$	$(7-8) \times (2^7 \times 2^8) / f_{xx} = 54.6-62.5 \text{ ms}$
x111b	$f_{xx}/2^5$	$f_{xx}/(2^5 \times 2^8)$	$(7-8) \times (2^5 \times 2^8) / f_{xx} = 13.6-15.6 \text{ ms}$

NOTES:

1. Clock frequencies assume a system oscillator clock frequency (fx) of 4.19 MHz
2. fxx = system clock frequency.
3. When the watchdog timer is enabled or the 3-bit counter of the watchdog timer is cleared to "0", the BCNT value is not cleared but increased continuously. As a result, the 3-bit counter of the watchdog timer (WDCNT) can be increased by 1. For example, when the BMOD value is x000b and the watchdog timer is enabled, the watchdog timer interval time is from $2^3 \times 2^{12} \times 2^8 / f_{xx}$ to $(2^3-1) \times 2^{12} \times 2^8 / f_{xx}$.

 **PROGRAMMING TIP — Using the Watchdog Timer**

```
RESET      DI
           LD      EA,#00H
           LD      SP,EA
           .
           .
           .
           LD      A,#0DH      ; WDCNT input clock is 7.82 ms
           LD      BMOD,A
           .
           .
           .
MAIN       BITS    WDTCF      ; Main routine operation period must be shorter than
                               ; watchdog-timer's period
           .
           .
           .
           JP      MAIN
```

8-BIT TIMER/COUNTERS 0 AND 1 (TC0, 1)

OVERVIEW

The KS57C5532's TC0 and TC1 are identical except that they have different counter clock sources, which are controlled by the TMODn register. Timer/counters 0 and 1 (TC0, 1) are used to count system 'events' by identifying the transition (high-to-low or low-to-high) of incoming square wave signals. To indicate that an event has occurred, or that a specified time interval has elapsed, TC generates an interrupt request. By counting signal transitions and comparing the current counter value with the reference register value, TC can be used to measure specific time intervals.

TC has a reloadable counter that consists of two parts: an 8-bit reference register, TREFn (n = 0, 1) into which you write the counter reference value, and an 8-bit counter register ,TCNTn (n = 0, 1) whose value is automatically incremented by counter logic.

8-bit mode register, TMODn (n = 0, 1), is used to activate the timer/counter and to select the basic clock frequency to be used for timer/counter operations. To dynamically modify the basic frequency, new values can be loaded into the TMODn register during program execution.

TC FUNCTION SUMMARY

8-bit programmable timer	Generates interrupts at specific time intervals based on the selected clock frequency.
External event counter	Counts various system "events" based on edge detection of external clock signals at the TC input pin, TCLn (n = 0, 1).
Arbitrary frequency output	Outputs clock frequencies to the TC output pin, TClOn (n = 0, 1).
External signal divider	Divides the frequency of an incoming external clock signal according to a modifiable reference value (TREFn), and outputs the modified frequency to the TClOn pin.
Serial I/O clock source	TC0 can output a modifiable clock signal for use as the SCK clock source.

TC COMPONENT SUMMARY

Mode register (TMODn)	Activates the timer/counter and selects the internal clock frequency or the external clock source at the TCLn pin.
Reference register (TREFn)	Stores the reference value for the desired number of clock pulses between interrupt requests.
Counter register (TCNTn)	Counts internal or external clock pulses based on the bit settings in TMODn and TREFn.
Clock selector circuit	Together with the mode register (TMODn), lets you select one of four internal clock frequencies or an external clock.
8-bit comparator	Determines when to generate an interrupt by comparing the current value of the counter register (TCNTn) with the reference value previously programmed into the reference register (TREFn).
Output latch (TOLn)	Where a TC clock pulse is stored pending output to the serial I/O circuit or to the TC output pin, TOLON. When the contents of the TCNTn and TREFn registers coincide, the timer/counter interrupt request flag (IRQn) is set to "1", the status of TOLn is inverted, and an interrupt is generated.
Output enable flag (TOEn)	Must be set to logic one before the contents of the TOLn latch can be output to TOLON.
Interrupt request flag (IRQn)	Cleared when TC operation starts and the TC interrupt service routine is executed and set to one whenever the counter value and reference value coincide.
Interrupt enable flag (IETn)	Must be set to logic one before the interrupt requests generated by timer/counters can be processed.

Table 11-4. TC Register Overview

Register Name	Type	Description	Size	RAM Address	Addressing Mode	Reset Value
TMOD0 TMOD1	Control	Controls TC0 and 1 enable/disable (bit 2); clears and resumes counting operation (bit 3); sets input clock and clock frequency (bits 6–4)	8-bit	F90H–F91H FA0H–FA1H	8-bit write-only; (TMODn.3 is also 1-bit writeable)	"0"
TCNT0 TCNT1	Counter	Counts clock pulses matching the TMODn frequency setting	8-bit	F94H–F95H FA4H–FA5H	8-bit read-only	"0"
TREF0 TREF1	Reference	Stores reference value for the timer/counters interval setting	8-bit	F96H–F97H FA8H–FA9H	8-bit write-only	FFH
TOE0 TOE1	Flag	Controls timer/counters output to the TOLON pin	1-bit	F92H.2 F92H.3	1/4-bit read/write	"0"

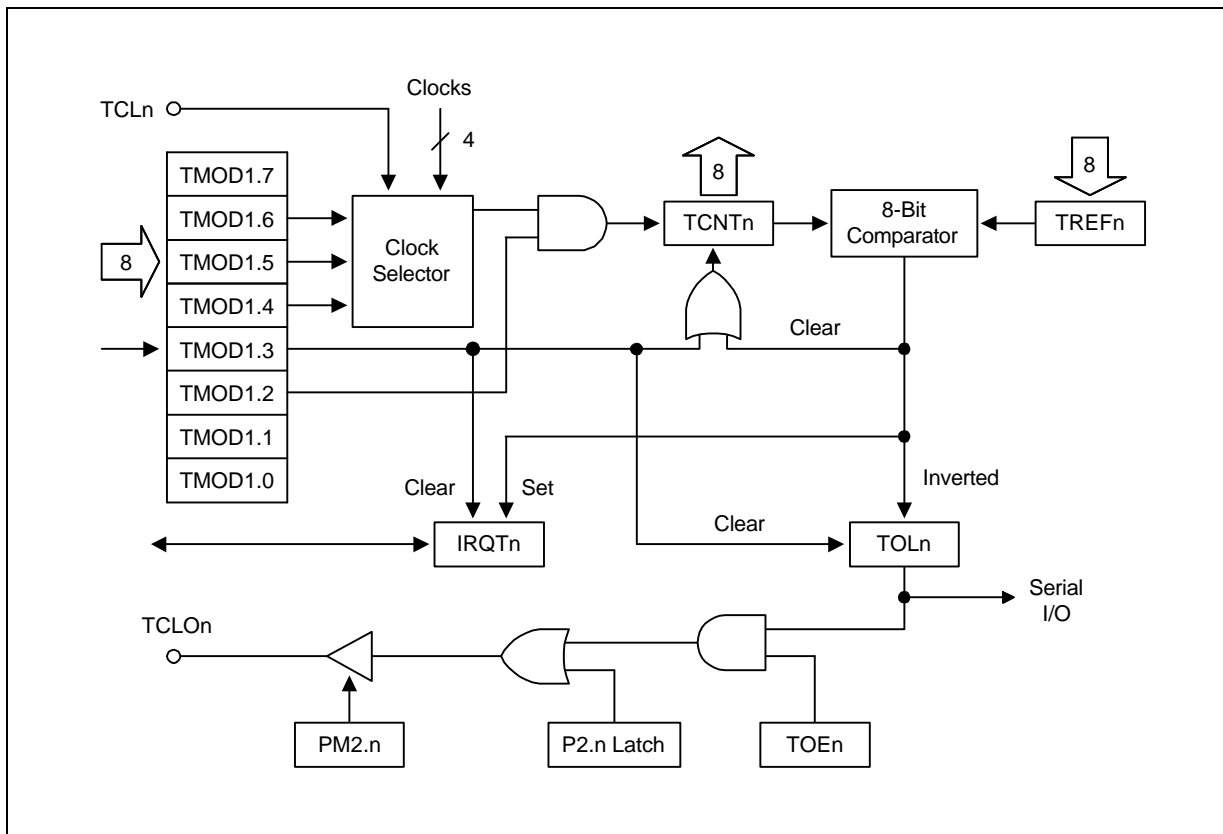


Figure 11-2. TC Circuit Diagram

TC ENABLE/DISABLE PROCEDURE

Enable Timer/Counter

- Set TMODEn.2 to logic one
- Set the TC interrupt enable flag IETn to logic one
- Set TMODEn.3 to logic one

TCNTn, IRQn, and TOLn are cleared to logic zero, and timer/counter operation starts.

Disable Timer/Counter

- Set TMODEn.2 to logic zero

Clock signal input to the counter register TCNTn is halted. The current TCNTn value is retained and can be read if necessary.

TC PROGRAMMABLE TIMER/COUNTER FUNCTION

Timer/counters can be programmed to generate interrupt requests at various intervals based on the selected system clock frequency. Its 8-bit TC mode register TMODn is used to activate the timer/counter and to select the clock frequency. The reference register TREFn stores the value for the number of clock pulses to be generated between interrupt requests. The counter register, TCNTn, counts the incoming clock pulses, which are compared to the TREFn value as TCNTn is incremented. When there is a match ($TREFn = TCNTn$), an interrupt request is generated.

To program timer/counter to generate interrupt requests at specific intervals, choose one of four internal clock frequencies (divisions of the system clock, fxx) and load a counter reference value into the reference register. The count register is incremented each time an internal counter pulse is detected with the reference clock frequency specified by TMODn.4–TMODn.6 settings. To generate an interrupt request, the TC interrupt request flag (IRQTn) is set to logic one, the status of TOLn is inverted, and the interrupt is generated. The content of the counter register is then cleared to 00H and TC continues counting. The interrupt request mechanism for TC includes an interrupt enable flag (IETn) and an interrupt request flag (IRQTn).

TC OPERATION SEQUENCE

The general sequence of operations for using TC can be summarized as follows:

1. Set TMODn.2 to "1" to enable TC0 and 1
2. Set TMODn.6 to "1" to enable the system clock (fxx) input
3. Set TMODn.5 and TMODn.4 bits to desired internal frequency ($fxx/2^n$)
4. Load a value to TREFn to specify the interval between interrupt requests
5. Set the TC interrupt enable flag (IETn) to "1"
6. Set TMODn.3 bit to "1" to clear TCNTn, IRQTn, and TOLn, and start counting
7. TCNTn increments with each internal clock pulse
8. When the comparator shows $TCNTn = TREFn$, the IRQTn flag is set to "1"
9. Output latch (TOLn) logic toggles high or low
10. Interrupt request is generated
11. TCNTn is cleared to 00H and counting resumes
12. Programmable timer/counter operation continues until TMODn.2 is cleared to "0".

TC EVENT COUNTER FUNCTION

Timer/counters can monitor or detect system 'events' by using the external clock input at the TCLn pin as the counter source. The TC mode register selects rising or falling edge detection for incoming clock signals. The counter register is incremented each time the selected state transition of the external clock signal occurs.

With the exception of the different TMODn.4–TMODn.6 settings, the operation sequence for TC's event counter function is identical to its programmable timer/counter function. To activate the TC event counter function,

- Set TMODn.2 to "1" to enable TC;
- Clear TMODn.6 to "0" to select the external clock source at the TCLn pin;
- Select TCLn edge detection for rising or falling signal edges by loading the appropriate values to TMODn.5 and TMODn.4.
- P3.0 and P3.1 must be set to input mode.

Table 11-5. TMODn Settings for TCLn Edge Detection

TMODn.5	TMODn.4	TCLn Edge Detection
0	0	Rising edges
0	1	Falling edges

TC CLOCK FREQUENCY OUTPUT

Using timer/counters, a modifiable clock frequency can be output to the TC clock output pin, TClOn. To select the clock frequency, load the appropriate values to the TC mode register, TModn. The clock interval is selected by loading the desired reference value into the reference register TREFn. In summary, the operational sequence required to output a TC-generated clock signal to the TClOn pin is as follows:

1. Load a reference value to TREFn.
2. Set the internal clock frequency in TModn.
3. Initiate TCn clock output to TClOn (TModn.2 = "1").
4. Set port 2 mode flag (PM2.0 and PM 2.1) to "1".
5. Set P2.0 and P2.1 output latches to "0".
6. Set TOEn flag to "1".

Each time TCNTn overflows and an interrupt request is generated, the state of the output latch TOLn is inverted and the TC-generated clock signal is output to the TClOn pin.

PROGRAMMING TIP — TC0 Signal Output to the TCLO0 Pin

Output a 30 ms pulse width signal to the TCLO0 pin:

```

BITS      EMB
SMB       15
LD        EA,#68H
LD        TREF0,EA
LD        EA,#4CH
LD        TMod0,EA
LD        EA,#01H
LD        PMG2,EA      ; P2.0 ← output mode
BITR      P2.0         ; P2.0 clear
BITS      TOE0

```

TC0 SERIAL I/O CLOCK GENERATION

Timer/counter 0 can supply a clock signal to the clock selector circuit of the serial I/O interface for data shifter and clock counter operations. (These internal SIO operations are controlled in turn by the SIO mode register, SMOD). This clock generation function enables you to adjust data transmission rates across the serial interface.

Use TMOD0 and TREF0 register settings to select the frequency and interval of the TC0 clock signals to be used as SCK input to the serial interface. The generated clock signal is then sent directly to the serial I/O clock selector circuit — not through the port 2.0 latch and TCLO0 pin (the TOE0 flag may be disabled).

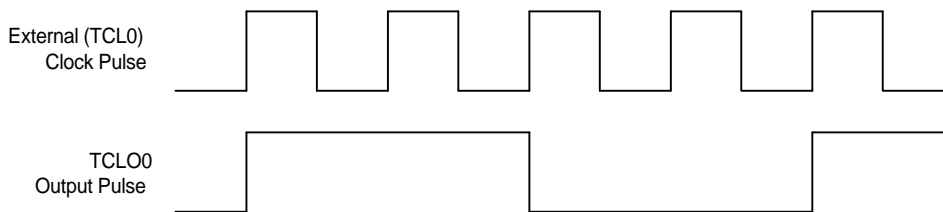
TC EXTERNAL INPUT SIGNAL DIVIDER

By selecting an external clock source and loading a reference value into the TC reference register, TREFn, you can divide the incoming clock signal by the TREFn value and then output this modified clock frequency to the TCLOn pin. The sequence of operations used to divide external clock input can be summarized as follows:

1. Load a signal divider value to the TREFn register
2. Clear TMODn.6 to "0" to enable external clock input at the TCLn pin
3. Set TMODn.5 and TMODn.4 to desired TCLn signal edge detection
4. Set port 2 mode flag (PM2.0, PM2.1) to output ("1")
5. Set P2.0 and P2.1 output latches to "0"
6. Set TOEn flag to "1" to enable output of the divided frequency to the TCLOn pin

PROGRAMMING TIP — External TCL0 Clock Output to the TCLO0 Pin

Output external TCL0 clock pulse to the TCLO0 pin (divide by four):



```

BITS      EMB
SMB       15
LD        EA,#01H
LD        TREF0,EA
LD        EA,#0CH
LD        TMOD0,EA
LD        EA,#01H
LD        PMG2,EA      ; P2.0 ← output mode
BITR      P2.0         ; P2.0 clear
BITS      TOE0

```

TC MODE REGISTER (TMODn)

TMODn are the 8-bit mode control registers for timer/counter 0 and 1. They are addressable by 8-bit write

instructions. One bit, TMODn.3, is also 1-bit writeable. RESET clears all TMODn bits to logic zero and disables TC operations.

F90H	TMOD0.3	TMOD0.2	"0"	"0"	TMOD0
F91H	"0"	TMOD0.6	TMOD0.5	TMOD0.4	
FA0H	TMOD1.3	TMOD1.2	"0"	"0"	TMOD1
FA1H	"0"	TMOD1.6	TMOD1.5	TMOD1.4	

TMODn.2 is the enable/disable bit for timer/counter 0 and 1. When TMODn.3 is set to "1", the contents of TCNTn, IRQTn, and TOLn are cleared, counting starts from 00H, and TMODn.3 is automatically reset to "0" for normal TC operation. When TC operation stops (TMODn.2 = "0"), the contents of the counter register TCNTn are retained until TC is re-enabled.

The TMODn.6, TMODn.5, and TMODn.4 bit settings are used together to select the TC clock source. This selection involves two variables:

- Synchronization of timer/counter operations with either the rising edge or the falling edge of the clock signal input at the TCLn pin, and
- Selection of one of four frequencies, based on division of the incoming system clock frequency, for use in internal TC operation.

Table 11-6. TC Mode Register (TMODn) Organization

Bit Name	Setting	Resulting TC0 Function	Address
TMODn.7	0	Always logic zero	F91H (TMOD0) FA1H (TMOD1)
TMODn.6	0,1	Specify input clock edge and internal frequency	
TMODn.5 TMODn.4			
TMODn.3	1	Clear TCNTn, IRQTn, and TOLn and resume counting immediately (This bit is automatically cleared to logic zero immediately after counting resumes.)	F90H (TMOD0) FA0H (TMOD1)
TMODn.2	0	Disable timer/counter; retain TCNTn contents	
	1	Enable timer/counter	
TMODn.1	0	Always logic zero	
TMODn.0	0	Always logic zero	

Table 11-7. TMODn.6, TMODn.5, and TMODn.4 Bit Settings

TMODn.6	TMODn.5	TMODn.4	TC0 Counter Source	TC1 Counter Source
0	0	0	External clock input (TCL0) on rising edges	External clock input (TCL1) on rising edges
0	0	1	External clock input (TCL0) on falling edges	External clock input (TCL1) on falling edges
1	0	0	$f_{xx}/2^{10}$ (3.49 kHz)	$f_{xx}/2^{12}$ (0.87 kHz)
1	0	1	$f_{xx}/2^6$ (55.93 kHz)	$f_{xx}/2^{10}$ (3.49 kHz)
1	1	0	$f_{xx}/2^4$ (223.7 kHz)	$f_{xx}/2^8$ (13.98 kHz)
1	1	1	$f_{xx} = 3.58$ MHz	$f_{xx}/2^6$ (55.93 kHz)

NOTE: 'fxx' = system clock of 3.579545 MHz.

PROGRAMMING TIP — Restarting TC0 Counting Operation

1. Set TC0 timer interval to 3.49 kHz:

```

BITS      EMB
SMB      15
LD        EA,#4CH
LD        TMOD0,EA
EI
BITS      IET0

```

2. Clear TCNT0, IRQT0, and TOL0 and restart TC0 counting operation:

```

BITS      EMB
SMB      15
BITS      TMOD0.3

```

TC COUNTER REGISTER (TCNTn)

The 8-bit counter register for TC, TCNTn, is read-only and can be addressed by 8-bit RAM control instructions. RESET sets all counter register values to logic zero (00H).

Whenever TMODn.3 is enabled, TCNTn is cleared to logic zero and counting resumes. The TCNTn register value is incremented each time an incoming clock signal is detected that matches the signal edge and frequency setting of the TMODn register (specifically, TMODn.6–TMODn.4).

Each time TCNTn is incremented, the new value is compared to the reference value stored in the reference register, TREFn. When TCNTn = TREFn, an overflow occurs in the counter register, the interrupt request flag, IRQTn, is set to logic one, and an interrupt request is generated to indicate that the specified timer/counter interval has elapsed.

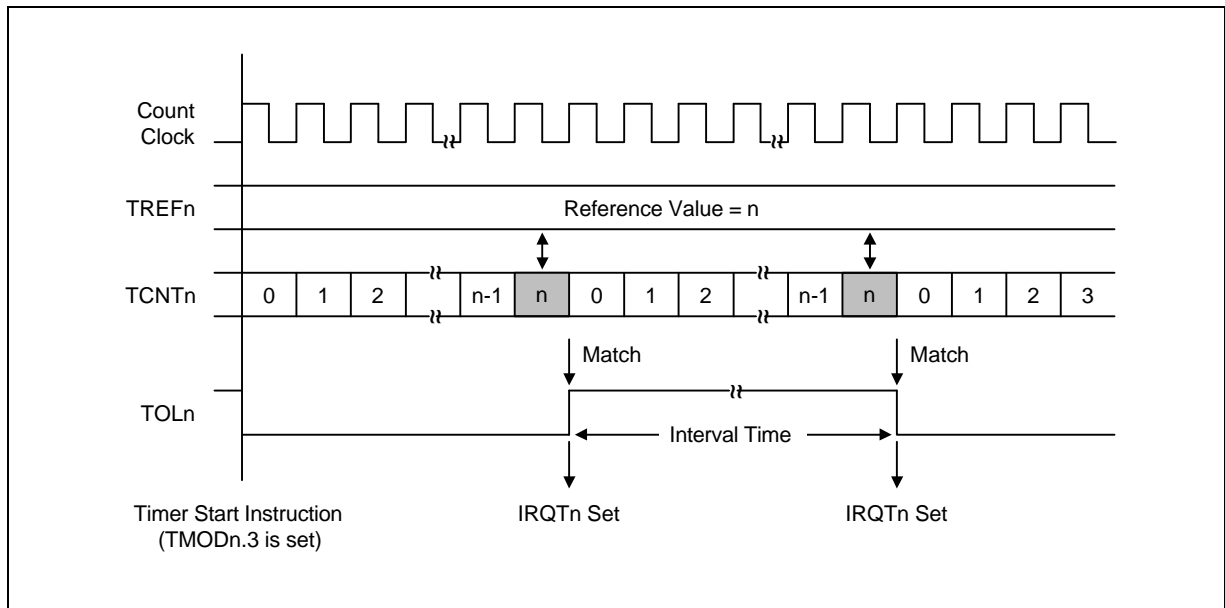


Figure 11-3. TC Timing Diagram

TC REFERENCE REGISTER (TREFn)

The TC reference register TREFn is an 8-bit write-only register that is RESET initializes the TREFn value to 'FFH'.

TREFn is used to store a reference value to be compared to the incrementing TCNTn register in order to identify an elapsed time interval. Reference values will differ depending upon the specific function that TC is being used to perform — as a programmable timer/counter, event counter, clock signal divider, or arbitrary frequency output source.

During timer/counter operation, the value loaded into the reference register is compared to the counter value. When TCNTn = TREFn, the TC output latch (TOLn) is inverted and an interrupt request is generated to signal the interval or event. The TREFn value, together with the TMODn clock frequency selection, determines the specific TC timer interval. Use the following formula to calculate the correct value to load to the TREFn reference register:

$$\text{TC timer interval} = (\text{TREFn value} + 1) \times \frac{1}{\text{TMODn frequency setting}}$$

(assuming a TREFn value $\neq 0$)

TC OUTPUT ENABLE FLAG (TOEn)

The 1-bit timer/counter output enable flag TOEn controls output from timer/counter to the TOLON pin. TOEn is addressable by 1-bit read and write instructions.


	Bit 3	Bit 2	Bit 1	Bit 0
F92H	TOE1	TOE0	BOE	0

When you set the TOEn flag to "1", the contents of TOLn can be output to the TOLON pin. Whenever a RESET occurs, TOEn is automatically set to logic zero, disabling all TC output. Even when the TOE0 flag is disabled, timer/counter 0 can continue to output an internally-generated clock frequency, via TOL0, to the serial I/O clock selector circuit.

TC OUTPUT LATCH (TOLn)

TOLn is the output latch for timer/counter 0 and 1. When the 8-bit comparator detects a correspondence between the value of the counter register TCNTn and the reference value stored in the TREFn register, the TOLn value is inverted — the latch toggles high-to-low or low-to-high. Whenever the state of TOLn is switched, the TC signal is output. TC output may be directed to the TOLON pin. TC0 signal can also be output directly to the serial I/O clock selector circuit as the SCK signal.

Assuming TC is enabled, when bit 3 of the TMODn register is set to "1", the TOLn latch is cleared to logic zero, along with the counter register and the interrupt request flag, IRQTn, and counting resumes immediately. When TCn is disabled (TMODn.2 = "0"), the contents of the TOLn latch are retained and can be read, if necessary.

 **PROGRAMMING TIP — Setting a TC0 Timer Interval**

To set a 30 ms timer interval for TC0, given $f_{xx} = 3.579545$ MHz, follow these steps.

1. Select the timer/counter 0 mode register with a maximum setup time of 73.3 ms (assume the TC0 counter clock = $f_{xx}/2^{10}$, and TREF0 is set to FFH):
2. Calculate the TREF0 value:

$$30 \text{ ms} = \frac{\text{TREF0 value} + 1}{3.49 \text{ kHz}}$$

$$\text{TREF0} + 1 = \frac{30 \text{ ms}}{286 \text{ } \mu\text{s}} = 104.8 = 69\text{H}$$

$$\text{TREF0 value} = 69\text{H} - 1 = 68\text{H}$$

3. Load the value 68H to the TREF0 register:

BITS	EMB
SMB	15
LD	EA,#68H
LD	TREF0,EA
LD	EA,#4CH
LD	TMOD0,EA

WATCH TIMER

OVERVIEW

The watch timer is a multi-purpose timer consisting of three basic components:

- 8-bit watch timer mode register (WMOD)
- Clock selector
- Frequency divider circuit

Watch timer functions include real-time and watch-time measurement and interval timing for the system clock. It is also used as a clock source for generating buzzer output.

Real-Time and Watch-Time Measurement

To start watch timer operation, set bit 2 of the watch timer mode register, WMOD.2, to logic one. The watch timer starts, the interrupt request flag IRQW is automatically set to logic one, and interrupt requests commence in 0.5-second intervals.

Since the watch timer functions as a quasi-interrupt instead of a vectored interrupt, the IRQW flag should be cleared to logic zero by program software as soon as a requested interrupt service routine has been executed.

Using a System Clock Source

The watch timer can generate interrupts based on the main system clock frequency or on the subsystem clock. When the zero bit of the WMOD register is set to "1", the watch timer uses the subsystem clock signal (fxt) as its source; if WMOD.0 = "0", the main system clock (fx) is used as the signal source, according to the following formula:

$$\text{Watch timer clock (fw)} = \frac{\text{Main system clock (fx)}}{128} = 32.768 \text{ kHz}$$

(assuming fxx = 4.19 MHz)

This feature is useful for controlling timer-related operations during stop mode. When stop mode is engaged, the main system clock (fx) is halted, but the subsystem clock continues to oscillate. By using the subsystem clock as the oscillation source during stop mode, the watch timer can set the interrupt request flag IRQW to "1", thereby releasing stop mode.

Buzzer Output Frequency Generator

The watch timer can generate a steady 2 kHz, 4 kHz, 8 kHz, or 16 kHz signal at 4.19 MHz to the BUZ pin. To select the BUZ frequency you want, load the appropriate value to the WMOD register. This output can then be used to actuate an external buzzer sound. To generate a BUZ signal, three conditions must be met:

- The WMOD.7 register bit is set to "1"
- The output latch for I/O port 2.3 is cleared to "0"
- The port 2.3 output mode flag (PM2.3) set to 'output' mode

Timing Tests in High-Speed Mode

By setting WMOD.1 to "1", the watch timer will function in high-speed mode, generating an interrupt every 3.91 ms at 4.19 MHz. At its normal speed (WMOD.1 = '0'), the watch timer generates an interrupt request every 0.5 seconds. High-speed mode is useful for timing events for program debugging sequences.

Check Subsystem Clock Level Feature

The watch timer can also check the input level of the subsystem clock by testing WMOD.3. If WMOD.3 is "1", the input level at the XT_{in} pin is high; if WMOD.3 is "0", the input level at the XT_{in} pin is low.

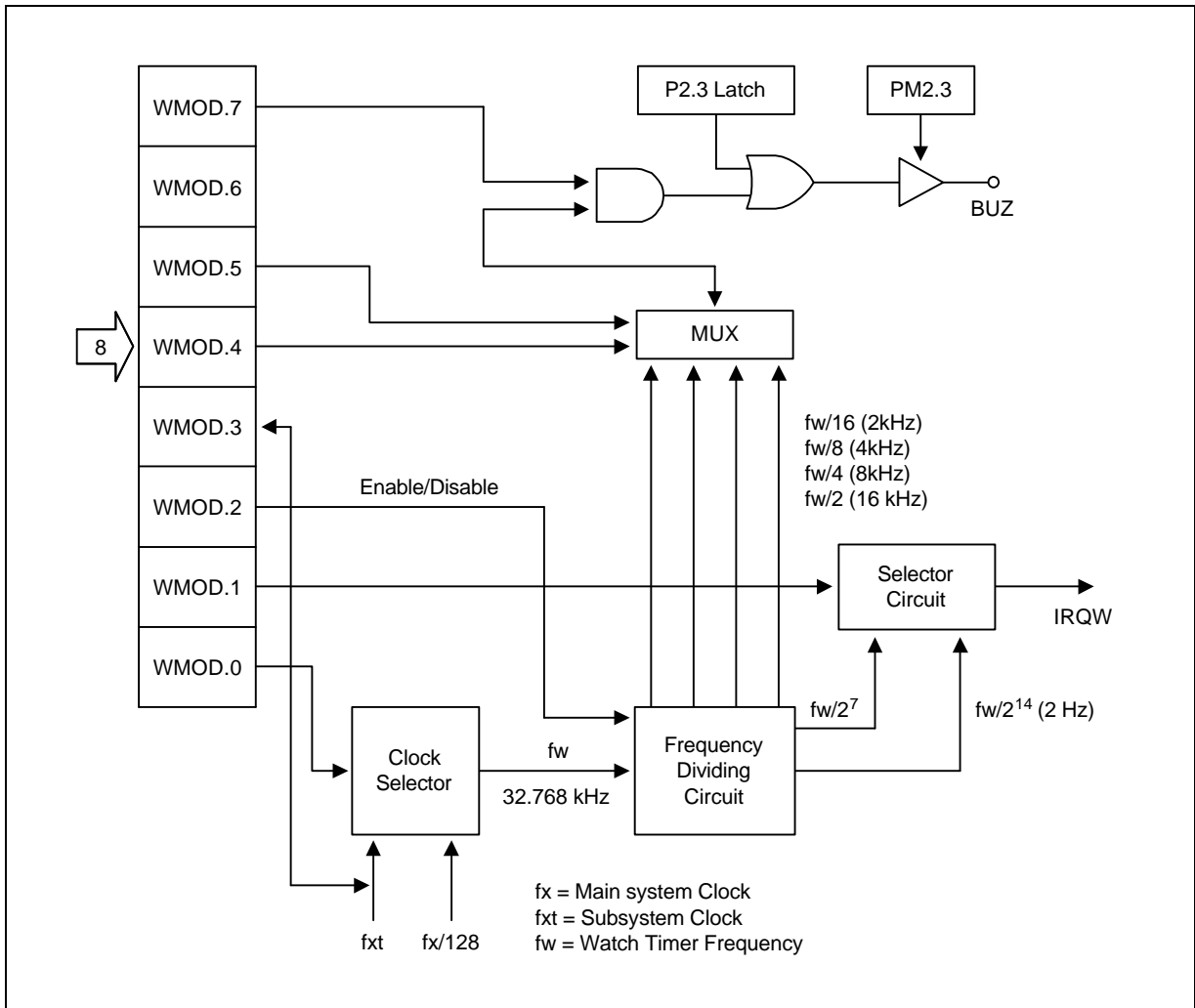


Figure 11-4. Watch Timer Circuit Diagram

WATCH TIMER MODE REGISTER (WMOD)

The watch timer mode register WMOD is used to select specific watch timer operations. It is 8-bit write-only addressable. An exception is WMOD bit 3 (the XT_{in} input level control bit) which is 1-bit read-only addressable. A RESET automatically sets WMOD.3 to the current input level of the subsystem clock, XT_{in} (high, if logic one; low, if logic zero), and all other WMOD bits to logic zero.

F88H	WMOD.3	WMOD.2	WMOD.1	WMOD.0
F89H	WMOD.7	"0"	WMOD.5	WMOD.4

In summary, WMOD settings control the following watch timer functions:

- Watch timer clock selection (WMOD.0)
- Watch timer speed control (WMOD.1)
- Enable/disable watch timer (WMOD.2)
- XT_{in} input level control (WMOD.3)
- Buzzer frequency selection (WMOD.4 and WMOD.5)
- Enable/disable buzzer output (WMOD.7)

Table 11-8. Watch Timer Mode Register (WMOD) Organization

Bit Name	Values	Function	Address	
WMOD.7	0	Disable buzzer (BUZ) signal output	F89H	
	1	Enable buzzer (BUZ) signal output		
WMOD.6	0	Always logic zero		
	0	Always logic zero		
WMOD.5 – .4	0	0		fw/16 buzzer (BUZ) signal output (2 kHz)
	0	1		fw/8 buzzer (BUZ) signal output (4 kHz)
	1	0		fw/4 buzzer (BUZ) signal output (8 kHz)
	1	1		fw/2 buzzer (BUZ) signal output (16 kHz)
WMOD.3	0	Input level to XT _{in} pin is low		F88H
	1	Input level to XT _{in} pin is high		
WMOD.2	0	Disable watch timer; clear frequency dividing circuits		
	1	Enable watch timer		
WMOD.1	0	Normal mode; sets IRQW to 0.5 seconds		
	1	High-speed mode; sets IRQW to 3.91 ms		
WMOD.0	0	Select (fx/128) as the watch timer clock (fw)		
	1	Select subsystem clock as watch timer clock (fw)		

NOTE: Main system clock frequency (fx) is assumed to be 4.19 MHz; subsystem clock frequency is assumed to be 32.768 kHz. 'fw' = watch timer clock frequency.

 **PROGRAMMING TIP — Using the Watch Timer**

1. Select a 0.5 second interrupt, and 2 kHz buzzer enable:

```

BITS      EMB
SMB       15
LD        EA,#08H
LD        PMG2,EA      ; P2.3 ← output mode
BITR      P2.3         ; Clear P2.3 output latch
LD        EA,#84H
LD        WMOD,EA
BITS      IEW

```

2. Sample real-time clock processing method:

```

CLOCK     BTSTZ      IRQW      ; 0.5 second check
          RET        ; No, return
          •          ; Yes, 0.5 second interrupt generation
          •
          •          ; Increment HOUR, MINUTE, SECOND

```

NOTES

12 DTMF GENERATOR

OVERVIEW

The dual-tone multi-frequency (DTMF) output circuit is used to generate 16 dual-tone multiple frequency signals for tone dialing. This function is controlled by the DTMF mode register. By writing the contents of the output latch for DTMF circuit with output instructions, 16 dual or single tones can be output to the DTMF output pin. The tone output frequency is selected by the DTMF mode register. Figure 12-1 shows the DTMF block diagram. A frequency of 3.579545 MHz is used for DTMF generator. Clock output is inhibited when DTMR.0 (DTMF Enable Bit) goes low.

The decoder receives data from the data latch and outputs the result to the row and column tone counter. The row and column tone counter are incremented until new data is latched. When DTMR.0 is logic one, data is latched, and the tone output is changed. Table 12-1 shows the 16 available keyboard frequencies.

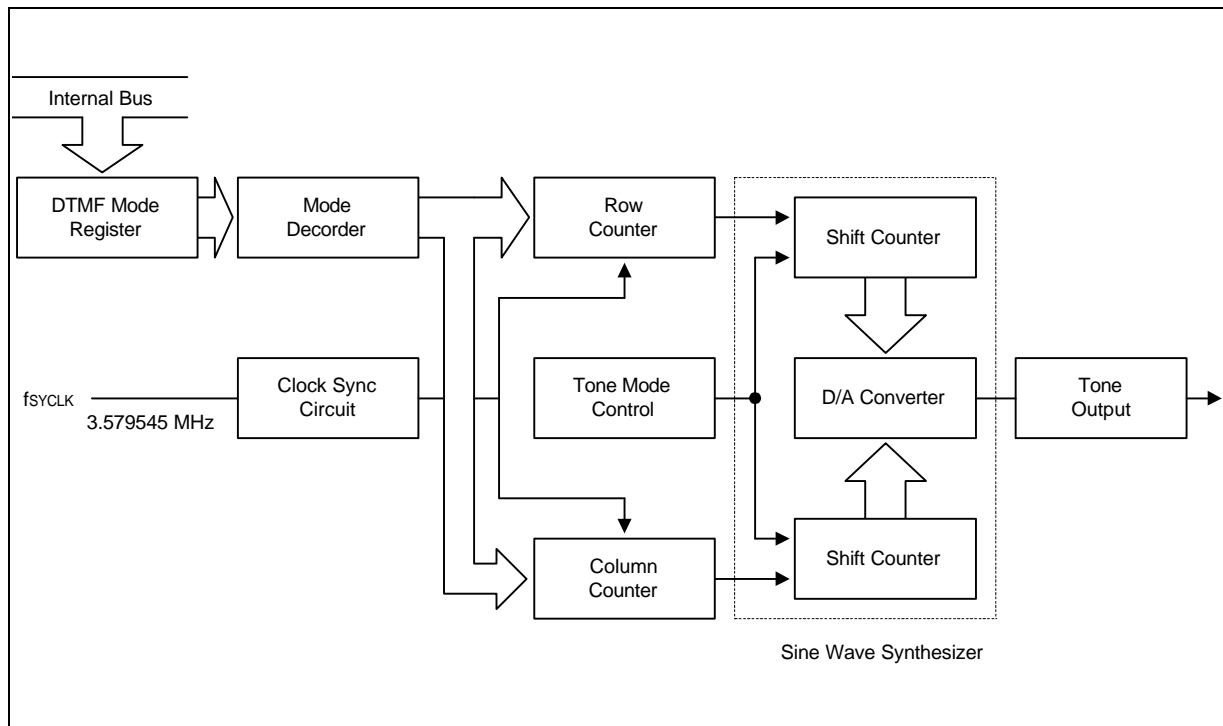


Figure 12-1. Block Diagram of DTMF Generator

Table 12-1. Keyboard Arrangement

1	2	3	A	ROW1
4	5	6	B	ROW2
7	8	9	C	ROW3
*	0	#	D	ROW4
COLUMN 1	COLUMN 2	COLUMN 3	COLUMN 4	

Table 12-2. Tone Output Frequencies

Input	Specified Frequency (Hz)	Actual Frequency (Hz)	% Error
Row1	697	699.1	+ 0.31
Row2	770	766.2	- 0.49
Row3	852	847.4	- 0.54
Row4	941	948.0	+ 0.74
Column 1	1209	1215.7	+ 0.57
Column 2	1336	1331.7	- 0.32
Column 3	1477	1471.7	- 0.35
Column 4	1633	1645.0	+ 0.73

DTMF MODE REGISTER

DTMF output is controlled by the DTMF mode register. Bit position DTMR.0 enables or disables DTMF operation. If DTMR.0 = 1, DTMF operation is enabled.

Programmers should write zeros or ones to bit positions DTMR.4–DTMR.7 according to the keyboard input specification. Writing the data in a look-up table is useful for program efficiency. The DTMR register is a write-only register, and is manipulated using 8-bit RAM control instructions.

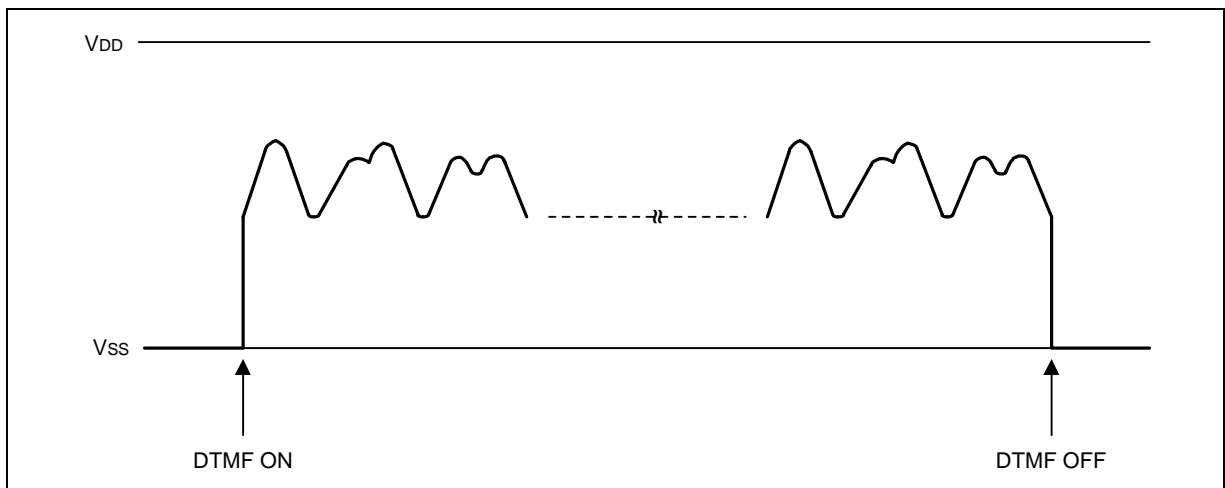


Figure 12-2. DTMF Output Waveform

Table 12-3. DTMF Mode Register (DTMR) Organization

Bit Name	Setting	Resulting DTMF Function	Address
DTMR.7–.4	0,1	Specify according to keyboard	FC1H
DTMR.3	–	Don't care	FC0H
DTMR.2–.1	0 0	Dual-tone enable	
	1 0		
	0 1	Single-column tone enable	
	1 1	Single-row tone enable	
DTMR.0	0	Disable DTMF operation	
	1	Enable DTMF operation	

Table 12-4. DTMR.7–DTMR.4 key Input Control Settings

DTMR.7	DTMR.6	DTMR.5	DTMR.4	Keyboard
0	0	0	0	D
0	0	0	1	1
0	0	1	0	2
0	0	1	1	3
0	1	0	0	4
0	1	0	1	5
0	1	1	0	6
0	1	1	1	7
1	0	0	0	8
1	0	0	1	9
1	0	1	0	0
1	0	1	1	*
1	1	0	0	#
1	1	0	1	A
1	1	1	0	B
1	1	1	1	C

NOTES

13

SERIAL I/O INTERFACE

OVERVIEW

The serial I/O interface (SIO) has the following functional components:

- 8-bit mode register (SMOD)
- Clock selector circuit
- 8-bit buffer register (SBUF)
- 3-bit serial clock counter

Using the serial I/O interface, 8-bit data can be exchanged with an external device. You control the transmission frequency by the appropriate bit settings to the SMOD register.

The serial interface can run off an internal or an external clock source, or the TOL0 signal that is generated by the 8-bit timer/counter 0, TC0. If you use the TOL0 clock signal, you can modify its frequency to adjust the serial data transmission rate.

SERIAL I/O OPERATION SEQUENCE

The general sequence of operations for the serial I/O interface may be summarized as follows:

1. Set SIO mode to transmit-and-receive or to receive-only.
2. Select MSB-first or LSB-first transmission mode.
3. Set the SCK clock signal in the mode register, SMOD.
4. Set SIO interrupt enable flag (IES) to "1".
5. Initiate SIO transmission by setting bit 3 of the SMOD to "1".
6. When the SIO operation is completed, IRQS flag is set and an interrupt is generated.

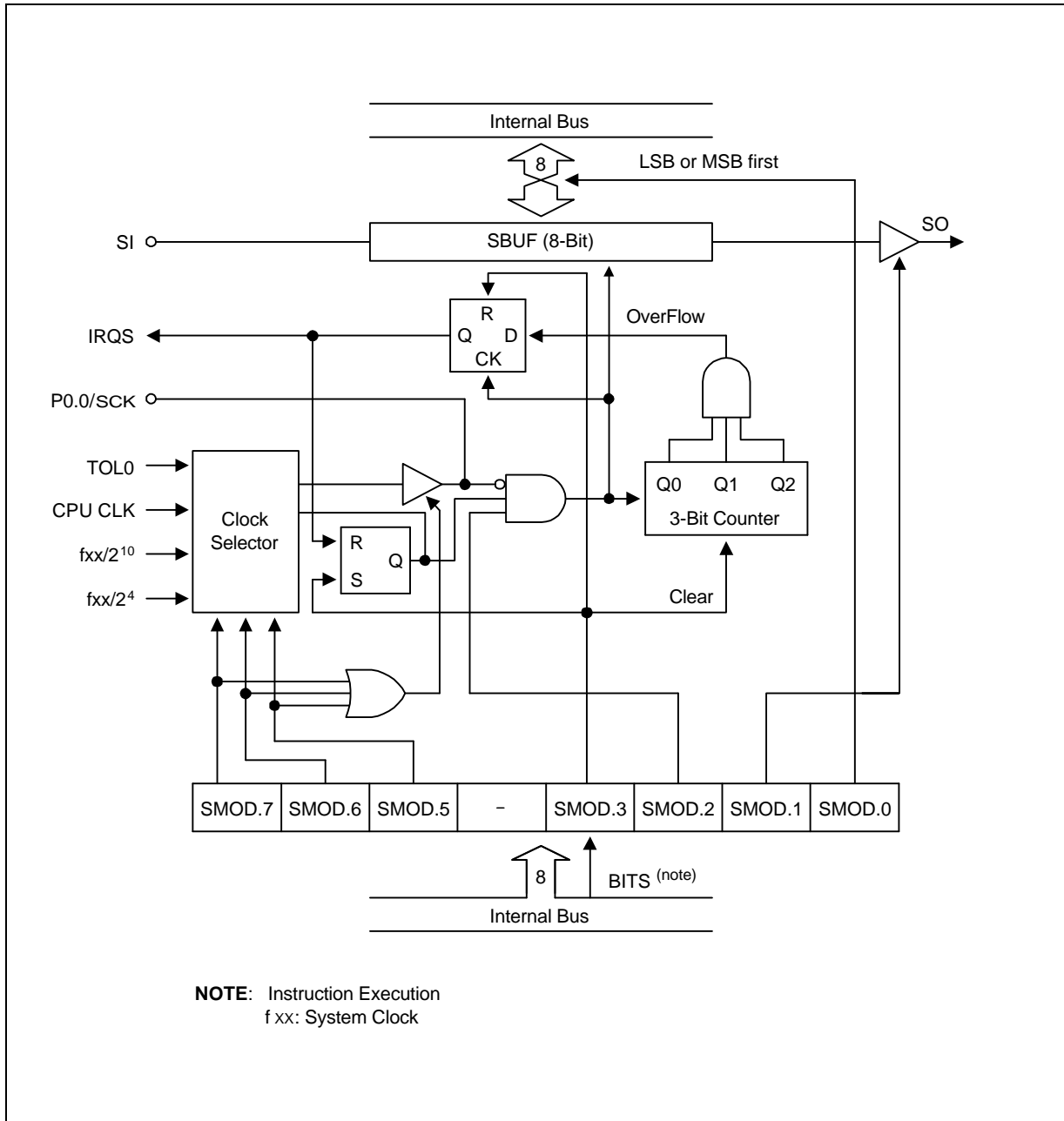


Figure 13-1. Serial I/O Interface Circuit Diagram

SERIAL I/O MODE REGISTER (SMOD)

The serial I/O mode register, SMOD, is an 8-bit register that specifies the operation mode of the serial interface. Its reset value is logic zero. SMOD is organized in two 4-bit registers, as follows:

FE0H	SMOD.3	SMOD.2	SMOD.1	SMOD.0
FE1H	SMOD.7	SMOD.6	SMOD.5	0

SMOD register settings enable you to select either MSB-first or LSB-first serial transmission, and to operate in transmit-and-receive mode or receive-only mode.

SMOD is a write-only register and can be addressed only by 8-bit RAM control instructions. One exception to this is SMOD.3, which can be written by a 1-bit RAM control instruction. When SMOD.3 is set to 1, the contents of the serial interface interrupt request flag, IRQS, and the 3-bit serial clock counter are cleared, and SIO operations are initiated. When the SIO transmission starts, SMOD.3 is cleared to logic zero.

Table 13-1. SIO Mode Register (SMOD) Organization

SMOD.0	0	Most significant bit (MSB) is transmitted first
	1	Least significant bit (LSB) is transmitted first
SMOD.1	0	Receive-only mode; output buffer is off
	1	Transmit-and-receive mode
SMOD.2	0	Disable the data shifter and clock counter; retain contents of IRQS flag when serial transmission is halted
	1	Enable the data shifter and clock counter; set IRQS flag to "1" when serial transmission is halted
SMOD.3	1	Clear IRQS flag and 3-bit clock counter to "0"; initiate transmission and then reset this bit to logic zero
SMOD.4	0	Bit not used; value is always "0"

SMOD.7	SMOD.6	SMOD.5	Clock Selection	R/W Status of SBUF
0	0	0	External clock at SCK pin	SBUF is enabled when SIO operation is halted or when SCK goes high.
0	0	1	Use TOL0 clock from TC0	
0	1	x	CPU clock: fxx/4, fxx/8, fxx/64	Enable SBUF read/write
1	0	0	3.49 kHz clock: fxx/2 ¹⁰	SBUF is enabled when SIO operation is halted or when SCK goes high.
1	1	1	223.7 kHz clock: fxx/2 ⁴	

NOTES:

- 'fxx' = system clock; 'x' means 'don't care.'
- kHz frequency ratings assume a system clock (fxx) running at 3.579545 MHz.
- The SIO clock selector circuit cannot select a fxx/2⁴ clock if the CPU clock is fxx/64.
- When an internal clock is selected as a clock source for the serial I/O interface (by setting other values than "000" in SMOD.7–SMOD.5), the clock can be output from SCK pin.

SERIAL I/O TIMING DIAGRAMS

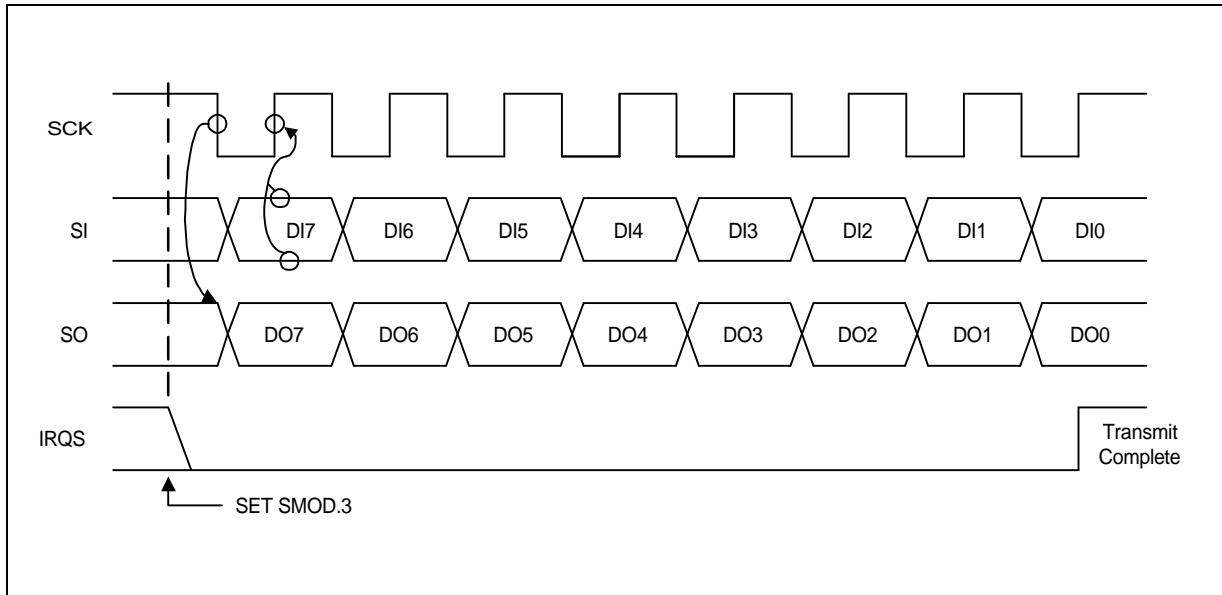


Figure 13-2. SIO Timing in Transmit/Receive Mode

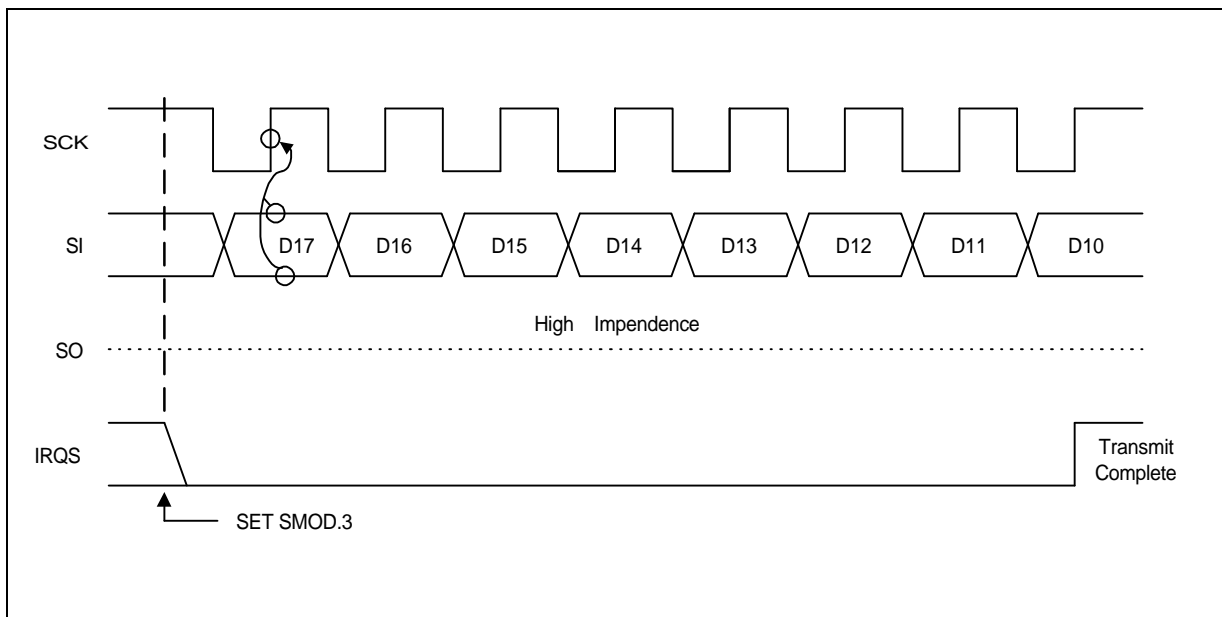


Figure 13-3. SIO Timing in Receive-Only Mode

SERIAL I/O BUFFER REGISTER (SBUF)

When the serial interface operates in transmit-and-receive mode (SMOD.1 = "1"), transmit data in the SIO buffer register are output to the SO pin at the rate of one bit for each falling edge of the SIO clock. Receive data is simultaneously input from the SI pin to SBUF at the rate of one bit for each rising edge of the SIO clock.

When receive-only mode is used, incoming data is input to the SIO buffer at the rate of one bit for each rising edge of the SIO clock.

SBUF can be read or written using 8-bit RAM control instructions. Following a RESET, the value of SBUF is undetermined.

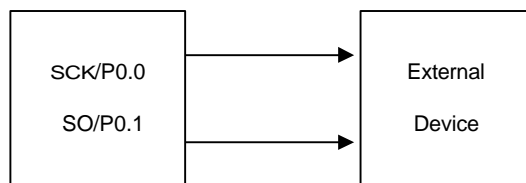
PROGRAMMING TIP — Setting Transmit/Receive Modes for Serial I/O

1. Transmit the data value 48H through the serial I/O interface using an internal clock frequency of $f_{cx}/2^4$ and in MSB-first mode:

```

BITS      EMB
SMB       15
LD        EA,#03H
LD        PMG1,EA      ; P0.0 / SCK and P0.1 / SO ← Output
LD        EA,#0E6H
LD        SMOD,EA
LD        EA,#48H
LD        SBUF,EA     ; SIO data transfer
BITS      SMOD.3

```



[KS575532]

2. Use CPU clock to transfer and receive serial data at high speed:

```

BITR      EMB
LD        EA,#03H
LD        PMG1,EA      ; P0.0/SCK and P0.1/SO ← Output, P0.2/SI ← Input
LD        EA,#47H      ; TDATA address = Bank0 (20H–7FH)
LD        SMOD,EA
LD        EA,#TDATA
LD        SBUF,EA     ; SIO start
BITS      SMOD.3
BITR      IES         ; SIO Interrupt Enable
STEST     BTSTZ      IRQS
JR        STEST
LD        EA,SBUF
LD        RDATA,EA    ; RDATA address = Bank0 (20H–7FH)

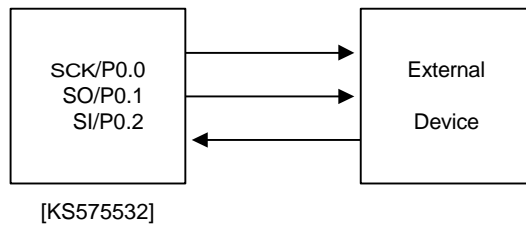
```

PROGRAMMING TIP — Setting Transmit/Receive Modes for Serial I/O (Continued)

3. Transmit and receive an internal clock frequency of 3.49 kHz (at 3.579545 MHz) in LSB-first mode:

```

BITS      EMB
LD        EA,#03H
LD        PMG1,EA      ; P0.0 / SCK and P0.1 / SO ← Output, P0.2/SI ← Input
LD        EA,#87H      ; TDATA address = Bank0 (20H-7FH)
LD        SMOD,EA
LD        EA,TDATA
LD        SBUF,EA      ; SIO start
BITS      SMOD.3
EI
BITS      IES          ; SIO Interrupt Enable
.
.
.
INTS      PUSH        SB          ; Store SMB, SRB
          PUSH        EA          ; Store EA
          BITR        EMB
          LD          EA,TDATA    ; EA ← Receive data
          ;           TDATA address = Bank0 (20H-7FH)
          XCH        EA,SBUF      ; Transmit data ↔ Receive data
          LD          RDATA,EA    ; RDATA address = Bank0 (20H-7FH)
          BITS      SMOD.3      ; SIO start
          POP        EA
          POP        SB
          IRET
    
```



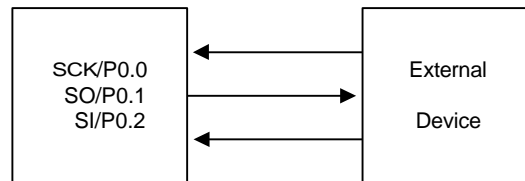
 **PROGRAMMING TIP — Setting Transmit/Receive Modes for Serial I/O (Continued)**

4. Transmit and receive an external clock in LSB-first mode:

```

        BITR      EMB
        LD        EA,#02H
        LD        PMG1,EA          ; P0.1 / SO ← Output, P0.0/SCK and P0.2/SI ← Input
        LD        EA,TDATA        ; TDATA address = Bank0 (20H-7FH)
        LD        SBUF,EA
        LD        EA,#0FH
        LD        SMOD,EA         ; SIO start
        EI
        BITS      IES             ; SIO Interrupt Enable
        .
        .
        .
INTS    PUSH      SB              ; Store SMB, SRB
        PUSH      EA              ; Store EA
        BITR      EMB
        LD        EA,TDATA        ; EA ← Transmit data
                                   ; TDATA address = Bank0 (20H-7FH)
        XCH      EA,SBUF          ; Transmit data ↔ Receive data
        LD        RDATA,EA        ; RDATA address = Bank0 (20H-7FH)
        BITS      SMOD.3         ; SIO start
        POP      EA
        POP      SB
        IRET

```



[KS575532]

High Speed SIO Transmission

NOTES

14 ELECTRICAL DATA

OVERVIEW

In this section, information on KS57C5532 electrical characteristics is presented as tables and graphics. The information is arranged in the following order:

Standard Electrical Characteristics

- Absolute maximum ratings
- D.C. electrical characteristics
- System clock oscillator characteristics
- I/O capacitance
- A.C. electrical characteristics
- Operating voltage range

Miscellaneous Timing Waveforms

- A.C timing measurement point
- Clock timing measurement at X_{IN} and X_{OUT}
- TCL timing
- Input timing for RESET
- Input timing for external interrupts
- Serial data transfer timing

Stop Mode Characteristics and Timing Waveforms

- RAM data retention supply voltage in stop mode
- Stop mode release timing when initiated by RESET
- Stop mode release timing when initiated by an interrupt request

Table 14-1. Absolute Maximum Ratings

(T_A = 25 °C)

Parameter	Symbol	Conditions	Rating	Units
Supply Voltage	V _{DD}	–	– 0.3 to 6.5	V
Input Voltage	V _{I1}	All I/O ports	– 0.3 to V _{DD} + 0.3	V
Output Voltage	V _O	–	– 0.3 to V _{DD} + 0.3	V
Output Current High	I _{OH}	One I/O port active	– 15	mA
		All I/O ports active	– 30	
Output Current Low	I _{OL}	One I/O port active	+ 30 (Peak value)	mA
			+ 15 (note)	
		All I/O ports, total	+ 100 (Peak value)	
			+ 60 (note)	
Operating Temperature	T _A	–	– 40 to + 85	°C
Storage Temperature	T _{stg}	–	– 65 to + 150	°C

NOTE: The values for Output Current Low (I_{OL}) are calculated as Peak Value × √Duty .

Table 14-2. D.C. Electrical Characteristics

(T_A = – 40 °C to + 85 °C, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Input High Voltage	V _{IH1}	All input pins except those specified below for V _{IH2} –V _{IH4}	0.7 V _{DD}	–	V _{DD}	V
	V _{IH2}	Ports 0, 1, 3, 6, 7, and RESET	0.8 V _{DD}		V _{DD}	
	V _{IH3}	Ports 4 and 5 with pull-up resistors assigned	0.7 V _{DD}		V _{DD}	
	V _{IH4}	X _{IN} , X _{OUT} and XT _{IN}	V _{DD} – 0.1		V _{DD}	
Input Low Voltage	V _{IL1}	All input pins except those specified below for V _{IL2} –V _{IL3}	–	–	0.3 V _{DD}	V
	V _{IL2}	Ports 0, 1, 3, 6, 7, and RESET			0.2 V _{DD}	
	V _{IL3}	X _{IN} , X _{OUT} and XT _{IN}			0.1	

Table 14-2. D.C. Electrical Characteristics (Continued)

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Output High Voltage	V _{OH}	I _{OH} = -1 mA Ports except 1	V _{DD} - 1.0	-	-	V
Output Low Voltage	V _{OL1}	V _{DD} = 4.5 V to 5.5 V I _{OL} = 15 mA Ports 4,5 only	-	-	2	V
		V _{DD} = 1.8 to 5.5 V, I _{OL} = 1.6mA	-	-	0.4	V
	V _{OL2}	V _{DD} = 4.5 V to 5.5 V I _{OL} = 4mA all out Ports except ports 4,5			2	V
		V _{DD} = 1.8 to 5.5 V, I _{OL} = 1.6mA			0.4	V
Input High Leakage Current	I _{LIH1}	V _I = V _{DD} All input pins except those specified below for I _{LIH2}	-	-	3	μA
	I _{LIH2}	V _I = V _{DD} X _{IN} , X _{OUT} and XT _{IN}			20	
Input Low Leakage Current	I _{LIL1}	V _I = 0 V All input pins except below and RESET	-	-	- 3	μA
	I _{LIL2}	V _I = 0 V X _{IN} , X _{OUT} and XT _{IN}			- 20	
Output High Leakage Current	I _{LOH}	V _O = V _{DD} All output pins	-	-	3	μA
Output Low Leakage Current	I _{LOL}	V _O = 0 V All output pins	-	-	- 3	
Pull-Up Resistor	R _{L1}	V _{DD} = 5 V; V _I = 0 V except RESET	25	45	100	kΩ
		V _{DD} = 3 V	50	89	200	
	R _{L3}	V _{DD} = 5 V; V _I = 0 V; RESET V _{DD} = 3 V	100 200	212 441	400 800	
Pull-Down Resistor	R _{L4}	V _{DD} = 5 V; V _I = V _{DD} ; Port 12	25	46	100	
		V _{DD} = 3 V	50	95	200	

Table 14-2. D.C. Electrical Characteristics (Concluded)

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

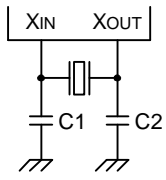
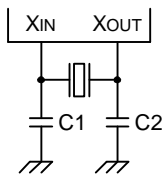
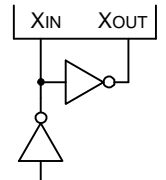
Parameter	Symbol	Conditions	Min	Typ	Max	Units	
Supply Current (1)	I _{DD1} (DTMF ON)	Run mode; V _{DD} = 5.0 V ± 10% 3.58 MHz Crystal oscillator; C1 = C2 = 22 pF	-	3.0	5.0	mA	
		V _{DD} = 3 V ± 10%		1.6	3.0		
	I _{DD2} (DTMF OFF)	Run mode; V _{DD} = 5.0 V ± 10% Crystal oscillator; C1 = C2 = 22 pF		6.0 MHz	2.7		8.0
		V _{DD} = 3 V ± 10%		3.58 MHz	2.0		4.0
				6.0 MHz	1.3		4.0
	I _{DD3}	Idle mode; V _{DD} = 5 V ± 10%		6.0 MHz	0.8		2.5
				3.58 MHz	0.7		1.8
		V _{DD} = 3 V ± 10%		6.0 MHz	0.3		1.5
				3.58 MHz	0.2		1.0
	I _{DD4}	Run mode; V _{DD} = 3.0 V ± 10% 32 kHz Crystal oscillator		-	12.5		30
I _{DD5}		Idle mode; V _{DD} = 3.0 V ± 10% 32 kHz Crystal oscillator	4.5		15		
I _{DD6}	Stop mode; V _{DD} = 5 V ± 10%	SCMOD = 0000B XT = 0V	-	1.9	5		
	Stop mode; V _{DD} = 3 V ± 10%			0.6	3		
	Stop mode; V _{DD} = 5 V ± 10%			SCMOD = 0100B	0.2	3	
	Stop mode; V _{DD} = 3 V ± 10%				0.1	2	
Row Tone Level (2)	V _{ROW}	V _{DD} = 2.0 V to 5.5 V R _L = 12 KΩ; Temp = -30 to 60 °C	-16	-14	-11	dBV	
Ratio of Column to Row Tone (2)	dB _{CR}	V _{DD} = 2.0 V to 5.5 V R _L = 12 KΩ; Temp = -30 to 60 °C	1	2	3	dB	
Distortion (2) (Dual tone)	THD	V _{DD} = 2.0 V to 5.5 V 1 MHz band, R _L = 12 KΩ Temp = -30 to 60 °C	-	-	5	%	

NOTES:

1. D.C. electrical values for Supply Current (I_{DD1} to I_{DD3}) do not include current drawn through internal pull-up resistors.
2. DTMF electrical characteristics.
3. For D.C. electrical values, the power control register (PCON) must be set to 0011B.

Table 14-3. Main System Clock Oscillator Characteristics

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

Oscillator	Clock Configuration	Parameter	Test Condition	Min	Typ	Max	Units
Ceramic Oscillator		Oscillation frequency ⁽¹⁾	V _{DD} = 2.7 V to 5.5 V	0.4	–	6.0	MHz
			V _{DD} = 1.8 V to 5.5 V	0.4	–	3	
		Stabilization time ⁽²⁾	V _{DD} = 3 V	–	–	4	ms
Crystal Oscillator		Oscillation frequency ⁽¹⁾	V _{DD} = 2.7 V to 5.5 V	0.4	–	6.0	MHz
			V _{DD} = 1.8 V to 5.5 V	0.4	–	3	
		Stabilization time ⁽²⁾	V _{DD} = 3 V	–	–	10	ms
External Clock		X _{IN} input frequency ⁽¹⁾	V _{DD} = 2.7 V to 5.5 V	0.4	–	6.0	MHz
			V _{DD} = 1.8 V to 5.5 V	0.4	–	3	
		X _{IN} input high and low level width (t _{XH} , t _{XL})	–	83.3	–	1250	ns

NOTES:

- Oscillation frequency and X_{IN} input frequency data are for oscillator characteristics only.
- Stabilization time is the interval required for oscillator stabilization after a power-on occurs, or when stop mode is terminated.

Table 14-4. Recommended Oscillator Constants

(T_A = -40 °C to +85 °C)

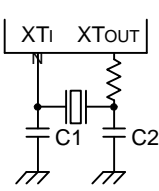
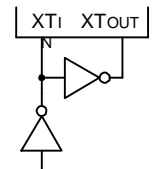
Manufacturer	Series Number ⁽¹⁾	Frequency Range	Load Cap (pF)		Oscillator Voltage Range (V)		Remarks
			C1	C2	MIN	MAX	
TDK	FCR ǒM5	3.58 MHz–6.0 MHz	33	33	2.0	5.5	Leaded Type
	FCR ǒMC5	3.58 MHz–6.0 MHz	(2)	(2)	2.0	5.5	On-chip C Leaded Type
	CCR ǒMC3	3.58 MHz–6.0 MHz	(3)	(3)	2.0	5.5	On-chip C SMD Type

NOTES:

1. Please specify normal oscillator frequency.
2. On-chip C: 30pF built in.
3. On-chip C: 38pF built in.

Table 14-5. Subsystem Clock Oscillator Characteristics

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

Oscillator	Clock Configuration	Parameter	Test Condition	Min	Typ	Max	Units
Crystal Oscillator		Oscillation frequency ⁽¹⁾	–	32	32.768	35	kHz
		Stabilization time ⁽²⁾	V _{DD} = 2.7 V to 5.5 V V _{DD} = 1.8 V to 5.5 V	– –	1.0 –	2 10	s s
External Clock		XT _{IN} input frequency ⁽¹⁾	–	32	–	100	kHz
		XT _{IN} input high and low level width (t _{XH} , t _{XL})	–	5	–	15	μs

NOTES:

- Oscillation frequency and XT_{IN} input frequency data are for oscillator characteristics only.
- Stabilization time is the interval required for oscillating stabilization after a power-on occurs or when stop mode is terminated.

Table 14-6. Input/Output Capacitance

(T_A = 25 °C, V_{DD} = 0 V)

Parameter	Symbol	Condition	Min	Typ	Max	Units
Input Capacitance	C _{IN}	f = 1 MHz; Unmeasured pins are returned to V _{SS}	–	–	15	pF
Output Capacitance	C _{OUT}		–	–	15	pF
I/O Capacitance	C _{IO}		–	–	15	pF

Table 14-7. A.C. Electrical Characteristics

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Instruction Cycle Time ⁽¹⁾	t _{CY}	V _{DD} = 2.7 V to 5.5 V	0.67	–	64	μs
		V _{DD} = 1.8 V to 5.5 V	1.33			
TCL0, TCL1 Input Frequency	f _{TIO} , f _{TI1}	V _{DD} = 2.7 V to 5.5 V	0	–	1.5	MHz
		V _{DD} = 1.8 V to 5.5 V			1	MHz
TCL0, TCL1 Input High, Low Width	t _{TIH0} , t _{TIL0} t _{TIH1} , t _{TIL1}	V _{DD} = 2.7 V to 5.5 V	0.48	–	–	μs
		V _{DD} = 1.8 V to 5.5 V	1.8			
SCK Cycle Time	t _{KCY}	V _{DD} = 2.7 V to 5.5 V External SCK source	800	–	–	ns
		Internal SCK source	670			
		V _{DD} = 1.8 V to 5.5 V External SCK source	3200			
		Internal SCK source	3800			
SCK High, Low Width	t _{KH} , t _{KL}	V _{DD} = 2.7 V to 5.5 V External SCK source	335	–	–	ns
		Internal SCK source	t _{KCY} –250			
		V _{DD} = 1.8 V to 5.5 V External SCK source	1600			
		Internal SCK source	t _{KCY} –2150			
SI Setup Time to SCK High	t _{SIK}	V _{DD} = 2.7 V to 5.5 V External SCK source	100	–	–	ns
		Internal SCK source	150			
		V _{DD} = 1.8 V to 5.5 V External SCK source	150			
		Internal SCK source	500			
SI Hold Time to SCK High	t _{KSI}	V _{DD} = 2.7 V to 5.5 V External SCK source	400	–	–	ns
		Internal SCK source	400			
		V _{DD} = 1.8 V to 5.5 V External SCK source	600			
		Internal SCK source	500			

Table 14-7. A.C. Electrical Characteristics (Continued)

($T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$, $V_{DD} = 1.8\text{ V}$ to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Output Delay for SCK to SO	t_{KSO} (note)	$V_{DD} = 2.7\text{ V}$ to 5.5 V External SCK source	-	-	300	ns
		Internal SCK source			250	
		$V_{DD} = 1.8\text{ V}$ to 5.5 V External SCK source			1000	
		Internal SCK source			1000	
Interrupt Input High, Low Width	t_{INTH} , t_{INTL}	INT0, INT1, INT2, INT4, KS0-KS7	10	-	-	μs
RESET Input Low Width	t_{RSL}	Input	10	-	-	μs

NOTE: R (1 k Ω) and C (100 pF) are the load resistance and load capacitance of the SO output line.

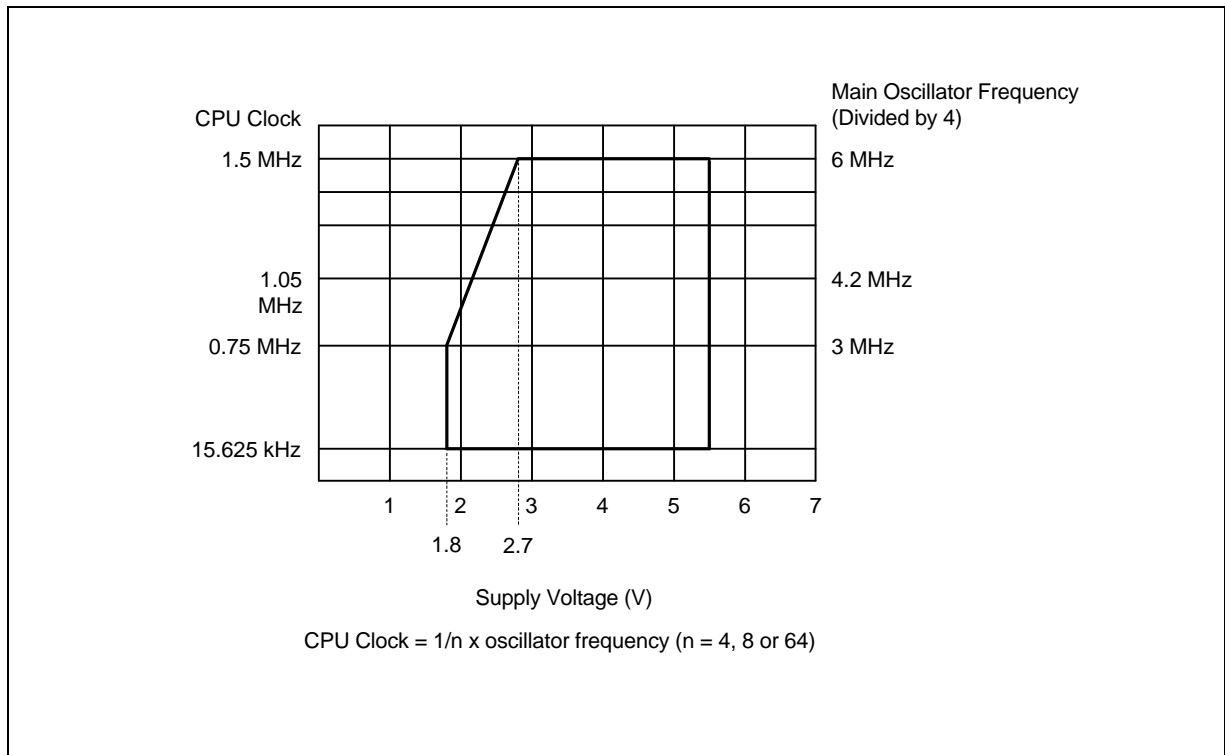


Figure 14-1. Standard Operating Voltage Range

Table 14-8. RAM Data Retention Supply Voltage in Stop Mode

(T_A = -40 °C to +85 °C)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Data retention supply voltage	V _{DDDR}	–	1.8	–	5.5	V
Data retention supply current	I _{DDDR}	V _{DDDR} = 1.5 V	–	0.1	10	μA
Release signal set time	t _{SREL}	–	0	–	–	μs
Oscillator stabilization wait time ⁽¹⁾	t _{WAIT}	Released by RESET	–	2 ¹⁷ /fx	–	ms
		Released by interrupt	–	(2)	–	ms

NOTES:

1. During oscillator stabilization wait time, all CPU operations must be stopped to avoid instability during oscillator start-up.
2. Use the basic timer mode register (BMOD) interval timer to delay execution of CPU instructions during the wait time.

TIMING WAVEFORMS

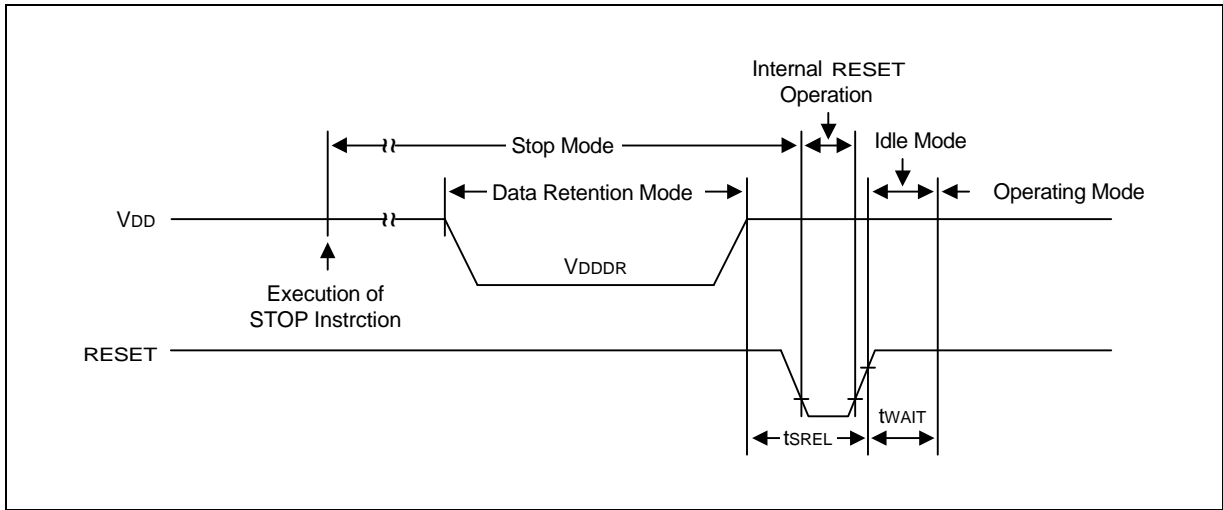


Figure 14-2. Stop Mode Release Timing When Initiated by RESET

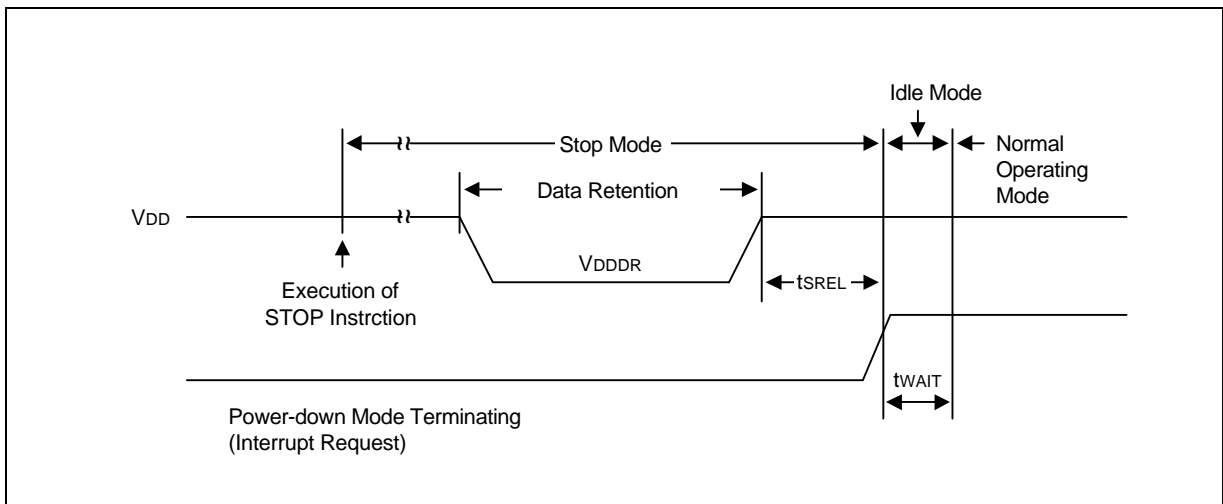


Figure 14-3. Stop Mode Release Timing When Initiated by Interrupt Request

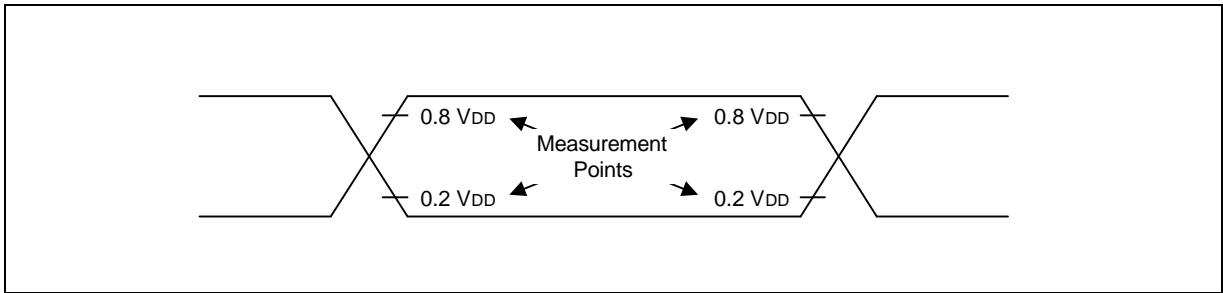


Figure 14-4. A.C. Timing Measurement Points (Except for X_{IN} and XT_{IN})

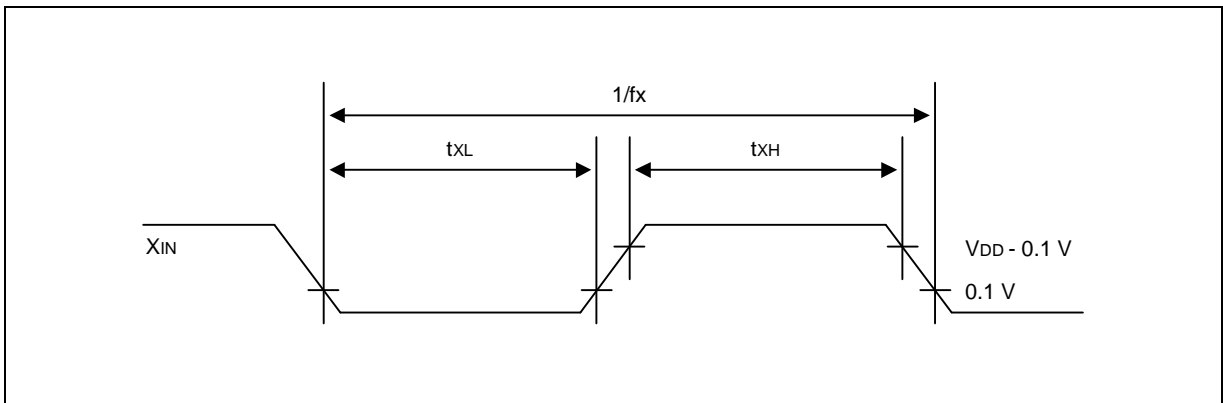


Figure 14-5. Clock Timing Measurement at X_{IN} (XT_{IN})

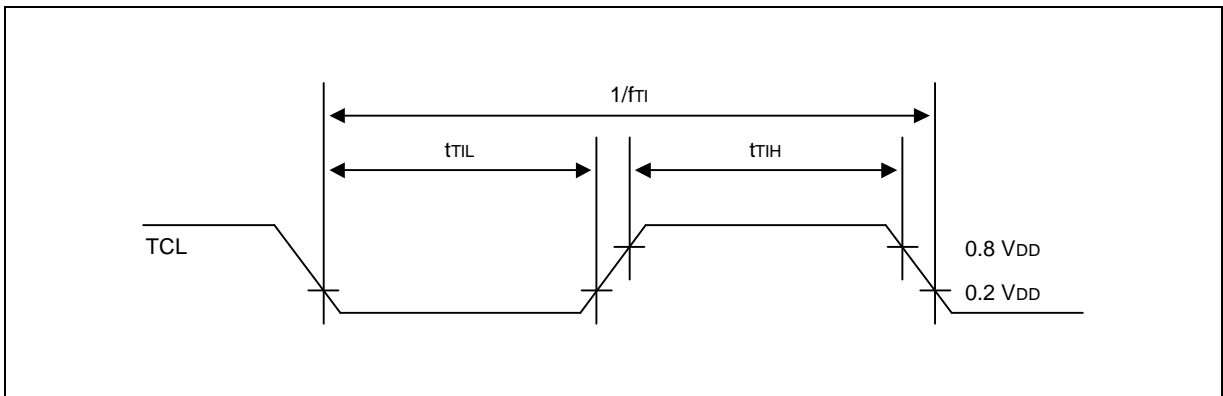


Figure 14-6. TCL0/1 Timing

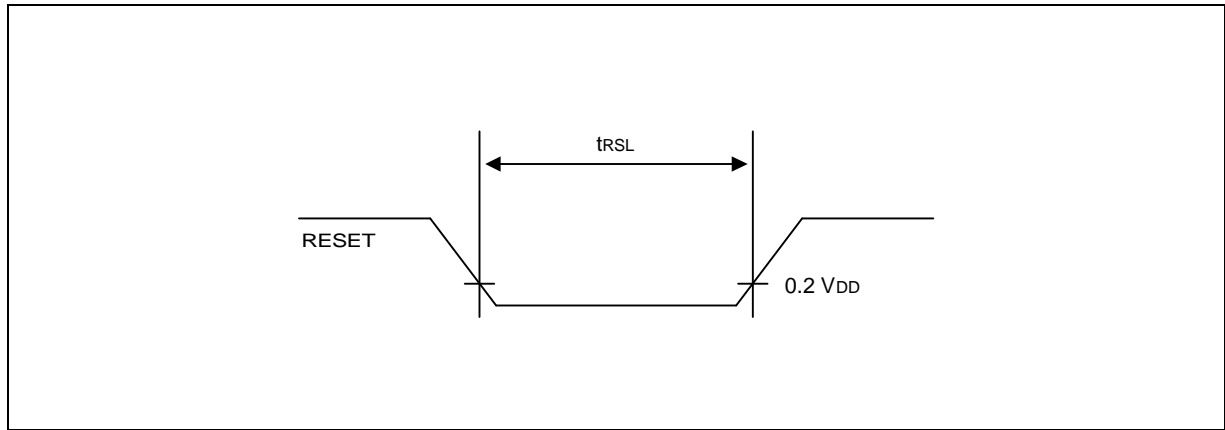


Figure 14-7. Input Timing for RESET Signal

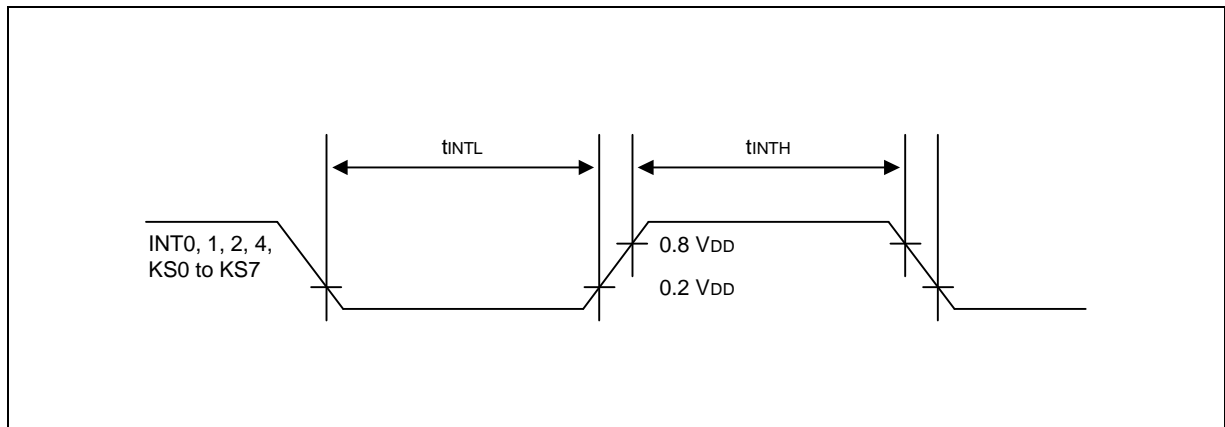


Figure 14-8. Input Timing for External Interrupts and Quasi-Interrupts

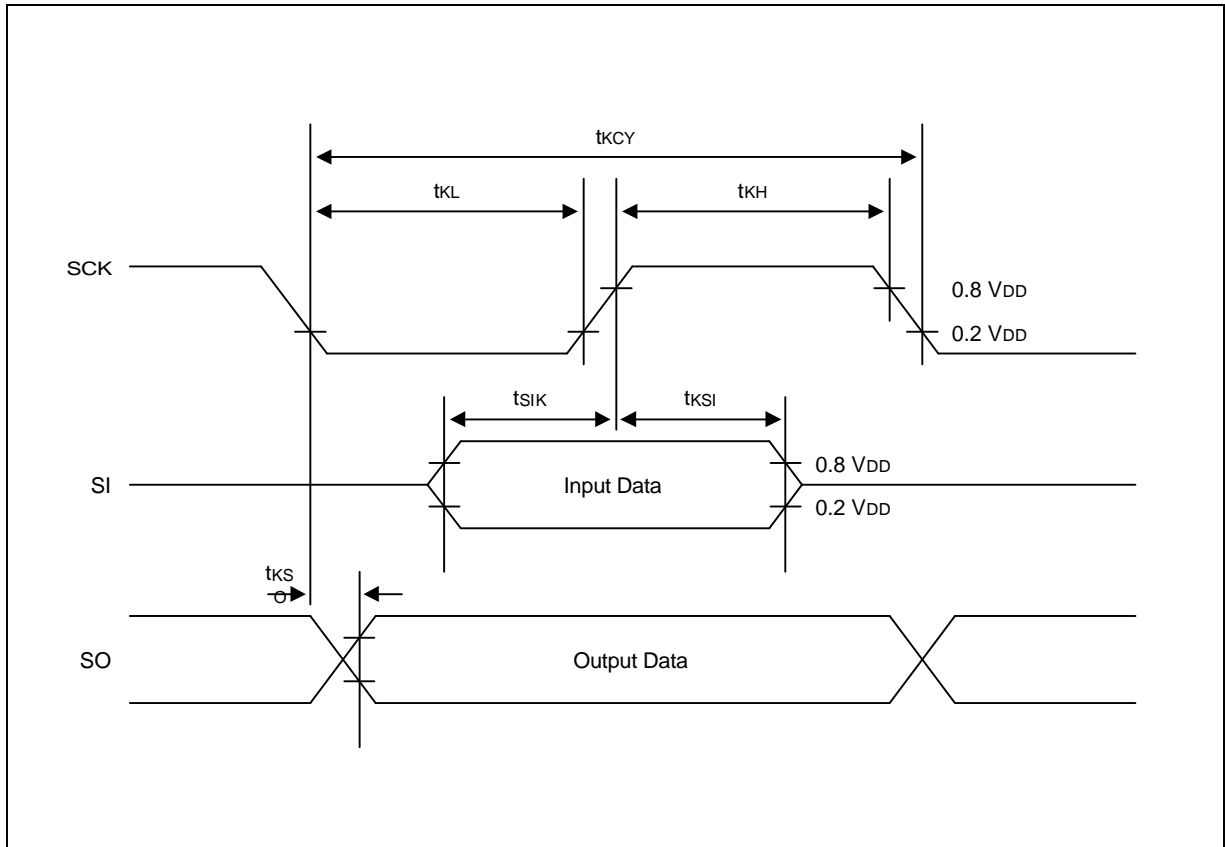


Figure 14-9. Serial Data Transfer Timing

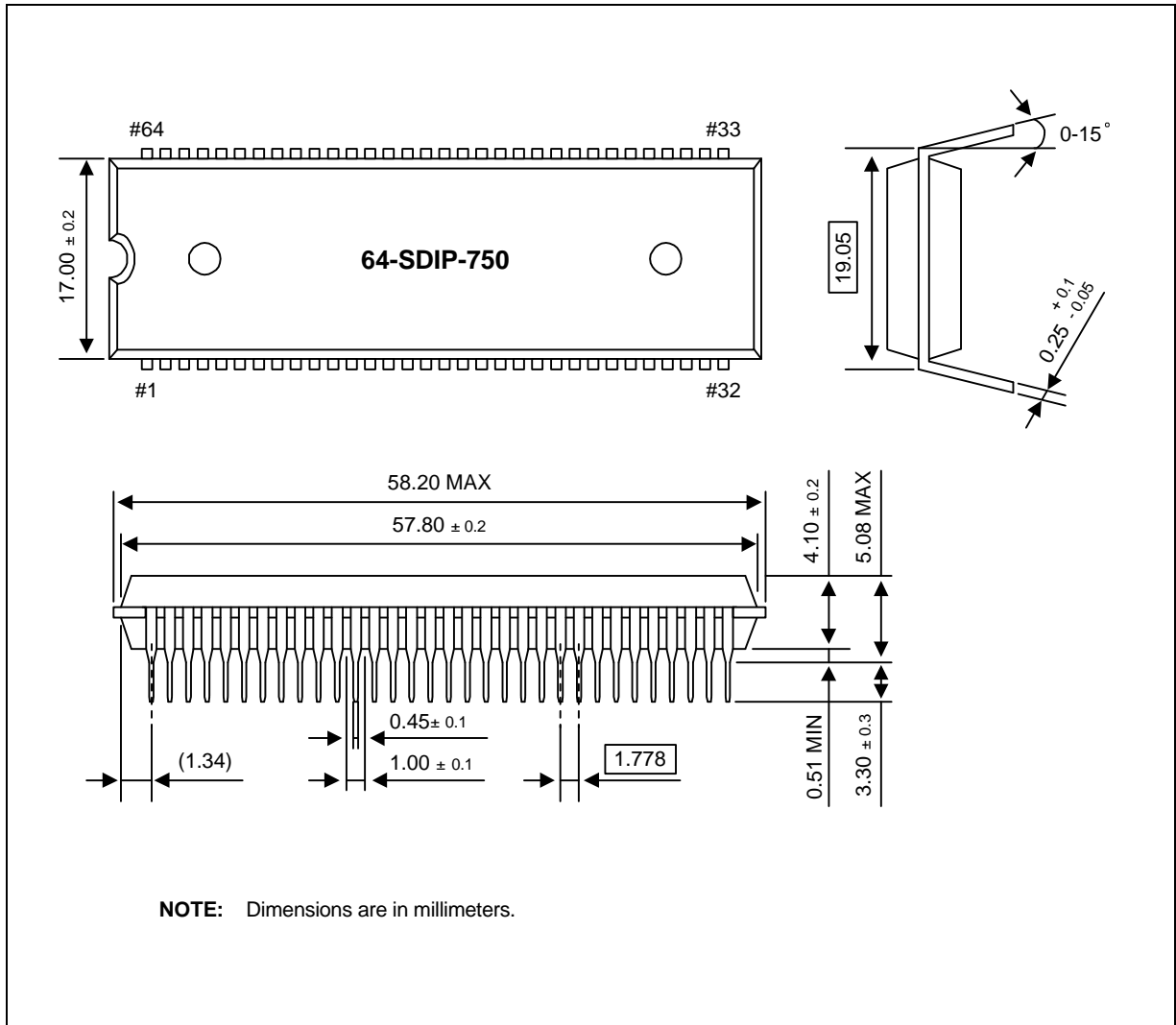


Figure 15-2. 64-SDIP-750C Package Dimensions

16

KS57P5532OTP

OVERVIEW

The KS57P5532 single-chip CMOS microcontroller is the OTP (One Time Programmable) version of the KS57C5532 microcontroller. It has an on-chip OTP ROM instead of masked ROM. The EPROM is accessed by serial data format.

The KS57P5532 is fully compatible with the KS57C5532, both in function and in pin configuration. Because of its simple programming requirements, the KS57P5532 is ideal for use as an evaluation chip for the KS57C5532.

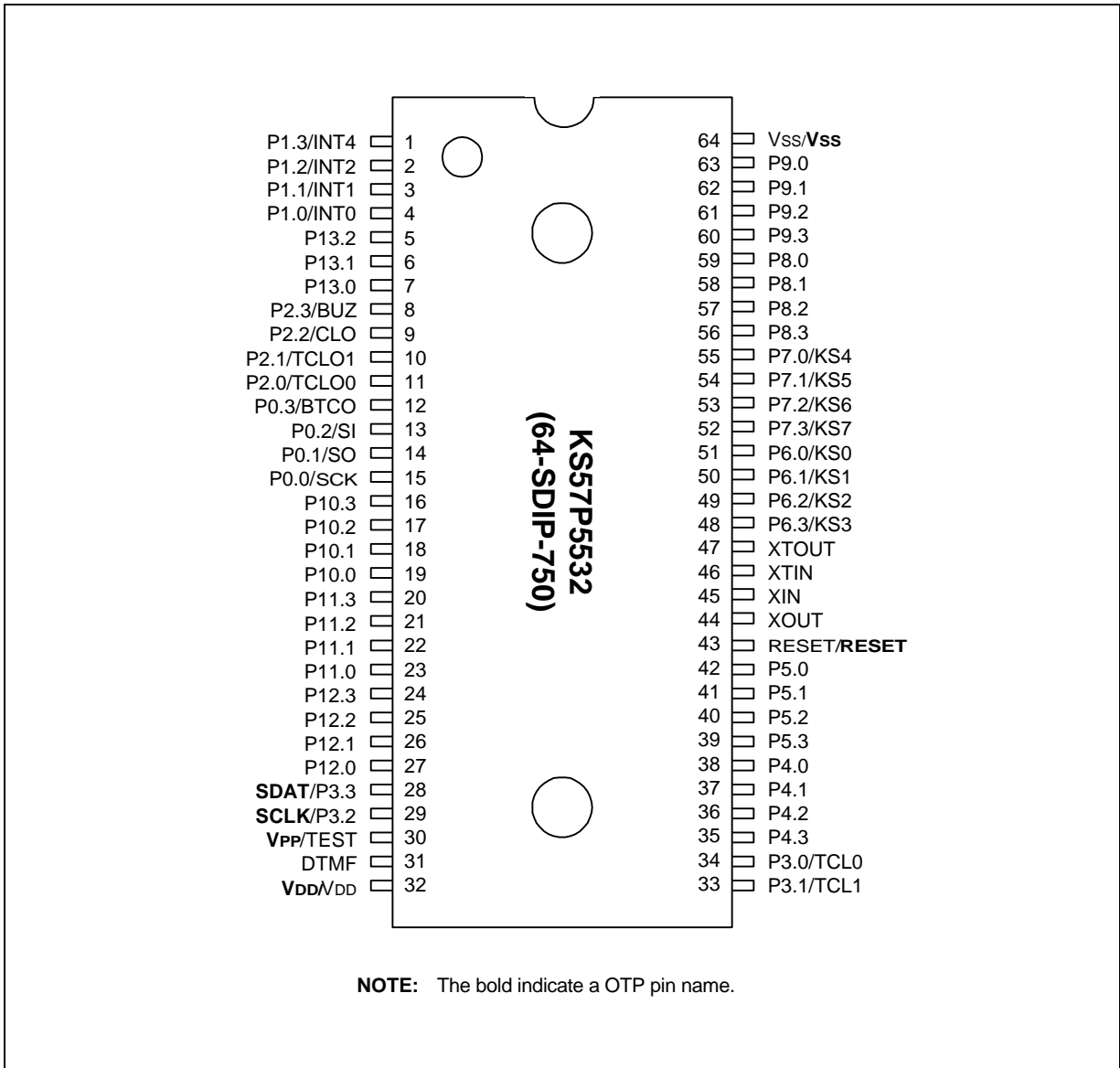


Figure 16-1. KS57P5532 Pin Assignments (64-SDIP)

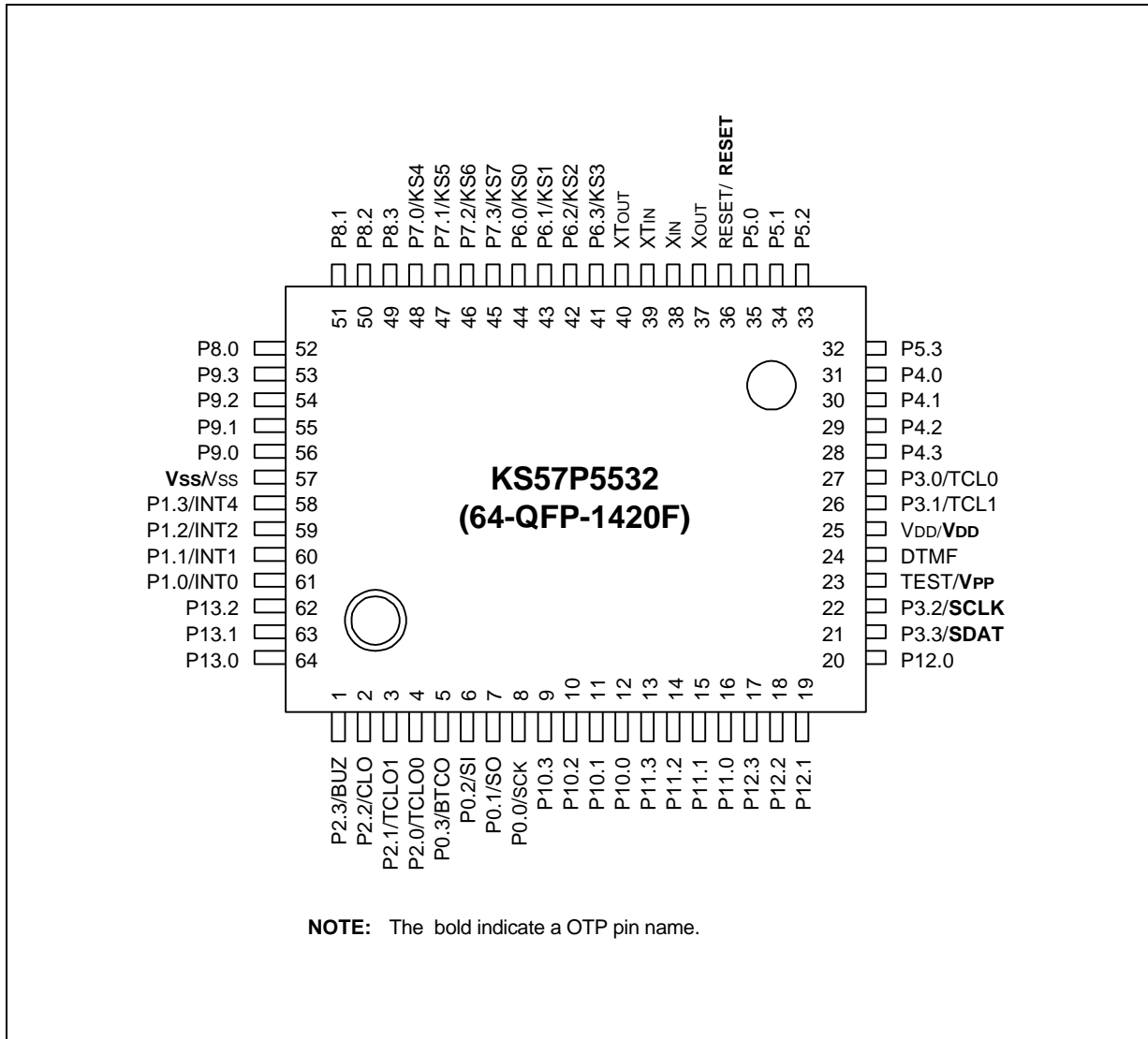


Figure 16-2. KS57P5532 Pin Assignments (64-QFP)

Table 16-1. Descriptions of Pins Used to Read/Write the EPROM

Pin Name	During Programming		
	Pin No.	I/O	Function
SDAT	28 (21)	I/O	Serial data pin. Output port when reading and input port when writing. Can be assigned as a Input/push-pull output port.
SCLK	29 (22)	I	Serial clock pin. Input only pin.
V _{PP} (TEST)	30 (23)	I	Power supply pin for EPROM cell writing (indicates that OTP enters into the writing mode). When 12.5 V is applied, OTP is in writing mode and when 5 V is applied, OTP is in reading mode. (Option) Hold GND when OTP is operating.
RESET	43 (36)	I	Chip initialization
V _{DD} /V _{SS}	32 (25) / 64 (57)	I	Logic power supply pin. V _{DD} should be tied to + 5 V during programming.

NOTE: Parentheses indicate pin number for 64 QFP package.

Table 16-2. Comparison of KS57P5532 and KS57C5532 Features

Characteristic	KS57P5532	KS57C5532
Program Memory	32 K byte EPROM	32 K byte mask ROM
Operating Voltage (V _{DD})	1.8 V to 5.5 V	1.8 V to 5.5 V
OTP Programming Mode	V _{DD} = 5 V, V _{PP} (TEST) = 12.5V	
Pin Configuration	64 SDIP/QFP	64 SDIP/QFP
EPROM Programmability	User Program 1 time	Programmed at the factory

OPERATING MODE CHARACTERISTICS

When 12.5 V is supplied to the V_{PP}(TEST) pin of the KS57P5532, the EPROM programming mode is entered. The operating mode (read, write, or read protection) is selected according to the input signals to the pins listed in Table 16-3 below.

Table 16-3. Operating Mode Selection Criteria

V _{DD}	V _{PP} (TEST)	REG/MEM	Address (A15-A0)	R/W	Mode
5 V	5 V	0	0000H	1	EPROM read
	12.5V	0	0000H	0	EPROM program
	12.5V	0	0000H	1	EPROM verify
	12.5V	1	0E3FH	0	EPROM read protection

NOTE: "0" means Low level; "1" means High level.

Table 16-4. Absolute Maximum Ratings

(T_A = 25 °C)

Parameter	Symbol	Conditions	Rating	Units
Supply Voltage	V _{DD}	–	– 0.3 to 6.5	V
Input Voltage	V _{I1}	All I/O ports	– 0.3 to V _{DD} + 0.3	V
Output Voltage	V _O	–	– 0.3 to V _{DD} + 0.3	V
Output Current High	I _{OH}	One I/O port active	– 15	mA
		All I/O ports active	– 30	
Output Current Low	I _{OL}	One I/O port active	+ 30 (Peak value)	mA
			+ 15 (note)	
		All I/O ports, total	+ 100 (Peak value)	
			+ 60 (note)	
Operating Temperature	T _A	–	– 40 to + 85	°C
Storage Temperature	T _{stg}	–	– 65 to + 150	°C

NOTE: The values for Output Current Low (I_{OL}) are calculated as Peak Value × √Duty.

Table 16-5. D.C. Electrical Characteristics

(T_A = – 40 °C to + 85 °C, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Input High Voltage	V _{IH1}	All input pins except those specified below for V _{IH2} –V _{IH4}	0.7 V _{DD}	–	V _{DD}	V
	V _{IH2}	Ports 0, 1, 3, 6, 7, and RESET	0.8 V _{DD}		V _{DD}	
	V _{IH3}	Ports 4 and 5 with pull-up resistors assigned	0.7 V _{DD}		V _{DD}	
	V _{IH4}	X _{IN} , X _{OUT} and XT _{IN}	V _{DD} – 0.1		V _{DD}	
Input Low Voltage	V _{IL1}	All input pins except those specified below for V _{IL2} –V _{IL3}	–	–	0.3 V _{DD}	V
	V _{IL2}	Ports 0, 1, 3, 6, 7, and RESET			0.2 V _{DD}	
	V _{IL3}	X _{IN} , X _{OUT} and XT _{IN}			0.1	

Table 16-5. D.C. Electrical Characteristics (Continued)

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Output High Voltage	V _{OH}	I _{OH} = -1 mA Ports except 1	V _{DD} - 1.0	-	-	V
Output Low Voltage	V _{OL1}	V _{DD} = 4.5 V to 5.5 V I _{OL} = 15 mA Ports 4,5 only	-	-	2	V
		V _{DD} = 2.0 to 5.5 V, I _{OL} = 1.6mA			0.4	
	V _{OL2}	V _{DD} = 4.5 V to 5.5 V I _{OL} = 4mA all out Ports except ports 4,5	-	-	2	V
		V _{DD} = 2.0 to 5.5 V, I _{OL} = 1.6mA			0.4	V
Input High Leakage Current	I _{LIH1}	V _I = V _{DD} All input pins except those specified below for I _{LIH2}	-	-	3	μA
	I _{LIH2}	V _I = V _{DD} X _{IN} , X _{OUT} and XT _{IN}			20	
Input Low Leakage Current	I _{LIL1}	V _I = 0 V All input pins except below and RESET	-	-	-3	μA
	I _{LIL2}	V _I = 0 V X _{IN} , X _{OUT} and XT _{IN}			-20	
Output High Leakage Current	I _{LOH}	V _O = V _{DD} All output pins	-	-	3	μA
Output Low Leakage Current	I _{LOL}	V _O = 0 V All output pins	-	-	-3	
Pull-up Resistor	R _{L1}	V _{DD} = 5 V; V _I = 0 V except RESET	25	45	100	kΩ
		V _{DD} = 3 V	50	89	200	
	R _{L3}	V _{DD} = 5 V; V _I = 0 V; RESET	100	212	400	
		V _{DD} = 3 V	200	441	800	
Pull-Down Resistor	R _{L4}	V _{DD} = 5 V; V _I = V _{DD} ; Port 12	25	46	100	
		V _{DD} = 3 V	50	95	200	

Table 16-5. D.C. Electrical Characteristics (Concluded)

(T_A = -40 °C to +85 °C, V_{DD} = 1.8 V to 5.5 V)

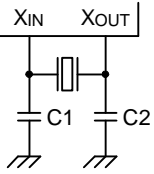
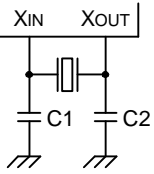
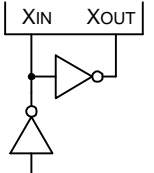
Parameter	Symbol	Conditions	Min	Typ	Max	Units	
Supply Current (1)	I _{DD1} (DTMF ON)	Run mode; V _{DD} = 5.0 V ± 10% 3.58 MHz Crystal oscillator; C1 = C2 = 22 pF	-	3.0	5.0	mA	
		V _{DD} = 3 V ± 10%		1.6	3.0		
	I _{DD2} (DTMF OFF)	Run mode; V _{DD} = 5.0 V ± 10% Crystal oscillator; C1 = C2 = 22 pF		6.0 MHz	2.7		8.0
		V _{DD} = 3 V ± 10%		3.58 MHz	2.0		4.0
				6.0 MHz	1.3		4.0
	I _{DD3}	Idle mode; V _{DD} = 5 V ± 10% V _{DD} = 3 V ± 10%		6.0 MHz	0.8		2.5
				3.58 MHz	0.7		1.8
I _{DD4}	Run mode; V _{DD} = 3.0 V ± 10% 32 kHz Crystal oscillator	6.0 MHz	-	0.3	1.5		
		3.58 MHz		0.2	1.0		
	I _{DD5}	Idle mode; V _{DD} = 3.0 V ± 10% 32 kHz Crystal oscillator		6.0 MHz	0.9	2.3	
				3.58 MHz	0.9	2.3	
I _{DD6}	Stop mode; V _{DD} = 5 V ± 10%	SCMOD = 0000B	-	1.9	5		
	Stop mode; V _{DD} = 3 V ± 10%	XT = 0 V		0.6	3		
	Stop mode; V _{DD} = 5 V ± 10%	SCMOD =		0.2	3		
	Stop mode; V _{DD} = 3 V ± 10%	0100B		0.1	2		
Row Tone Level (2)	V _{ROW}	V _{DD} = 2.0 V to 5.5 V R _L = 12 KΩ; Temp = -30 to 60 °C	-16	-14	-11	dBV	
Ratio of Column to Row Tone (2)	dB _{CR}	V _{DD} = 2.0 V to 5.5 V R _L = 12 KΩ; Temp = -30 to 60 °C	1	2	3	dB	
Distortion (2) (Dual tone)	THD	V _{DD} = 2.0 V to 5.5 V 1 MHz band, R _L = 12 KΩ Temp = -30 to 60 °C	-	-	5	%	

NOTES:

1. D.C. electrical values for Supply Current (I_{DD1} to I_{DD3}) do not include current drawn through internal pull-up resistors.
2. DTMF electrical characteristics.
3. For D.C. electrical values, the power control register (PCON) must be set to 0011B.

Table 16-6. Main System Clock Oscillator Characteristics

(T_A = -40 °C + 85 °C, V_{DD} = 1.8 V to 5.5 V)

Oscillator	Clock Configuration	Parameter	Test Condition	Min	Typ	Max	Units
Ceramic Oscillator		Oscillation frequency ⁽¹⁾	V _{DD} = 2.7 V to 5.5 V	0.4	–	6.0	MHz
			V _{DD} = 1.8 V to 5.5 V	0.4	–	3.0	
		Stabilization time ⁽²⁾	V _{DD} = 3 V	–	–	4	ms
Crystal Oscillator		Oscillation frequency ⁽¹⁾	V _{DD} = 2.7 V to 5.5 V	0.4	–	6.0	MHz
			V _{DD} = 1.8 V to 5.5 V	0.4	–	3.0	
		Stabilization time ⁽²⁾	V _{DD} = 3 V	–	–	10	ms
External Clock		X _{IN} input frequency ⁽¹⁾	V _{DD} = 2.7 V to 5.5 V	0.4	–	6.0	MHz
			V _{DD} = 1.8 V to 5.5 V	0.4	–	3.0	
		X _{in} input high and low level width (t _{xH} , t _{xL})	–	83.3	–	1250	ns

NOTES:

- Oscillation frequency and X_{IN} input frequency data are for oscillator characteristics only.
- Stabilization time is the interval required for oscillating stabilization after a power-on occurs, or when stop mode is terminated.

Table 16-7. Recommended Oscillator Constants

(T_A = -40 °C + 85 °C, V_{DD} = 1.8 V to 5.5 V)

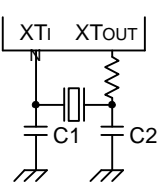
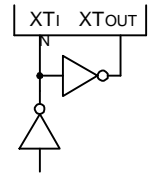
Manufacturer	Series Number ⁽¹⁾	Frequency Range	Load Cap (pF)		Oscillator Voltage Range (V)		Remarks
			C1	C2	MIN	MAX	
TDK	FCR ǒM5	3.58 MHz–6.0 MHz	33	33	2.0	5.5	Leaded Type
	FCR ǒMC5	3.58 MHz–6.0 MHz	(2)	(2)	2.0	5.5	On-chip C Leaded Type
	CCR ǒMC3	3.58 MHz–6.0 MHz	(3)	(3)	2.0	5.5	On-chip C SMD Type

NOTES:

1. Please specify normal oscillator frequency.
2. On-chip C: 30pF built in.
3. On-chip C: 38pF built in.

Table 16-8. Subsystem Clock Oscillator Characteristics

(T_A = -40 °C + 85 °C, V_{DD} = 1.8 V to 5.5 V)

Oscillator	Clock Configuration	Parameter	Test Condition	Min	Typ	Max	Units
Crystal Oscillator		Oscillation frequency ⁽¹⁾	–	32	32.768	35	kHz
		Stabilization time ⁽²⁾	V _{DD} = 2.7 V to 5.5 V V _{DD} = 1.8 V to 5.5 V	– –	1.0 –	2 10	s s
External Clock		XT _{IN} input frequency ⁽¹⁾	–	32	–	100	kHz
		XT _{IN} input high and low level width (t _{XH} , t _{XL})	–	5	–	15	μs

NOTES:

1. Oscillation frequency and XT_{IN} input frequency data are for oscillator characteristics only.
2. Stabilization time is the interval required for oscillating stabilization after a power-on occurs or when stop mode is terminated.

Table 16-9. Input/Output Capacitance

($T_A = 25\text{ }^\circ\text{C}$, $V_{DD} = 0\text{ V}$)

Parameter	Symbol	Condition	Min	Typ	Max	Units
Input Capacitance	C_{IN}	f = 1 MHz; Unmeasured pins are returned to V_{SS}	–	–	15	pF
Output Capacitance	C_{OUT}		–	–	15	pF
I/O Capacitance	C_{IO}		–	–	15	pF

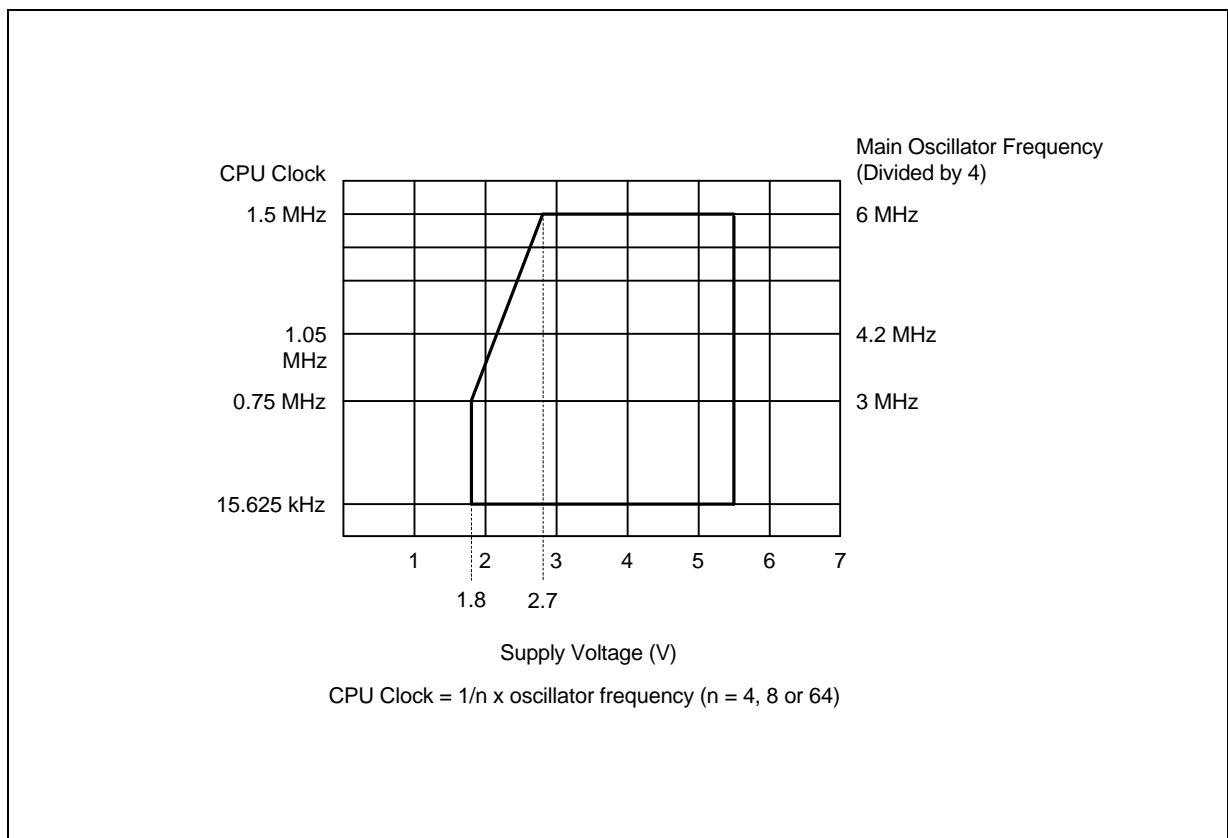


Figure 16-3. Standard Operating Voltage Range

17

DEVELOPMENT TOOLS

OVERVIEW

Samsung provides a powerful and easy-to-use development support system in turnkey form. The development support system is configured with a host system, debugging tools, and support software. For the host system, any standard computer that operates with MS-DOS as its operating system can be used. One type of debugging tool including hardware and software is provided: the sophisticated and powerful in-circuit emulator, SMDS2+, for KS57, KS86, KS88 families of microcontrollers. The SMDS2+ is a new and improved version of SMDS2. Samsung also offers support software that includes debugger, assembler, and a program for setting options.

SHINE

Samsung Host Interface for In-Circuit Emulator, SHINE, is a multi-window based debugger for SMDS2+. SHINE provides pull-down and pop-up menus, mouse support, function/hot keys, and context-sensitive hyper-linked help. It has an advanced, multiple-windowed user interface that emphasizes ease of use. Each window can be sized, moved, scrolled, highlighted, added, or removed completely.

SAMA ASSEMBLER

The Samsung Arrangeable Microcontroller (SAM) Assembler, SAMA, is a universal assembler, and generates object code in standard hexadecimal format. Assembled program code includes the object code that is used for ROM data and required SMDS program control data. To assemble programs, SAMA requires a source file and an auxiliary definition (DEF) file with device specific information.

SASM57

The SASM57 is an relocatable assembler for Samsung's KS57-series microcontrollers. The SASM57 takes a source file containing assembly language statements and translates into a corresponding source code, object code and comments. The SASM57 supports macros and conditional assembly. It runs on the MS-DOS operating system. It produces the relocatable object code only, so the user should link object file. Object files can be linked with other object files and loaded into memory.

HEX2ROM

HEX2ROM file generates ROM code from HEX file which has been produced by assembler. ROM code must be needed to fabricate a microcontroller which has a mask ROM. When generating the ROM code (.OBJ file) by HEX2ROM, the value 'FF' is filled into the unused ROM area upto the maximum ROM size of the target device automatically.

TARGET BOARDS

Target boards are available for all KS57-series microcontrollers. All required target system cables and adapters are included with the device-specific target board.

OTPs

One time programmable microcontroller (OTP) for the KS57C5532 microcontroller and OTP programmer (Gang) are now available.

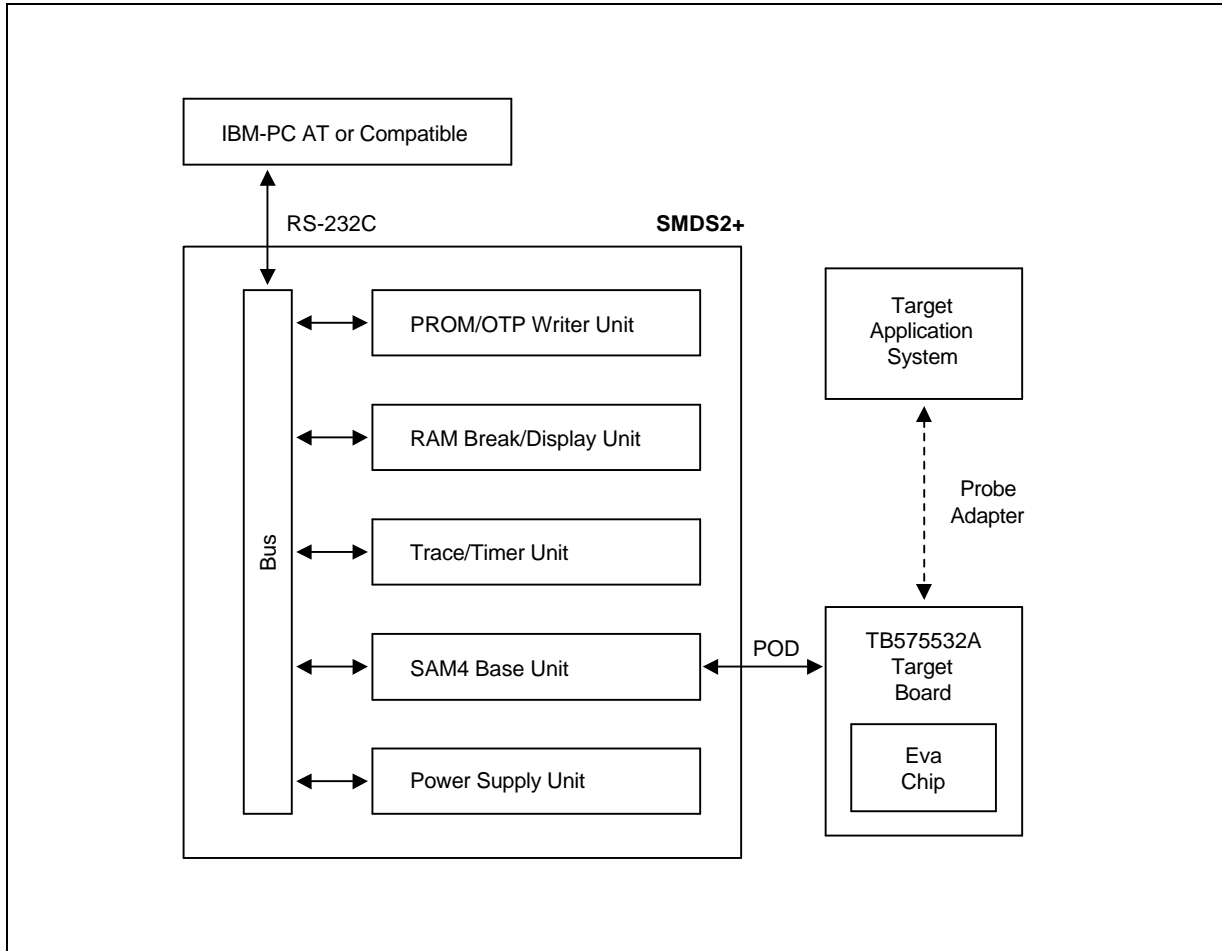


Figure 17-1. SMDS Product Configuration (SMDS2+)

TB575532A/TB575532A TARGET BOARD

The TB575532A/TB575532A target board is used for the KS57C5532/P5532 microcontroller. It is supported by the SMDS2+ development system.

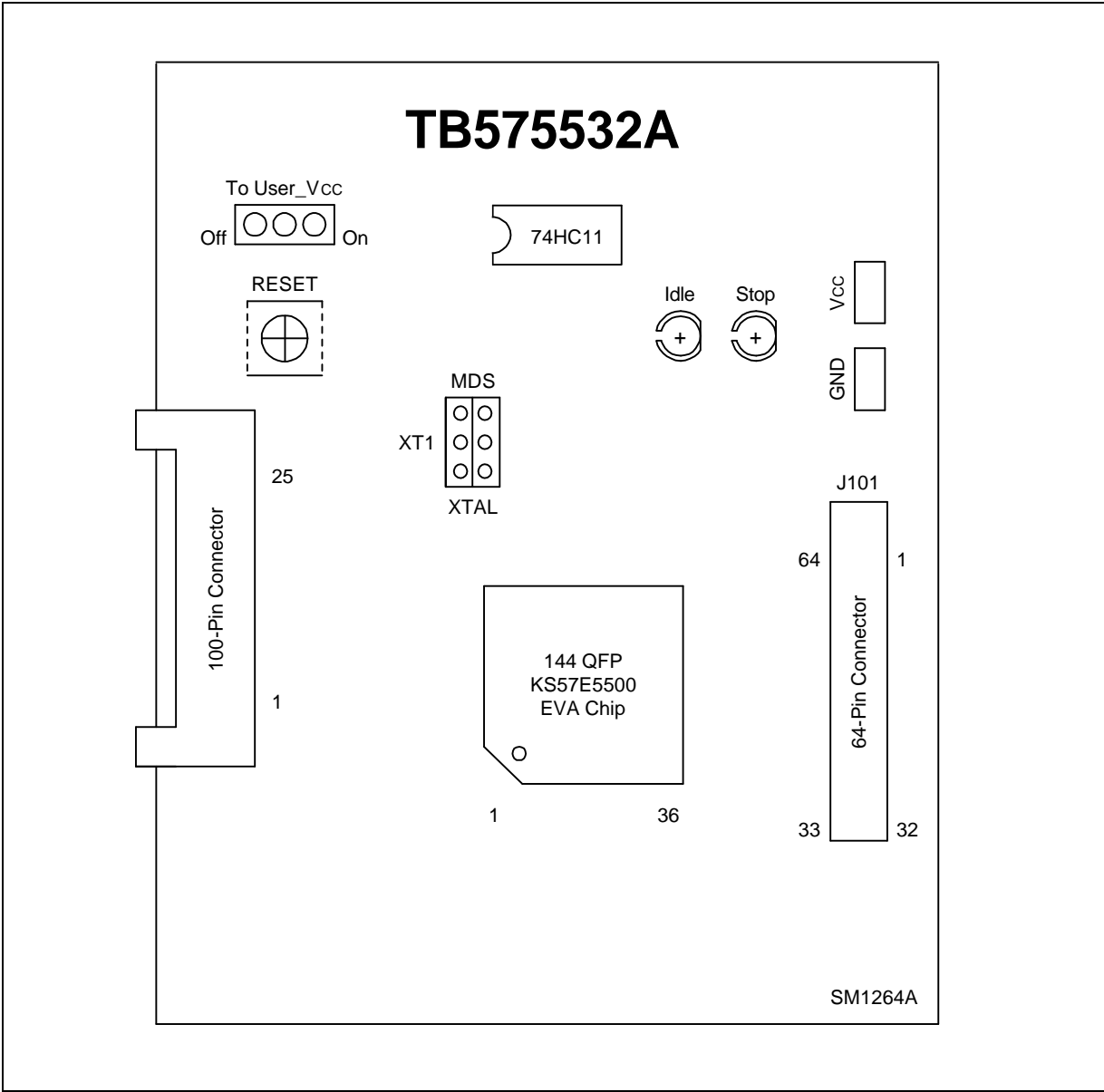


Figure 17-2. TB575532A Target Board Configuration

Table 17-1. Power Selection Settings for TB575532A

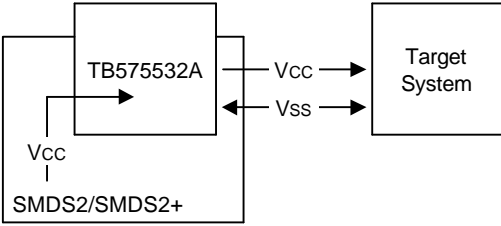
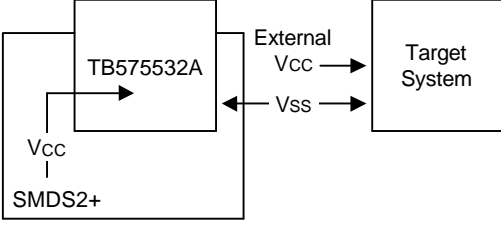
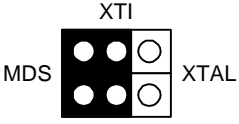
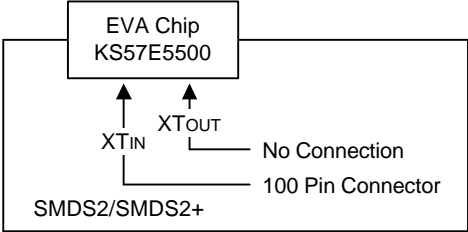
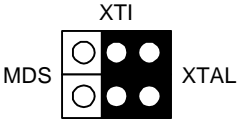
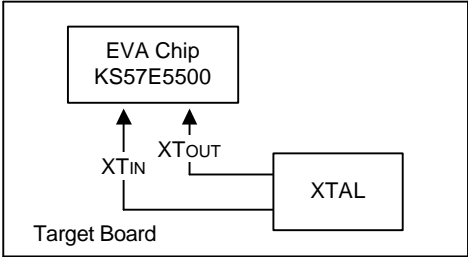
'To User_Vcc' Settings	Operating Mode	Comments
<p>To User_Vcc Off <input type="radio"/> <input checked="" type="radio"/> <input type="radio"/> On</p>	 <p>The diagram shows a TB575532A chip. A line labeled 'Vcc' goes from the chip to a box labeled 'Target System'. A line labeled 'Vss' goes from the 'Target System' back to the chip. The chip is also connected to a power source labeled 'SMDS2/SMDS2+' which provides 'Vcc' to the chip.</p>	<p>The SMDS2/SMDS2+ supplies V_{CC} to the target board (evaluation chip) and the target system.</p>
<p>To User_Vcc Off <input type="radio"/> <input checked="" type="radio"/> <input type="radio"/> On</p>	 <p>The diagram shows a TB575532A chip. A line labeled 'External Vcc' goes from the chip to a box labeled 'Target System'. A line labeled 'Vss' goes from the 'Target System' back to the chip. The chip is also connected to a power source labeled 'SMDS2+' which provides 'Vcc' to the chip.</p>	<p>The SMDS2/SMDS2+ supplies V_{CC} only to the target board (evaluation chip). The target system must have its own power supply.</p>

Table 17-2. Clock Selection Settings for TB575532A

Sub Clock Setting	Operating Mode	Comments
		<p>Set the XTI switch to "MDS" when the target board is connected to the SMDS2/SMDS2+.</p>
		<p>Set the XTI switch to "XTAL" when the target board is used as a standalone unit, and is not connected to the SMDS2/SMDS2+.</p>

IDLE LED

This LED is ON when the evaluation chip (KS57E5500) is in idle mode.

STOP LED

This LED is ON when the evaluation chip (KS57E5500) is in stop mode.

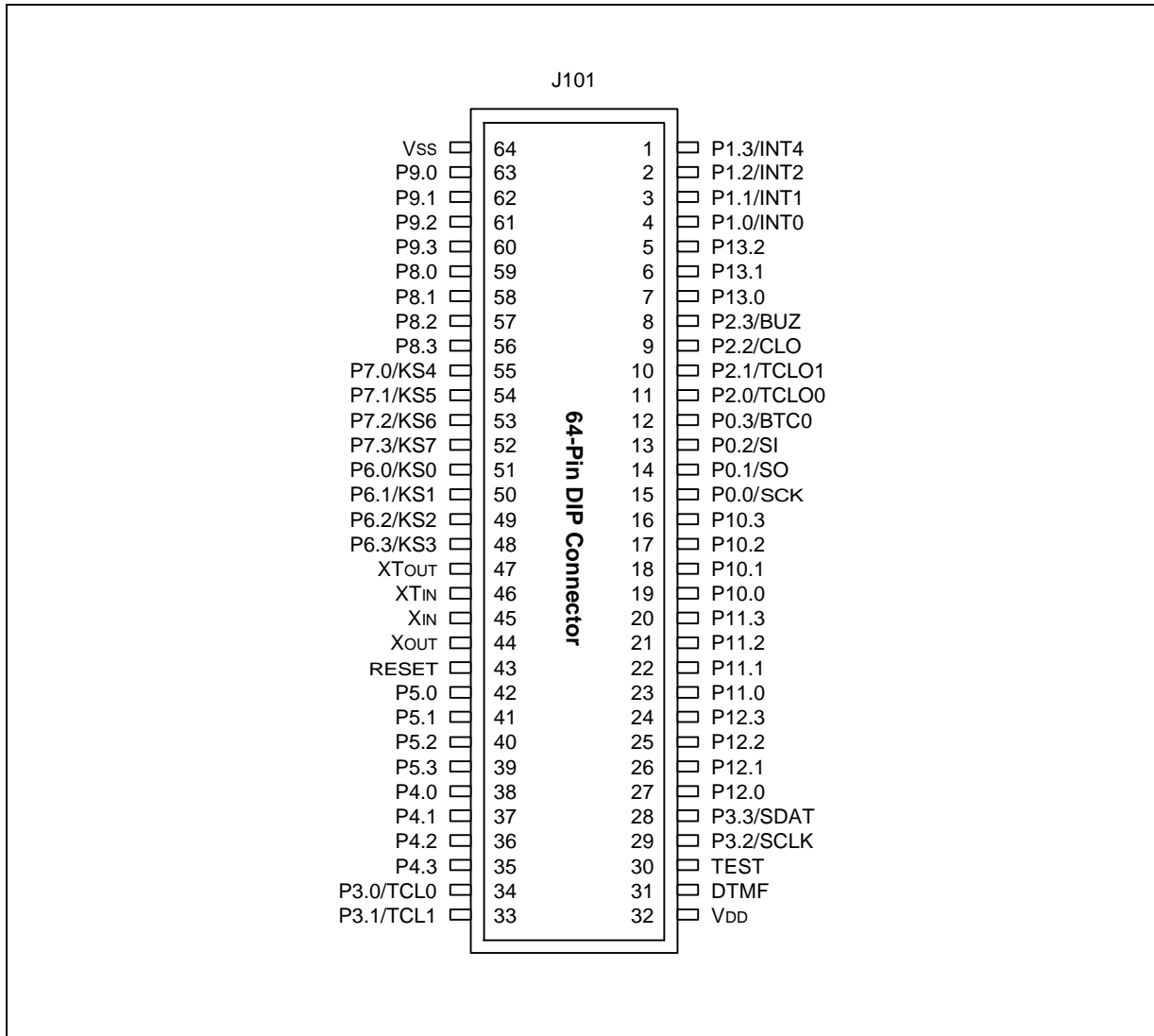


Figure 17-3. 64-Pin Connector for TB575532A

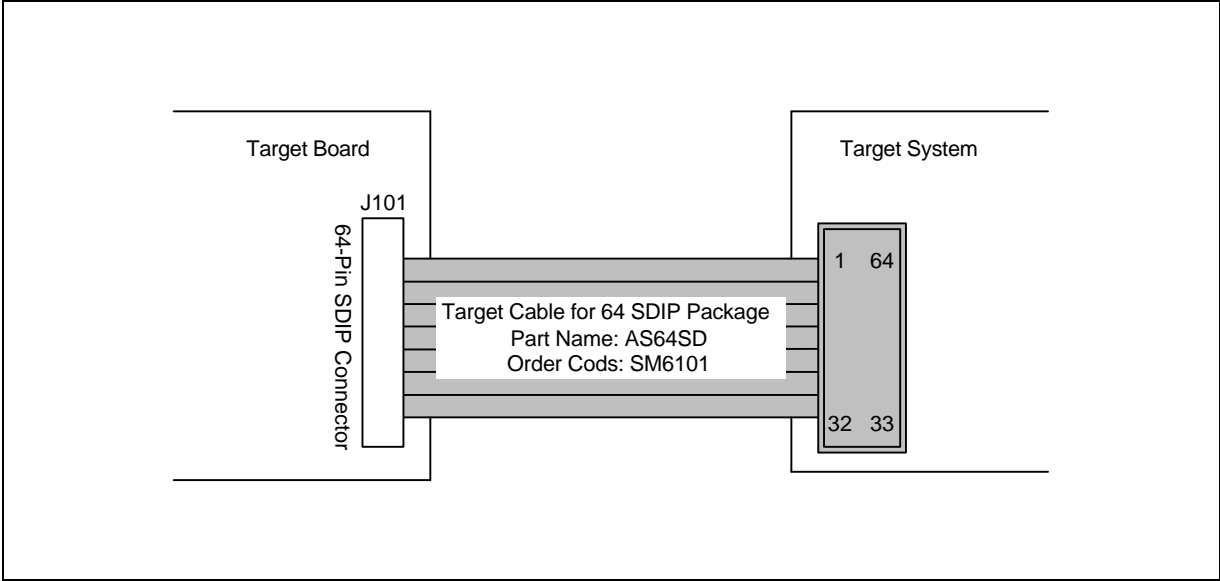


Figure 17-4. TB575532A Adapter Cable (KS57C5532/P5532)

NOTES